hyperstone E1-32XS / E1-16XS

**32-Bit-RISC/DSP Microprocessor
User's Manual**

hyperston

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Table of Contents

4. Exceptions

5. Timer

7. Mechanical Data

1. Architecture

1.1. Introduction

The *hyperstone* E1-32XS and *hyperstone* E1-16XS microprocessors represent a further development of the *hyperstone* E1-32X and *hyperstone* E1-16X processors. Using a sophisticated 0.25 µm CMOS process, the maximum clock rate of the processor could be further improved. Being pin-compatible to their predecessors these new processors can be used as a direct replacement in existing designs, given that the changed voltage supply requirements are considered.

This combination of a high-performance RISC microprocessor with an additional powerful DSP instruction set and on-chip microcontroller functions offers a high throughput. The speed is obtained by an optimized combination of the following features:

❐ The most recent stack frames are kept in a register stack, thereby reducing data memory accesses to a minimum by keeping almost all local data in registers.

❐ Pipelined memory access allows overlapping of memory accesses with execution.

❐ 16 KByte fully static On-Chip Memory (IRAM).

❐ On-chip Instruction Cache omits instruction fetch in inner loops and provides prefetch.

❐ Variable-length instructions of 16, 32 or 48 bits provide a large, powerful instruction set, thereby reducing the number of instructions to be executed.

❐ Primarily used 16-bit instructions halve the memory bandwidth required for instruction fetch in comparison to conventional RISC architectures with fixed-length 32-bit instructions, yielding also even better code economy than conventional CISC architectures.

❐ Orthogonal instruction set.

❐ Most instructions execute in one cycle.

❐ Pipelined DSP instructions.

❐ Parallel execution of ALU, DSP, and load/store instructions.

❐ Single-cycle half-word multiply-accumulate operation.

❐ Fast Call and Return by parameter passing via registers.

❐ An instruction pipeline depth of just two stages — decode/execute — provides branching without insertion of wait cycles in combination with Delayed Branch instructions.

❐ Range and pointer checks are performed without speed penalty, thus, these checks need no longer be turned off, thereby providing higher runtime reliability.

❐ Separate address and data buses provide a throughput of one 32-bit word each cycle.

The features noted above contribute to reduce the number of idle wait cycles to a bare minimum. The processor is designed to sustain its execution rate with a standard SDRAM memory.

The low power consumption is of advantage for mobile (portable) applications or in temperature-sensitive environments.

1.1. Introduction (continued)

Most of the transistors are used for the on-chip memory, the instruction cache, the register stack and the multiplier, whereas only a small number is required for the control logic.

Due to their low manufacturing costs, the *hyperstone* E1-32XS and E1-16XS microprocessors are very well suited for embedded systems applications requiring high performance and lowest cost. To simplify board design as well as to reduce system costs, the *hyperstone* E1-32XS and E1-16XS already come with integrated peripherals, such as a timer and memory and bus control logic. Therefore, complete systems using *hyperstone* microprocessors can be designed with a minimum of external components. To connect any kind of memory or I/O, no glue logic is necessary. It is even suitable for systems where up to now microprocessors with 16-bit architecture have been used for cost reasons. Its improved performance compared to conventional microcontrollers can be used to software-substitute many external peripherals like graphics controllers or DSPs. Using the *hyperstone* E1-32XS as a core for ASICs or ASSPs is particularly advantageous because the total gate count of the entire logic is just about 35k gates without the on-chip memory.

The software development tools include an optimizing C compiler, assembler, source-level debugger with profiler as well as a runtime kernel and a sophisticated DSP library. Using the runtime kernel, up to 31 tasks, each with its own virtual timer, can be developed independently of each other. The synchronization of these tasks is effected almost automatically by the runtime kernel. For the system designer, it seems as if he has up to 31 *hyperstone* microprocessors to which he can allocate his programs accordingly. Real-time debugging of multiple tasks is assisted in an optimized way. The DSP library provides a powerful set of DSP related functions and is taking care of all parallelism between ALU, DSP, and Load/Store unit.

The following description gives a brief architectural overview:

Compatibility:

❒ Pin compatible to *hyperstone* E1-32X and *hyperstone* E1-16X.

Phased Locked Loop:

❒ An internal phased locked loop circuit (PLL) provides clock rate multiplication by a factor ½, 1, 2, 4, or 8. For example, only an external crystal of 12 MHz is required to achieve an internal clock rate of 96 MHz.

Registers:

❒ 32 global and 64 local registers of 32 bits each

❒ 16 global and up to 16 local registers are addressable directly

Flags:

❒ Zero(Z), negative(N), carry(C) and overflow(V) flag

❒ Interrupt-mode, interrupt-lock, trace-mode, trace-pending, supervisor state, cache-mode and high global flag

1.1. Introduction (continued)

Register Data Types:

❐ Unsigned integer, signed integer, single or double signed short, signed complex short, single or double 16-bit fixed-point, bit string, IEEE-754 floating-point, each either 32 or 64 bits

External Memory:

❐ Address space of 4 Gbytes, divided into five areas

❐ Separate I/O address space

❐ Load/Store architecture

❐ Pipelined memory and I/O accesses

❐ High-order data located and addressed at lower address (big endian)

❐ Instructions and double-word data may cross DRAM page boundaries

On-Chip Memory (IRAM):

❐ 16 KByte fully static internal memory, 32 bit wide, single cycle access

Memory Data Types:

❐ Unsigned and signed byte (8 bit)

❐ Unsigned and signed half-word (16 bit), located on half-word boundary

❐ Undedicated word (32 bit), located on word boundary

❐ Undedicated double-word (64 bit), located on word boundary

Runtime Stack:

❐ Runtime Stack is divided into memory part and register part

❐ Register part is implemented by the 64 local registers holding the most recent stack frame(s)

❐ Current stack frame (maximum 16 registers) is always kept in register part of the stack

❐ Data transfer between memory and register part of the stack is automatic

❐ Upper stack bound is guarded

Instruction Cache:

❐ An on-chip Instruction Cache reduces instruction memory access substantially

Instructions General:

❐ Variable-length instructions of one, two or three half-words halve required memory bandwidth

❐ Pipeline depth of only two stages, assures immediate refill after branches

1.1. Introduction (continued)

❒ Register instructions of type "source operator destination $\Rightarrow$ destination" or "source operator immediate $\Rightarrow$ destination"

❒ All register bits participate in an operation

❒ Immediate operands of 5, 16 and 32 bits, zero- or sign-expanded

❒ Large address displacement of up to 28 bits

❒ Two sets of signed arithmetical instructions: instructions set or clear either only the overflow flag or trap additionally to a Range Error routine on overflow

❒ DSP instructions operate on 16-bit integer, real and complex fixed-point data and 32-bit integer data into 32-bit and 64-bit hardware accumulators

Instruction Summary:

❒ Memory instructions pipelined to a depth of two stages, trap on address register equal to zero (check for invalid pointers)

❒ Memory address modes: register address, register post-increment, register + displacement (including PC relative), register post-increment by displacement (next address), absolute, stack address, I/O absolute and I/O displacement

❒ Load, all data types, bytes and half-words right adjusted and zero- or sign-expanded, execution proceeds after Load until data is needed

❒ Store, all data types, trap when range of signed byte or half-word is exceeded

❒ Move, Move immediate, Move double-word

❒ Logical instructions AND, AND not, OR, XOR, NOT, AND not immediate, OR immediate, XOR immediate

❒ Mask source and immediate $\Rightarrow$ destination

❒ Add unsigned/signed, Add signed with trap on overflow, Add with carry

❒ Add unsigned/signed immediate, Add signed immediate with trap on overflow

❒ Sum source + immediate $\Rightarrow$ destination, unsigned/signed and signed with trap on overflow

❒ Subtract unsigned/signed, Subtract signed with trap on overflow, Subtract with carry

❒ Negate unsigned/signed, Negate signed with trap on overflow

❒ Multiply word $*$ word $\Rightarrow$ low-order word unsigned or signed, Multiply word $*$ word $\Rightarrow$ double-word unsigned and signed

❒ Divide double-word by word $\Rightarrow$ quotient and remainder, unsigned and signed

❒ Shift left unsigned/signed, single and double-word, by constant and by content of register

❒ Shift right unsigned and signed, single and double-word, by constant and by content of register

❒ Rotate left single word by content of register

❒ Index Move, move an index value scaled by 1, 2, 4 or 8, optionally with bounds check

1.1. Introduction (continued)

❐ Check a value for an upper bound specified in a register or check for zero

❐ Compare unsigned/signed, Compare unsigned/signed immediate

❐ Compare bits, Compare bits immediate, Compare any byte zero

❐ Test number of leading zeros

❐ Set Conditional, save conditions in a register

❐ Branch unconditional and conditional (12 conditions)

❐ Delayed Branch unconditional and conditional (12 conditions)

❐ Call subprogram, unconditional and on overflow

❐ Trap to supervisor subprogram, unconditional and conditional (11 conditions)

❐ Frame, structure a new stack frame, include parameters in frame addressing, set frame length, restore reserve frame length and check for upper stack bound

❐ Return from subprogram, restore program counter, status register and return-frame

❐ Software instructions, call an associated subprogram and pass a source operand and the address of a destination operand to it

❐ DSP Multiply instructions:
signed and/or unsigned multiplication $\Rightarrow$ single and double word product

❐ DSP Multiply-Accumulate instructions:
signed multiply-add and multiply-subtract $\Rightarrow$ single and double word product sum and difference

❐ DSP Half-word Multiply-Accumulate instructions:
signed multiply-add operating on four half-word operands $\Rightarrow$ single and double word product sum

❐ DSP Complex Half-word Multiply instruction:
signed complex half-word multiplication $\Rightarrow$ real and imaginary single word product

❐ DSP Complex Half-word Multiply-Accumulate instruction:
signed complex half-word multiply-add $\Rightarrow$ real and imaginary single word product sum

❐ DSP Add and Subtract instructions:
signed half-word add and subtract with and without fixed-point adjustment $\Rightarrow$ single word sum and difference

❐ Floating-point instructions are architecturally fully integrated, they are executed as Software instructions by the present version. Floating-point Add, Subtract, Multiply, Divide, Compare and Compare unordered for single and double-precision, and Convert single $\Leftrightarrow$ double are provided.

1.1. Introduction (continued)

Exceptions:

❒ Pointer, Privilege, Frame and Range Error, Extended Overflow, Parity Error, Interrupt and Trace mode exception

❒ Watchdog function

❒ Error-causing instructions can be identified by backtracking, thus allowing a very detailed error analysis

Timer:

❒ Two multi-functional timers

Bus Interface:

❒ Separate address bus of 26 (E1-32XS) or 22 (E1-16XS) bits and data bus of up to 32 (E1-32XS) or 16 bits (E1-16XS) provide a throughput of up to four or two bytes at each clock cycle, respectively.

❒ Data bus width of 32, 16 or 8 bits, individually selectable for each external memory area.

❒ 8-bit, 16-bit, and 32-bit boot width selectable via two external pins.

❒ Configurable I/O pins

❒ Internal generation of all memory and I/O control signals

❒ Wait pin function for I/O accesses to peripheral devices.

❒ Wait pin function for memory accesses to address space MEM2.

❒ On-chip DRAM controller supporting Fast-Page-Mode DRAMs, EDO DRAMs, and synchronous DRAMs (SDRAM).

❒ Up to seven vectored interrupts.

❒ Control function for CLKOUT pin.

Power Management:

❒ Lower power supply current in power-down mode.

❒ Clock-Off function to further reduce power dissipation (Sleep Mode).

❒ PLL settings controllable by software, providing a "gear-up" or "gear-down" within one clock cycle.

1.2. Block Diagram
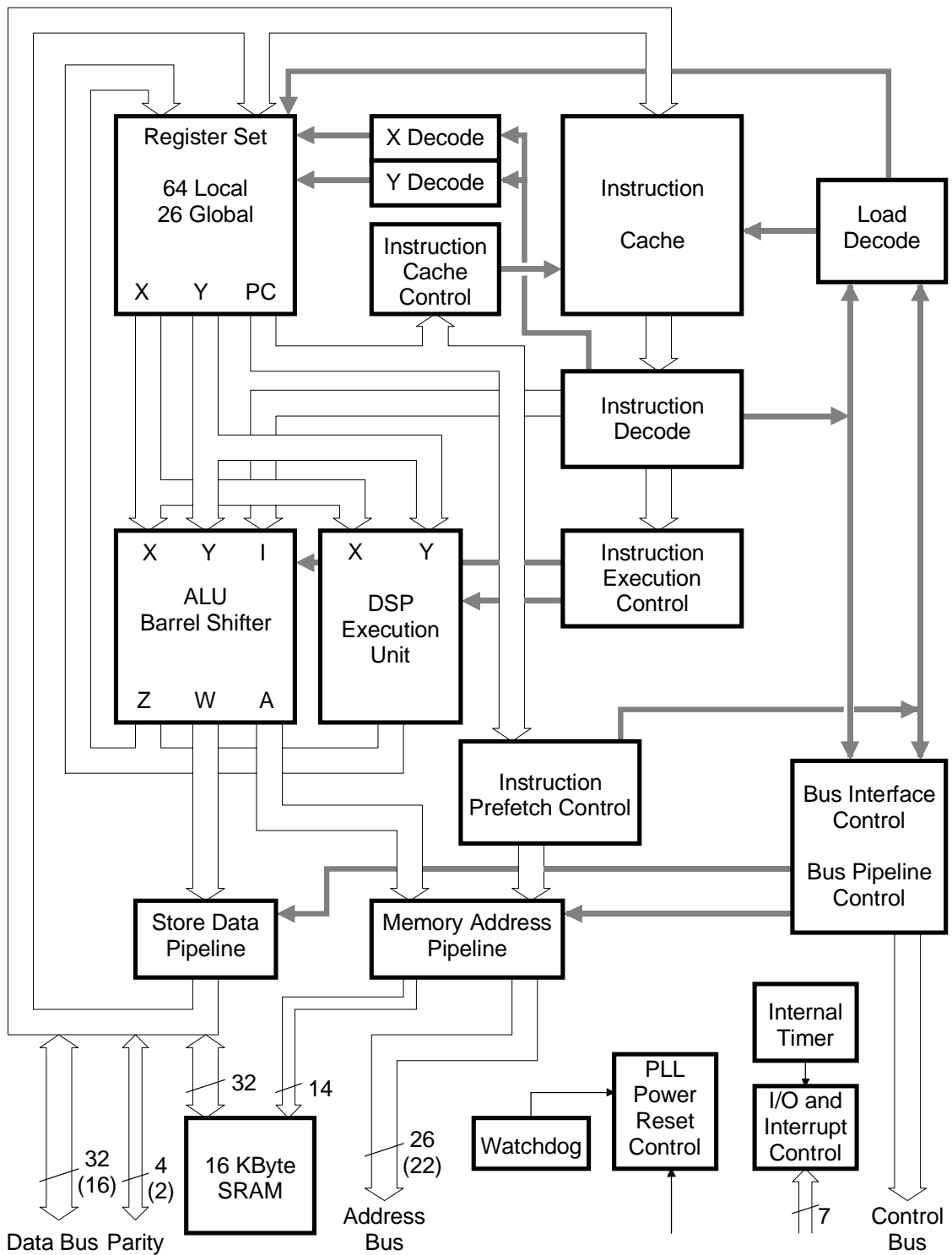
Figure 1.1: Block Diagram

1.3. Global Register Set

The architecture provides 32 global registers of 32 bits each. These are:

G0   Program Counter PC

G1   Status Register SR

G2   Floating-Point Exception Register FER

G3..G15   General purpose registers

G16..G17   Reserved

G18   Stack Pointer SP

G19   Upper Stack Bound UB

G20   Bus Control Register BCR (see section 6. Bus Interface)

G21   Timer Prescaler Register TPR (see section 5. Timer)

G22   Timer Compare Register TCR (see section 5. Timer and CPU Clock Modes)

G23   Timer Register TR (see section 5. Timer and CPU Clock Modes)

G24   Watchdog Compare Register WCR (see section 6. Bus Interface)

G25   Input Status Register ISR (see section 6. Bus Interface)

G26   Function Control Register FCR (see section 6. Bus Interface)

G27   Memory Control Register MCR (see section 6. Bus Interface)

G28..G31   Reserved

Registers G0..G15 can be addressed directly by the register code (0..15) of an instruction. Registers G18..G27 can be addressed only by a MOV or MOVI instruction with the high global flag H set to 1.

31		0
G0	Program Counter PC	0
G1	Status Register SR	
G2	Floating-Point Exception Register FER	
G3		
	General Purpose Registers G3..G15	
G15		
G16	Reserved	
G17	Reserved	
G18	Stack Pointer SP	0 0
G19	Upper Stack Bound UB	0 0
G20	Bus Control Register BCR	
G21	Timer Prescaler Register TPR	
G22	Timer Compare Register TCR	
G23	Timer Register TR	
G24	Watchdog Compare Register WCR	
G25	Input Status Register ISR	
G26	Function Control Register FCR	
G27	Memory Control Register MCR	
G28		
	G28..G31 Reserved	
G31		

Figure 1.2: Global Register Set

1.3.1. Program Counter PC

G0 is the program counter PC. It is updated to the address of the next instruction through instruction execution. Besides this implicit updating, the PC can also be addressed like a regular source or destination register. When the PC is referenced as an operand, the value supplied is the address of the first byte after the instruction which references it, except when referenced by a delay instruction with a preceding delayed branch taken (see section 3.26. Delayed Branch Instructions).

Placing a result in the PC has the effect of a branch taken. Bit zero of the PC is always zero, regardless of any value placed in the PC.

1.3.2. Status Register SR

G1 is the status register SR. Its content is updated by instruction execution. Besides this implicit updating, the SR can also be addressed like a regular register. When addressed as source or destination operand, all 32 bits are used as an operand. However, only bits 15..0 of a result can be placed in bits 15..0 of the SR, bits 31..16 of the result are discarded and bits 31..16 of the SR remain unchanged. The full content of the SR is replaced only by the Return Instruction. A result placed in the SR overrules any setting or clearing of the condition flags as a result of an instruction.
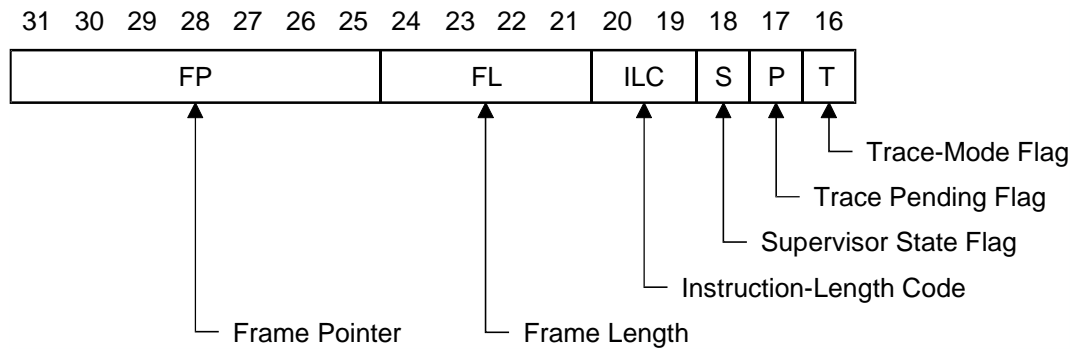
Figure 1.3: Status Register SR (bits 31..16)
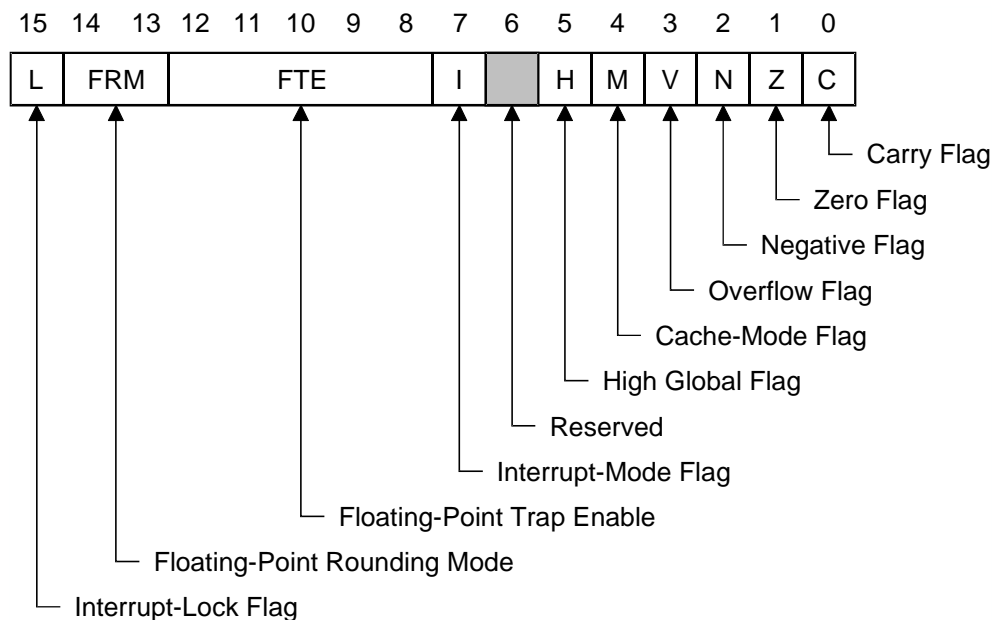
Figure 1.4: Status Register SR (bits 15..0)

1.3.2. Status Register SR (continued)

The status register SR contains the following status information:

C   Bit zero is the carry condition flag C. In general, when set it indicates that the unsigned integer range has been exceeded. At add operations, it indicates a carry out of bit 31 of the result. At subtract operations, it indicates a borrow (inverse carry) into bit 31 of the result.

Z   Bit one is the zero condition flag Z. When set, it indicates that all 32 or 64 result bits are equal to zero regardless of any carry, borrow or overflow.

N   Bit two is the negative condition flag N. On compare instructions, it indicates the arithmetic correct (true) sign of the result regardless of an overflow. On all other instructions, it is derived from result bit 31, which is the true sign bit when no overflow occurs. In the case of overflow, result bit 31 and N reflect the inversion of the true sign.

V   Bit three is the overflow condition flag V. In general, when set it indicates a signed overflow.

M   Bit four is the cache-mode flag M. Besides being set or cleared under program control, it is also automatically cleared by a Frame instruction and by any branch taken except a delayed branch. See section 1.9. Instruction Cache for details.

H   Bit five is the high global flag H. When H is set, denotation of G0..G15 addresses G16..G31 instead. Thus, the registers G18..G27 may be addressed by denoting G2..G11 respectively.
The H flag is effective only in the first cycle of the next instruction after it was set; then it is cleared automatically.
Only the MOV or MOVI instruction issued as the next instructions can be used to copy the content of a local register or an immediate value to one of the high global registers. The MOV instruction can also be used to copy the content of a high global register (except the BCR, TPR, FCR and MCR register, which are write-only) to a local register. With all other instructions, the result may be invalid.
If one of the high global registers is addressed as the destination register in user state (S = 0), the condition flags are undefined, the destination register remains unchanged and a trap to Privilege Error occurs.

Reserved Bit six is reserved for future use. It must always be zero.

I   Bit seven is the interrupt-mode flag I. It is set automatically on interrupt entry and reset to its old value by a Return instruction. The I flag is used by the operating system; it must be never changed by any user program, regardless of user or supervisor state.

FTE   Bits 12..8 are the floating-point trap enable flags (see section 3.33.2. Floating-Point Instructions).

FRM   Bits 14..13 are the floating-point rounding modes (see section 3.33.2. Floating-Point Instructions).

1.3.2. Status Register SR (continued)

L   Bit 15 is the interrupt-lock flag L. When the L flag is one, all Interrupt, Parity
              Error and Extended Overflow exceptions regardless of individual mode bits are
              inhibited. The state of the L flag is effective immediately after any instruction
              which changed it. The L flag is set to one by any exception.
              The L flag can be cleared or kept set in any or on return to any privilege state
              (user or supervisor). Changing the L flag from zero to one is privileged to su-
              pervisor or return from supervisor to supervisor state. A trap to Privilege Error
              occurs if the L flag is set under program control from zero to one in user or on
              return to user state.

The following status information cannot be changed by addressing the SR:

T   Bit 16 is the trace-mode flag T. When both the T flag and the trace pending flag
              P are one, a trace exception occurs after every instruction except after a De-
              layed Branch instruction. The T flag is cleared by any exception.
              Note: The T flag can only be changed in the saved return SR and is then effec-
              tive after execution of a Return instruction.

P   Bit 17 is the trace pending flag P. It is automatically set to one by all in-
              structions except by the Return instruction, which restores the P flag from bit
              17 of the saved return SR.
              Since for a Trace exception both the P and the T flag must be one, the P flag
              determines whether a trace exception occurs ($P = 1$) or does not occur ($P = 0$)
              immediately after a Return instruction which restored the T flag to one.
              Note: The P flag can only be changed in the saved SR. No program except the
              trace exception handler should affect the saved P flag. The trace exception han-
              dler must clear the saved P flag to prevent a trace exception on return, in order
              to avoid tracing the same instruction in an endless loop.

S   Bit 18 is the supervisor state flag S (see section 1.5. Privilege States). It is set to
              one by any exception.

ILC   Bits 20 and 19 represent the instruction-length code ILC. It is updated by in-
              struction execution. The ILC holds (in general) the length of the last in-
              struction: ILC values of one, two or three represent an instruction length of one,
              two or three half-words respectively. After a branch taken, the ILC is invalid.
              The Return instruction clears the ILC.
              Note: Since a Return instruction following an exception clears the ILC, a pro-
              gram must not rely on the current value of the ILC.

FL   Bits 24..21 represent the frame length FL. The FL holds the number of usable
              local registers (maximum 16) assigned to the current stack frame.
              $FL = 0$ is always interpreted as $FL = 16$.

FP   Bits 31..25 represent the frame pointer FP. The least significant six bits of the
              FP point to the beginning of the current stack frame in the local register set,
              that is, they point to L0.
              The FP contains bit 8..2 of the address at which the content of L0 would be
              stored if pushed onto the memory part of the stack.

1.3.3. Floating-Point Exception Register FER

G2 is the floating-point exception register. Only bits 12..8 and 4..0 may be changed by a user program, all other bits must remain unchanged.
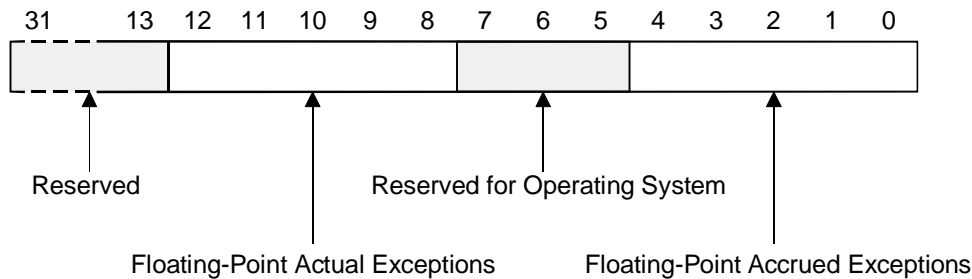
Figure 1.5: Floating-Point Exception Register

1.3.4. Stack Pointer SP

G18 is the stack pointer SP. The SP contains the top address + 4 of the memory part of the stack, that is the address of the first free memory location in which the first local register would be saved by a push operation (see section 3.29. Frame Instruction for details). Stack growth is from low to high address.

When the SP is set, bits one and zero must always be zero. The SP can be addressed only via the high global flag H being set. Copying an operand to the SP is a privileged operation.

1.3.5. Upper Stack Bound UB

G19 is the upper stack bound UB. The UB contains the address beyond the highest legal memory stack location. It is used by the Frame instruction to inhibit stack overflow.

When the UB is set, bits one and zero must always be zero. The UB can be addressed only via the high global flag H being set. Copying an operand to the UB is a privileged operation.

1.3.6. Bus Control Register BCR

G20 is the write-only bus control register BCR. Its content defines the options possible for bus cycle, parity and refresh control. The BCR can be addressed only via the high global flag H being set. Copying an operand to the BCR is a privileged operation. The BCR register is described in detail in the bus interface description in section 6.

1.3.7. Timer Prescaler Register TPR

G21 is the write-only timer prescaler register TPR. It adapts the timer clock to different processor clock frequencies and controls the processor clock generation by the PLL circuit. The TPR can be addressed only via the high global flag H being set. Copying an operand to the TPR is a privileged operation. The TPR is described in the timer description in section 5. Updating TPR with amended values for the PLL multiplication factor in conjunction with corresponding updated values for the timer prescaler changes the internal clock frequency while keeping all timer settings correct.

1.3.8. Timer Compare Register TCR

G22 is the timer compare register TCR. Its content is compared continuously with the content of the timer register TR. The TCR can be addressed only via the high global flag H being set. Copying an operand to the TCR is a privileged operation. The TCR is described in the timer description in section 5.

1.3.9. Timer Register TR

G23 is the timer register TR. Its content is incremented by one on each time unit. The TR can be addressed only via the high global flag H being set. Copying an operand to the TR is a privileged operation. The TR is described in the timer description in section 5.

1.3.10. Watchdog Compare Register WCR

G24 is the watchdog compare register WCR. The WCR can be addressed only via the high global flag H being set. Copying an operand to the WCR is a privileged operation. The WCR is described in the bus interface description in section 6.

1.3.11. Input Status Register ISR

G25 is the read-only input status register ISR. The ISR can be addressed only via the high global flag H being set. The ISR is described in the bus interface description in section 6.

1.3.12. Function Control Register FCR

G26 is the write-only function control register FCR. The FCR can be addressed only via the high global flag H being set. Copying an operand to the FCR is a privileged operation. The FCR is described in the bus interface description in section 6.

1.3.13. Memory Control Register MCR

G27 is the write-only memory control register MCR. The MCR can be addressed only via the high global flag H being set. Copying an operand to the MCR is a privileged operation. The MCR is described in the bus interface description in section 6.

1.4. Local Register Set

The architecture provides a set of 64 local registers of 32 bits each. The local registers 0..63 represent the register part of the stack, containing the most recent stack frame(s).

Figure 1.6: Local Register Set 0..63

The local registers can be addressed by the register code (0..15) of an instruction as L0..L15 only relative to the frame pointer FP; they can also be addressed absolutely as part of the stack in the stack address mode (see section 3.1.1. Address Modes).

The absolute local register address is calculated from the register code as:

absolute local register address := (FP + register code) modulo 64.

That is, only the least significant six bits of the sum FP + register code are used and thus, the absolute local register addresses for L0..L15 wrap around modulo 64.

The absolute local register addresses for FP + register code + 1 or FP + FL + offset are calculated accordingly.

1.5. Privilege States

The architecture provides two privilege states, determined by the supervisor state flag S: user state (S = 0) and supervisor state (S = 1).

The runtime kernel hyRTK is executed in the higher privileged supervisor state, thereby restricting access to all sensitive data to a highly reliable system program. The following operations are also privileged to be executed only in the supervisor or on return from supervisor to supervisor state:

❒ Copying an operand to any of the high global registers

❒ Changing the interrupt-lock flag L from zero to one

❒ Returning through a Return instruction to supervisor state

Any illegal attempt causes a trap to Privilege Error.

The S flag is also saved in bit zero of the saved return PC by the Call, Trap and Software instructions and by an exception. A Return instruction restores it from this bit position to the S flag in bit position 18 of the SR (thereby overwriting the bit 18 returned from the saved return SR).

If a Return instruction attempts a return from user to supervisor state, a trap to Privilege Error occurs (S = 1 is saved).

Returning from supervisor to user state is achieved by clearing the S flag in bit zero of the saved return PC before return. Switching from user to supervisor state is only possible by executing a Trap instruction or by exception processing through one of the 64 supervisor subprogram entries (see section 2.4. Entry Tables).

1.6. Register Data Types

```
31                                                    0        Register:

┌─────────────────────────────────────────────────┐
│ MSB              32 Bits                      LSB │    n
└─────────────────────────────────────────────────┘
```

Bitstring

```
31                                                    0

┌─────────────────────────────────────────────────┐
│ MSB         High-Order 32-Bits                    │    n
├─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─┤
│             Low-Order 32-Bits                LSB │    n+1
└─────────────────────────────────────────────────┘
```

Double-Word Bitstring

```
31                                                    0

┌─────────────────────────────────────────────────┐
│ MSB           32-Bit Magnitude               LSB │    n
└─────────────────────────────────────────────────┘
```

Unsigned Integer

```
31                                                    0

┌─────────────────────────────────────────────────┐
│ MSB       High-Order 32-Bit Magnitude             │    n
├─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─┤
│          Low-Order 32-Bit Magnitude          LSB │    n+1
└─────────────────────────────────────────────────┘
```

Unsigned Double-Word Integer

```
31                                                    0

┌─┬───────────────────────────────────────────────┐
│S│ MSB           31-Bit Magnitude            LSB │    n
└─┴───────────────────────────────────────────────┘
```

Signed Integer, Two's Complement

```
31                                                    0

┌─┬───────────────────────────────────────────────┐
│S│ MSB      High-Order 31-Bit Magnitude           │    n
├─┴─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─┤
│          Low-Order 32-Bit Magnitude          LSB │    n+1
└─────────────────────────────────────────────────┘
```

Signed Double-Word Integer, Two's Complement

```
31                        15                          0

┌─┬──────────────────────┬─┬──────────────────────┐
│S│ MSB              LSB │S│ MSB              LSB │    n
└─┴──────────────────────┴─┴──────────────────────┘
```

Two Signed Shorts

```
31                        15                          0

┌─┬──────────────────────┬─┬──────────────────────┐
│S│ MSB  Real Part   LSB │S│ MSB Imaginary Part LSB│    n
└─┴──────────────────────┴─┴──────────────────────┘
```

Complex Signed Short

```
31                                                    0

┌─┬─────────────┬───────────────────────────────────┐
│S│8-Bit Exponent│ MSB      23-Bit Fraction      LSB │    n
└─┴─────────────┴───────────────────────────────────┘
```

Single Precision Floating-Point Number

```
31                                                    0

┌─┬────────────────┬────────────────────────────────┐
│S│ 11-Bit Exponent│ MSB  High-Order 20-Bit Fraction │    n
├─┴────────────────┴─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ┤
│          Low-Order 32-Bit Fraction           LSB  │    n+1
└─────────────────────────────────────────────────── ┘
```

Double Precision Floating-Point Number

S = sign bit, MSB = most significant bit, LSB = least significant bit

Figure 1.7: Register Data Types

1.7. Memory Organization

The architecture provides a memory address space in the range of $0..2^{32} - 1$ (0..4 294 967 295) 8-bit bytes. Memory is implied to be organized as 32-bit words. The following memory data types are available (see figure 1.8)

❏ Byte unsigned (unsigned 8-bit integer, bit string or character)

❏ Byte signed (signed 8-bit integer, two's complement)

❏ Half-word unsigned (unsigned 16-bit integer or bit string)

❏ Half-word signed (signed 16-bit integer, two's complement)

❏ Word (32-bit undedicated word)

❏ Double-word (64-bit undedicated double-word)

Besides the memory address space, a separate I/O address space is provided. In the I/O address space, only word and double-word data types are available.

Words and double-words must be located at word boundaries, that is, their most significant byte must be located at an address whose two least significant bits are zero. Half-words must be located at half-word boundaries, their most significant byte being located at an address whose least significant bit is zero. Bytes may be located at any address.

The variable-length instructions are located as contiguous sequences of one, two or three half-words at half-word boundaries.

Memory- and I/O-accesses are pipelined to a depth of two words.

Note: All data is located high to low order at addresses ascending from low to high, that is, the high order part of all data is located at the lower address (big-endian).

1.7. Memory Organization (continued)

Figure 1.8 shows the location of data and instructions in memory relative to a binary address n = ...xxx00 (x = 0 or 1). The memory organization is big-endian.

31			0
Byte n	Byte n + 1	Byte n + 2	Byte n + 3

Halfword n	Halfword n + 2

Byte n	Byte n + 1	Halfword n + 2

Halfword n	Byte n + 2	Byte n + 3

Word n

High-Order Word n of Double-Word
Low-Order Word n + 4 of Double-Word

1st Instruction Halfword	2nd Instruction Halfword (opt.)
3rd Instruction Halfword (opt.)	

Preceding Instruction	1st Instruction Halfword
2nd Instruction Halfword (opt.)	3rd Instruction Halfword (opt.)

Figure 1.8: Memory Organization

At all data types, the most significant bit is located at the higher and the least significant bit at the lower bit position.

1.8. Stack

A runtime stack, called stack here, holds generations of local variables in last-in-first-out order. A generation of local variables, called stack frame or activation record, is created upon subprogram entry and released upon subprogram return.

The runtime stack provided by the architecture is divided into a memory part and a register part. The register part of the stack, implemented by a set of 64 local registers organized as a circular buffer, holds the most recent stack frame(s). The current stack frame is always kept in the register part of the stack. The frame pointer FP points to the beginning of the current stack frame (addressed as register L0). The frame length FL indicates the number of registers (maximum 16) assigned to the current stack frame. The stack grows from low to high address. It is guarded by the upper stack bound UB.

The stack is maintained as follows:

❐ A Call, Trap or Software instruction increments the FP and sets FL to six, thus creating a new stack frame with a length of six registers (including the return PC and the return SR).

❐ An exception increments the FP by the value of FL and then sets FL to two.

❐ A Frame instruction restructures a stack frame to include (optionally) passed parameters by decrementing the FP and by resetting the FL to the desired length, and restores a reserve of 10 local registers for the next subprogram call. If the required number of registers + 10 do not fit in the register part of the stack, the contents of the differential (required + 10 - available) number of local registers are pushed onto the memory part of the stack. A trap to Frame Error occurs after the push operation when the old value of the stack pointer SP exceeded the upper stack bound UB.

❐ A Return instruction releases the current stack frame and restores the preceding stack frame. If the restored stack frame is not fully contained in the register part of the stack, the content of the missing part of the stack frame is pulled from the memory part of the stack.

For more details see the descriptions of the specific instructions.

When the number of local registers required for a stack frame exceeds its maximum length of 16 (in rare cases), a second runtime stack in memory may be used. This second stack is also required to hold local record or array data.

The stack is used by routines in user or supervisor state, that is, supervisor stack frames are appended to user stack frames, and thus, parameters can be passed between user and supervisor state. A small stack space must be reserved above UB. UB can then be set to a higher value by the Frame Error handler to free stack space for error handling.

1.8. Stack (continued)

Because the complete stack management is accomplished automatically by the hardware, programming the stack handling instructions is easy and does not require any knowledge of the internal working of the stack.

The following example demonstrates how the Call, Frame and Return instructions are applied to achieve the stack behavior of the register part of the stack shown in the figures 1.9 and 1.10.

A currently activated function A has a frame length of $FL = 13$. Registers L0..L6 are to be retained through a subsequent call, registers L7..L12 are temporaries. A call to function B needs 2 parameters to be passed. The parameters are placed by function A in registers L7 and L8 before calling B. The Call instruction addresses L9 as destination for the return PC and return SR register pair to be used by function B on return to function A.

On entry of function B, the new frame of B has an implicit length of $FL = 6$. It starts physically at the former register L9 of frame A. However, since the frame pointer FP has been incremented by 9 by the Call instruction, this register location is now being addressed as L0 of frame B. The passed parameters cannot be addressed because they are located below the new register L0 of frame B. To make them addressable, a Frame instruction decrements the frame pointer FP by 2. Then, parameter 1 and 2 passed to B can be addressed as registers L0 and L1 respectively. Note that the return PC is now to be addressed as L2!

The Frame instruction in B specifies also the new, complete frame length $FL = 11$ (including the passed parameters as well as the return PC and return SR pair). Besides, a new reserve of 10 registers for subsequent function calls and traps is provided in the register stack. A possible overflow of the register stack is checked and handled automatically by the Frame instruction. A program needs not and must not pay attention to register stack overflow.

At the end of function B, a Return instruction returns control to function A and restores the frame A. A possible underflow of the register stack is handled also automatically; thus, the frame A is always completely restored, regardless whether it was wholly or partly pushed into the memory part of the stack before (in the case when B called other functions).

In the present example with the frame length of $FL = 13$, any suitable destination register up to L13 could be specified in the Call instruction. The parameters to be passed to the function B would then be placed in L11 and L12. It is even possible to append a new frame to a frame with a length of $FL = 16$ (coded as $FL = 0$ in the status register SR): the destination register in the Call instruction is then coded as L0, but interpreted as the register past L15.

See also sections 3.27. Call instruction, 3.29. Frame instruction and 3.30. Return instruction for further details.

Note: With an average frame length of 8 registers, ca. 7..8 Frame instructions succeed a pulling Return instruction until a push occurs and 7..8 Return instructions succeed a pushing Frame instruction until a pull occurs. Thus, the built-in hysteresis makes pushing and pulling a rare event in regular programs.

1.8. **Stack** (continued)

Program Example:

```
A:  FRAME   L13, L3      ; set frame length FL = 13, decrement FP by 3
            :            ; parameters passed to A can be addressed
            :            ; in L0, L1, L2
            :
            :
    code of function A
            :
            :
    MOV     L7, L5       ; copy L5 to L7 for use as parameter1
    MOVI    L8, 4        ; set L8 = 4 for use as parameter2
    CALL    L9, 0, B     ; call function B,
            :            ; save return PC, return SR in L9, L10
            :
            :
    MOVI    L0, 20       ; set L0 = 20 as return parameter for caller
    RET     PC, L3       ; return to function calling A,
                         ; restore frame of caller




B:  FRAME   L11, L2      ; set frame length FL = 11, decrement FP by 2
            :            ; passed parameter1 can now be addressed in L0
            :            ; passed parameter2 can now be addressed in L1
            :
            :
    code of function B
            :
            :
    RET     PC, L2       ; return to function A, frame A is restored by
                         ; copying return PC and return SR in L2 and L3
                         ; of frame B to PC and SR
```

1.8. Stack (continued)

Figure 1.9 shows the creation and release of stack frames in the register part of the stack.

Return from B	Call B	Frame in B

PC := ret. PC for B;
SR := ret. SR for B;
-- returns preceding stack frame
if stack frame contained
in local registers then
   next instruction;
else
   pull contents of differential words
   from memory part of the stack;
	PC := branch address;
	ret. PC for B := old PC;
	ret. SR for B := old SR;
	FP := FP + reg.code
	   of ret. PC;
	FL := 6;
	-- reg.code of ret. PC = 9
		FP := FP - code of source reg.;
		FL := code of dest.reg.;
		if available registers ≥
		(required + 10) registers then
		   next instruction
		else
		   push contents of
		   differential number of
		   registers to memory
		   part of stack;
		   -- code of source reg. = 2
		   -- code of dest.reg. = 11

Figure 1.9: Stack frame handling (register part)

1.8. Stack (continued)

before Frame Instruction for frame X

register part
of the stack
A and X
overlap modulo 64

memory part
of the stack

A

| words to be pushed |

rest of frame A

various frames

FP

space available for X

X   additional space for X required

stack space required

SP

pushed number
of words
according to
space required
for frame X

after Frame Instruction for frame X

register part
of the stack

memory part
of the stack

rest of frame A

various frames

FP

additional space for X available

stack space appended

SP

before Return Instruction to frame A

FP

A

frame words for A required

rest of frame A

various frames

X   words to be overwritten

words to be pulled

SP

pulled number
of words
completes
stack frame A!

after Return Instruction to frame A

FP

A

frame words pulled

rest of frame A

various frames

stack space freed

SP

= available part of a frame

Figure 1.10: Stack frame pushing and popping

1.9. Instruction Cache

The instruction cache is transparent to programs. A program executes correctly even if it ignores the cache, whereby it is assumed that a program does not modify the instruction code in the local range contained in the cache.

The instruction cache holds a total of up to 128 bytes (32 unstructured 32-bit words of instructions). It is implemented as a circular buffer which is guarded by a look-ahead counter and a look-back counter. The look-ahead counter holds the highest and the look-back counter the lowest address of the instruction words available in the cache. The cache-mode flag M is used to optimize special cases in loops (see details below). The cache can be regarded as a temporary local window into the instruction sequence, moving along with instruction execution and being halted by the execution of a program loop.

Its function is as follows:

The prefetch control loads unstructured 32-bit instruction words (without regard to instruction boundaries) from memory into the cache. The load operation is pipelined to a depth of two stages (see section 3.1. Memory Instructions for details of the load pipeline). The look-ahead counter is incremented by four at each prefetch cycle. It always contains the address of the last instruction word for which an address bus cycle is initiated, regardless of whether the addressed instruction word is in the load pipeline or already loaded into the instruction cache.

The prefetched instruction word is placed in the cache word location addressed by bits 6..2 of the look-ahead counter. The look-back counter remains unchanged during prefetch unless the cache word location it addresses with its bits 6..2 is overwritten by a prefetched instruction word. In this case, it is incremented by four to point to the then lowest-addressed usable instruction word in the cache. Since the cache is implemented as a circular buffer, the cache word addresses derived from bits 6..2 of the look-ahead and look-back counter wrap around modulo 32.

The prefetch is halted:

❒ When eight words are prefetched, that is, eight words are available (including those pending in the load pipeline) in the prefetch sequence succeeding the instruction word addressed by the program counter PC through the instruction word addressed by the look-ahead counter. Prefetch is resumed when the PC is advanced by instruction execution.

❒ In the cycle preceding the execution cycle of an instruction accessing memory or I/O or any potentially branch-causing instruction (regardless of whether the branch is taken) except a forward Branch or Delayed Branch instruction with an instruction length of one half-word and a branch target contained in the cache. Halting the prefetch in these cases avoids filling the load pipeline with demands for potentially unnecessary instruction words. The prefetch is also halted during the execution cycle of any instruction accessing memory or I/O.

1.9. Instruction Cache (continued)

The cache is read in the decode cycle by using bits 6..1 of the PC as an address to the first half-word of the instruction presently being decoded. The instruction decode needs and uses only the number (1, 2 or 3) of instruction half-words defined by the instruction format. Since only the bits 6..1 of the PC are used for addressing, the half-word addresses wrap around modulo 64. Idle wait cycles are inserted when the instruction is not or not fully available in the cache.

At an explicit Branch or Delayed Branch instruction (except when placed as delay instruction) with an instruction length of one half-word, the location of the branch target is checked. The branch target is treated as being in the cache when the target address of a backward branch is not lower than the address in the look-back counter and the target address of a forward branch is not higher than two words above the address in the look-ahead counter. That is, the two instruction words succeeding the instruction word addressed by the content of the look-ahead counter are treated by a forward branch as being in the cache. Their actual fetch overlaps in most cases with the execution of the branch instruction and thus, no cycles are wasted. When the branch target is in the cache, the look-back counter and the look-ahead counter remain unchanged.

When a branch is taken by a Delayed Branch instruction with an instruction length of one half-word to a forward branch target not in the cache and the cache mode flag M is enabled (1), the look-back counter and the look-ahead counter remain unchanged. Wait cycles are then inserted until the ongoing prefetch has loaded the branch target instruction into the cache.

Any other branch taken flushes the cache by placing the branch address in the look-back and the look-ahead counter. Prefetch then starts immediately at the branch address. Instruction decoding waits until the branch target instruction is fully available in the cache.

The cache mode flag M (bit four of the SR) can be set or cleared by logical instructions. It is automatically cleared by a Frame instruction and by any branch taken except a branch caused by a Delayed Branch or Return instruction; a Delayed Branch instruction leaves the M flag unchanged and a Return instruction restores the M flag from the saved status register SR.

Note: Since up to eight instruction words can be loaded into the cache by the prefetch, only 24 instruction words are left to be contained in a program loop. Thus, a program loop can have a maximum length of 96 or 94 bytes including the branch instruction closing the loop, depending on the even or odd half-word address location of the first instruction of the loop respectively.

A forward Branch or Delayed Branch instruction with an instruction length of one half-word into up to two instruction words succeeding the word addressed by the look-ahead counter treats the branch target as being in the cache and does not flush the cache. Thus, three or four instruction half-words, depending on the odd or even half-word address location of the branch instruction respectively, can always be skipped without flushing the cache.

1.9. Instruction Cache (continued)

Enabling the cache-mode flag M is only required when a program loop to be contained in the cache contains a forward branch to a branch target in the program loop and more than three (or four, see above) instruction half-words are to be skipped. In this case, the enabled M flag in combination with a Delayed Branch instruction with an instruction length of one half-word inhibits flushing the cache when the branch target is not yet prefetched.

Since a single-word memory instruction halts the prefetch for two cycles, any sequence of memory instructions, even with interspersed one-cycle non-memory instructions, halts the prefetch during its execution. Thus, alternating between instruction and data memory pages is avoided. If the number of instruction half-words required by such a sequence is not guaranteed to be in the cache at the beginning of the sequence, a Fetch instruction enforcing the prefetch of the sequence may be used. A Fetch instruction may also be used preceding a branch into a program loop; thus, flushing the cache by the first branch repeating the loop can be avoided.

A branch taken caused by a Branch or Delayed Branch instruction with an instruction length of two half-words always flushes the instruction cache, even if the branch target is in the cache. Thus, branches can be forced to bypass the cache, thereby reducing the cache to a prefetch buffer. This reduced function can be used for testing.

1.10. On-Chip Memory (IRAM)

16 KBytes of memory are provided on-chip. The on-chip memory (IRAM) is mapped to the hex address C000 0000 of the memory address space and wraps around modulo 16K up to DFFF FFFF. The IRAM is implemented as a fully static memory block.

An access to the IRAM bypasses the access pipeline of the external memory. Thus, pending external memory accesses do not delay accesses to the IRAM. The IRAM can hold data as well as instructions. Instruction words from the IRAM are automatically transferred to the instruction cache on demand; these transfers do not interfere with external memory accesses. Besides bypassing of the external memory pipeline, memory instructions accessing the IRAM behave exactly alike those accessing external memory. The minimum delay for a load access is one cycle; that is, the data is not available in the cycle after the load instruction. One or more wait cycles are automatically inserted if the target register of the load is addressed before the data is loaded into the target register.

Attention: For selection between an internal and external memory access, bits 31..29 of the specified address register are used before calculation of the effective address. Therefore, the content of the specified address register must point into the IRAM address range. The IRAM address range boundary must not be crossed when the effective memory address is calculated in the displacement address mode.

2. Instructions General

2.1. Instruction Notation

In the following instruction-set presentation, an informal description of an instruction is followed by a formal description in the form:

Format   Notation   Operation

Format denotes the instruction format.

Notation gives the assembler notation of the instruction.

Operation describes the operation with the following symbols:

Ls   denotes any of the local registers L0..L15 used as source register or as source operand. At memory Load instructions, Ls denotes the load destination register.

Ld   denotes any of the local registers L0..L15 used as destination register or as destination operand.

Rs   denotes any of the local registers L0..L15 or any of the global registers G0..G15 used as source register or as source operand. At memory Load instructions, Rs denotes the load destination register.

Rd   denotes any of the local registers L0..L15 or any of the global registers G0..G15 used as destination register or as destination operand.

Lsf, Ldf, Rsf and Rdf denote the register or operand following after (with a register address one higher than) Ls, Ld, Rs and Rd respectively.

imm, const, dis, lim, rel, adr and n denote immediate operands (constants) of various formats and ranges.

Operand(x) denotes a single bit at the bit position x of an operand.
        Example: Ld(31) denotes bit 31 of Ld.

Operand(x..y) denotes bits x through y of an operand.
        Example: Ls(4..0) denotes bits 4 through 0 of Ls.

Expression^ denotes an operand at a location addressed by the value of the expression. Depending on the context, the expression addresses a memory location or a local register.
        Example: Ld^ denotes a memory operand whose memory address is the operand Ld. (FP + FL)^ denotes a local register operand whose register address is FP + FL.

:=   signifies the assignment symbol, read as "is replaced by".

//   signifies the concatenation symbol. It denotes concatenation of two operand words to a double-word operand or concatenation of bits and bitstrings.
        Examples: Ld//Ldf denotes a double-word operand, 16 zeros//imm1 denotes expanding of an immediate half-word by 16 leading zeros.

=, ≠, > and < denote the equal, unequal, greater than and less than relations.
        Example: The relation Ld = 0 evaluates to one if Ld is equal to zero, otherwise it evaluates to zero.

2.2. Instruction Execution

On instruction execution, all bits of the operands participate in the operations, except on the Shift and Rotate instructions (whereat only the 5 least significant bits of the source operand are used) and except on the byte and half-word Store instructions.

Instructions are executed by a two-stage pipeline. In the first stage, the instruction is fetched from the instruction cache and decoded. In the second stage, the instruction is executed while the next instruction in the first stage is already decoded.

On register instructions executing in one or two cycles, the corresponding source and destination operand words are read from their registers and evaluated in each cycle in which they are used. Then the result word is placed in the corresponding destination register in the same cycle. Thus, on all single-word register instructions executing in one cycle, the source operand register and the destination operand register may coincide without changing the effect of the instruction. On all other instructions, the effect of a register coincidence depends on execution order and must be examined specifically for each such instruction.

The content of a source register remains unchanged unless it is used coincidentally as a destination register (except on memory Load instructions).

Some instructions set or clear condition flags according to the result and special conditions occuring during their execution. The conditions may be expressed by single bits, relations or logical combinations of these. If a condition evaluates to one (true), the corresponding condition flag is set to one, if it evaluates to zero (false), the corresponding condition flag is cleared to zero. If the conditions for a Range Error are met, a trap to Range Error occurs after the flags and the destination are updated.

All instructions may use the result and any flags updated by the preceding instruction. A time penalty occurs only if the result of a memory Load instruction is not yet available when needed as destination or source operand. In this case one or more (depending on the memory access time) idle wait cycles are enforced by a hardware interlock.

An instruction must not use any local register of the register sequence beginning with L0 beyond the number of usable registers specified by the current value of the frame length FL (FL = 0 is interpreted as FL = 16). That is, the value of the corresponding register code (0..15) addressing a local register must be lower than the interpreted value of the FL (except with a Call or Frame instruction or some restricted cases). Otherwise, an exception could overwrite the contents of such a register or the beginning of the register part of the stack at the SP could be overwritten without any warning when a result is placed in such a register.

Double-word instructions denote the high-order word (at the lower address). The low-order word adjacently following it (at the higher address) is implied.

"Old" denotes the state before the execution of an instruction.

2.3. Instruction Formats

Instructions have a length of one, two or three half-words and must be located on half-word boundaries. The following formats are provided:

Format   **Configuration**

LL

15	8	7	4	3	0
OP-code		Ld-code		Ls-code	

Ls-code encodes L0..L15 for Ls
Ld-code encodes L0..L15 for Ld

LLext

15	8	7	4	3	0
OP-code		Ld-code		Ls-code	
OP-code extension					

Ls-code encodes L0..L15 for Ls
Ld-code encodes L0..L15 for Ld
OP-code extension encodes the
EXTEND instructions

LR

15	9	8	7	4	3	0
OP-code		s	Ld-code		Rs-code	

s = 0: Rs-code encodes G0..G15 for Rs
s = 1: Rs-code encodes L0..L15 for Rs
Ld-code encosed L0..L15 for Ld

RR

15	10	9	8	7	4	3	0
OP-Code		d	s	Rd-code		Rs-code	

s = 0: Rs-code encodes G0..G15 for Rs
s = 1: Rs-code encodes L0..L15 for Rs
d = 0: Rd-code encodes G0..G15 for Rd
d = 1: Rd-code encodes L0..L15 for Rd

Ln

15	9	8	7	4	3	0
OP-code		n	Ld-code		n	

Ld-code encodes L0..L15 for Ld
n: Bit 8//bits 3..0 encode n = 0..31

Rn

15	10	9	8	7	4	3	0
OP-Code		d	n	Rd-code		n	

d = 0: Rd-code encodes G0..G15 for Rd
d = 1: Rd-code encodes L0..L15 for Rd
n: Bit 8//bits 3..0 encode n = 0..31

PCadr

15	8	7	0
OP-code		adr-byte	

adr = 24 ones's//adr-byte(7..2)//00

PCrel

15	8	7	6	1	0
OP-code		0	low-rel		S

S: sign bit of rel
rel = 25 S//low-rel//0
range -128..126

PCrel

15	8	7	6	1	0
OP-code		1	high-rel		
low-rel					S

S: sign bit of rel
rel = 9 S//high-rel//low-rel//0
range -8 388 608..8 388 606

Table 2.1: Instruction Formats, Part 1

2.3. Instruction Formats (continued)

Format   **Configuration**

LRconst

15 14	9 8	7	4 3	0
OP-code	s	Ld-code	Rs-code	

e	S	const1

const2

s = 0: Rs-code encodes G0..G15 for Rs
s = 1: Rs-code encodes L0..L15 for Rs
      Ld-code encodes L0..L15 for Ld
S: Sign bit of const
e = 0: const = 18 S//const1
      range -16 384..16 383
e = 1: const = 2 S//const1//const2
      range -1 073 741 824..1 073 741 8

RRconst

15 14	10 9	8	7	4 3	0
OP-code	d	s	Rd-code	Rs-code	

e	S	const1

const2

s = 0: Rs-code encodes G0..G15 for Rs
s = 1: Rs-code encodes L0..L15 for Rs
d = 0: Rd-code encodes G0..G15 for Rd
d = 1: Rd-code encodes L0..L15 for Rd
S: Sign bit of const
e = 0: const = 18 S//const 1
      range -16 384..16 383
e = 1: const = 2 S//const1//const2
      range -1 073 741 824..1 073 741 8

RRdis

15 14	10 9	8	7	4 3	0
OP-code	d	s	Rd-code	Rs-code	

e	S	D D	dis1

dis2

s = 0: Rs-code encodes G0..G15 for Rs
s = 1: Rs-code encodes L0..L15 for Rs
d = 0: Rd-code encodes G0..G15 for Rd
d = 1: Rd-code encodes L0..L15 for Rd
S: Sign bit of dis
e = 0: dis = 20 S//dis1
      range -4 096..4 095
e = 1: dis = 4 S//dis1//dis2
      range -268 435 456..268 435 455
DD: D-code, D13..D12 encode data
      types at memory instructions

Rimm

15	10 9	8	7	4 3	0
OP-code	d	n	Rd-code	n	

imm1

imm2

d = 0: Rd-code encodes G0..G15 for Rd
d = 1: Rd-code encodes L0..L15 for Rd
n: Bit 8//bits 3..0 encode n = 0..31
      see Table 2.3. Encoding of
      Immediate Values for encoding of
      imm

RRlim

15 14	10 9	8	7	4 3	0
OP-code	d	s	Rd-code	Rs-code	

e	X X X	lim1

lim2

s = 0: Rs-code encodes G0..G15 for Rs
s = 1: Rs-code encodes L0..L15 for Rs
d = 0: Rd-code encodes G0..G15 for Rd
d = 1: Rd-code encodes L0..L15 for Rd
XXX: X-code, X14..X12 encode Index
      instructions
e = 0: lim = 20 zeros//lim1
      range 0..4 095
e = 1: lim = 4 zeros//lim1//lim2
      range 0..268 435 455

Table 2.2: Instruction Formats, Part 2

2.3.1. Table of Immediate Values

n	immediate value imm	Comment
0..16	0..16	at CMPBI, n = 0 encodes ANYBZ at ADDI and ADDSI n = 0 encodes CZ
17	imm1//imm2	range = $0..2^{32}-1$ or $-2^{31}..2^{31}-1$
18	16 zeros//imm1	range = 0..65 535
19	16 ones//imm1	range = -65 536..-1
20	32	bit 5 = 1, all other bits = 0
21	64	bit 6 = 1, all other bits = 0
22	128	bit 7 = 1, all other bits = 0
23	2^{31}	bit 31 = 1, all other bits = 0
24	-8	
25	-7	
26	-6	
27	-5	
28	-4	
29	-3	
30	-2	
31	$2^{31}-1$	at CMPBI and ANDNI bit 31 = 0, all other bits = 1
31	-1	at all other instructions using imm

Table 2.3: Encoding of Immediate Values

Note: 2^{31} provides clear, set and invert of the floating-point sign bit at ANDNI, ORI and XORI respectively.

2^{31}-1 provides a test for floating-point zero at CMPBI and extraction of the sign bit at ANDNI.

See CMPBI for ANYBZ and ADDI, ADDSI for CZ.

2.3.2. Table of Instruction Codes

OP-code Bits 15..12 (rows) × OP-code Bits 11..8 (columns)

	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0	CHK, CHKZ, NOP				MOVD, RET				DIVU				DIVS			
1		XMx, XXx				MASK					SUM				SUMS	
2			CMP			MOV					ADD				ADDS	
3				CMPB		ANDN					OR				XOR	
4			SUBC			NOT					SUB				SUBS	
5			ADDC			AND					NEG				NEGS	
6			CMPI			MOVI					ADDI				ADDSI	
7				CMPBI		ANDNI					ORI				XORI	
8		SHRDI	SHRD	SHR		SARDI	SARD	SAR		SHLDI	SHLD	SHL	RESERVED		TESTLZ	ROL
9	LDxx.D/A/IOD/IOA				LDxx.N/S				STxx.D/A/IOD/IOA				STxx.N/S			
A			SHRI				SARI				SHLI			RESERVED		
B			MULU				MULS		SETxx, SETADR, FETCH					MUL		
C	FADD	FADDD	FSUB	FSUBD	FMUL	FMULD	FDIV	FDIVD	FCMP	FCMPD	FCMPU	FCMPUD	FCVT	FCVTD	EXTEND	DO
D	LDW.R		LDD.R		LDW.P		LDD.P		STW.R		STD.R		STW.P		STD.P	
E	DBV	DBNV	DBE	DBNE	DBC	DBNC	DBSE	DBHT	DBN	DBNN	DBLE	DBGT	DBR	FRAME	CALL	
F	BV	BNV	BE	BNE	BC	BNC	BSE	BHT	BN	BNN	BLE	BGT	BR	TRAPxx, TRAP		

Table 2.4: Table of Instruction Codes

2.3.3. Table of Extended DSP Instruction Codes

The Extended DSP instructions are specified by a 16-bit OP-code extension succeeding the instruction op-code for the EXTEND instruction. See section 3.32. Extended DSP Instructions.

Instruction	OP-code exten-sion (hex)
EMUL	0102
EMULU	0104
EMULS	0106
EMAC	010A
EMACD	010E
EMSUB	011A
EMSUBD	011E
EHMAC	002A
EHMACD	002E
EHCMULD	0046
EHCMACD	004E
EHCSUMD	0086
EHCFFTD	0096
EHCFFTSD	0296

Table 2.5: Extended DSP Instruction Codes

2.4. Entry Tables

Spacing of the entries for the Trap instructions and exceptions is four bytes. These entries are intended to each contain an instruction branching to the associated function. The entries for the TRAPxx instructions are the same as for TRAP. Table 2.6 shows the trap entries when the entry table is mapped to the end of memory area MEM3 (default after Reset):

Address (Hex)	Entry	Description
FFFF FF00	TRAP 0	
FFFF FF04	TRAP 1	
:	:	
FFFF FFC0	TRAP 48	IO2 Interrupt -- priority 15
FFFF FFC4	TRAP 49	IO1 Interrupt -- priority 14
FFFF FFC8	TRAP 50	INT4 Interrupt -- priority 13
FFFF FFCC	TRAP 51	INT3 Interrupt -- priority 11
FFFF FFD0	TRAP 52	INT2 Interrupt -- priority 9
FFFF FFD4	TRAP 53	INT1 Interrupt -- priority 7
FFFF FFD8	TRAP 54	IO3 Interrupt -- priority 5
FFFF FFDC	TRAP 55	Timer Interrupt -- priority selectable as 6, 8, 10, 12
FFFF FFE0	TRAP 56	Reserved -- priority 17 (lowest)
FFFF FFE4	TRAP 57	Trace Exception -- priority 16
FFFF FFE8	TRAP 58	Parity Error -- priority 4
FFFF FFEC	TRAP 59	Extended Overflow -- priority 3
FFFF FFF0	TRAP 60	Range, Pointer, Frame and Privilege Error -- priority 2
FFFF FFF4	TRAP 61	Reserved -- priority 1
FFFF FFF8	TRAP 62	Reset -- priority 0 (highest)
FFFF FFFC	TRAP 63	Error entry for instruction code of all ones

Table 2.6: Trap entry table mapped to the end of MEM3

2.4. Entry Tables (continued)

Table 2.7 shows the trap entries when the entry table is mapped to the beginning of memory areas MEM0, MEM1, MEM2 or IRAM. x is 0, 4, 8 or C corresponding to the mapping to MEM0, MEM1, MEM2 or IRAM respectively.

Address (Hex)	Entry	Description
x000 0000	TRAP 63	Error entry for instruction code of all ones
x000 0004	TRAP 62	Reserved -- priority 0 (highest)
x000 0008	TRAP 61	Reserved -- priority 1
x000 000C	TRAP 60	Range, Pointer, Frame and Privilege Error -- priority 2
x000 0010	TRAP 59	Extended Overflow -- priority 3
x000 0014	TRAP 58	Parity Error -- priority 4
x000 0018	TRAP 57	Trace Exception -- priority 16
x000 001C	TRAP 56	Reserved -- priority 17 (lowest)
x000 0020	TRAP 55	Timer Interrupt -- priority selectable as 6, 8, 10, 12
x000 0024	TRAP 54	IO3 Interrupt -- priority 5
x000 0028	TRAP 53	INT1 Interrupt -- priority 7
x000 002C	TRAP 52	INT2 Interrupt -- priority 9
x000 0030	TRAP 51	INT3 Interrupt -- priority 11
x000 0034	TRAP 50	INT4 Interrupt -- priority 13
x000 0038	TRAP 49	IO1 Interrupt -- priority 14
x000 003C	TRAP 48	IO2 Interrupt -- priority 15
:	:	
x000 00F8	TRAP 1	
x000 00FC	TRAP 0	

Table 2.7: Trap entry table mapped to the beginning of MEM0, MEM1, MEM2 or IRAM

2.4. Entry Tables (continued)

Table 2.8 below shows the addresses of the first instruction of the emulator code associated with the floating-point instructions when the trap entry tables are mapped to the end of memory area MEM3. Spacing of the entries for the Software instructions FADD..DO is 16 bytes.

Address (Hex)	Entry	Description
FFFF FE00	FADD	Floating-point Add, single word
FFFF FE10	FADDD	Floating-point Add, double-word
FFFF FE20	FSUB	Floating-point Subtract, single word
FFFF FE30	FSUBD	Floating-point Subtract, double-word
FFFF FE40	FMUL	Floating-point Multiply, single word
FFFF FE50	FMULD	Floating-point Multiply, double-word
FFFF FE60	FDIV	Floating-point Divide, single word
FFFF FE70	FDIVD	Floating-point Divide, double-word
FFFF FE80	FCMP	Floating-point Compare, single word
FFFF FE90	FCMPD	Floating-point Compare, double-word
FFFF FEA0	FCMPU	Floating-point Compare Unordered, single word
FFFF FEB0	FCMPUD	Floating-point Compare Unordered, double-word
FFFF FEC0	FCVT	Floating-point Convert single word $\Rightarrow$ double-word
FFFF FED0	FCVTD	Floating-point Convert double-word $\Rightarrow$ single word
FFFF FEE0		Reserved
FFFF FEF0	DO	Do instruction

Table 2.8: Floating-Point entry table mapped to the end of MEM3

2.4. Entry Tables (continued)

Table 2.9 below shows the addresses of the first instruction of the emulator code associated with the floating-point instructions when the trap entry tables are mapped to the beginning of memory areas MEM0, MEM1, MEM2 or IRAM. x is 0, 4, 8 or C corresponding to the mapping to MEM0, MEM1, MEM2 or IRAM respectively.

Address (Hex)	Entry	Description
x000 010C	DO	Do instruction
x000 011C		Reserved
x000 012C	FCVTD	Floating-point Convert double-word $\Rightarrow$ single word
x000 013C	FCVT	Floating-point Convert single word $\Rightarrow$ double-word
x000 014C	FCMPUD	Floating-point Compare Unordered, double-word
x000 015C	FCMPU	Floating-point Compare Unordered, single word
x000 016C	FCMPD	Floating-point Compare, double-word
x000 017C	FCMP	Floating-point Compare, single word
x000 018C	FDIVD	Floating-point Divide, double-word
x000 019C	FDIV	Floating-point Divide, single word
x000 01AC	FMULD	Floating-point Multiply, double-word
x000 01BC	FMUL	Floating-point Multiply, single word
x000 01CC	FSUBD	Floating-point Subtract, double-word
x000 01DC	FSUB	Floating-point Subtract, single word
x000 01EC	FADDD	Floating-point Add, double-word
x000 01FC	FADD	Floating-point Add, single word

Table 2.9: Floating-Point entry table mapped to the beginning of MEM0, MEM1, MEM2 or IRAM

2.5. Instruction Timing

The following execution times are given in number of processor clock cycles.

All instructions not shown below: 1 cycle

Move double-word: 2 cycles

Shift double-word: 2 cycles

Test Leading Zeros: 2 cycles

Multiply word:
>   when both operands are in the range of $-2^{15}..2^{15}-1$: 3 cycles
>   all other cases: 5 cycles

Multiply double-word signed:
>   when both operands are in the range of $-2^{15}..2^{15}-1$: 4 cycles
>   all other cases: 6 cycles

Multiply double-word unsigned:
>   when both operands are in the range of $0..2^{16}-1$: 4 cycles
>   all other cases: 6 cycles

Divide unsigned and signed: 36 cycles

Branch instructions when branch not taken: 1 cycle
>   when branch taken and target in on-chip cache: 2 cycles
>   when branch taken and target in memory : 2 + memory read latency cycles
>   (see next page)

Delayed Branch instructions when branch not taken: 1 cycle
>   when branch taken and target in on-chip cache: 1 cycle
>   when branch taken and target in memory: 1 + memory read latency cycles exceeding
>   (delay instruction cycles - 1)

Call and Trap instructions when branch not taken: 1 cycle
>   when branch taken: 2 + memory read latency cycles

Software instructions: 6 + memory read latency cycles exceeding 4 cycles

Frame when not pushing words on the stack: 3 cycles
>   additionally when pushing n words on the stack: memory write latency cycles
>   + n * bus cycles per access
>   -- write latency = cycles elapsed until write access cycle of first word stored (mini-
>   mum = 1 at a non-RAS access and no pipeline congestion)

Return:
>   4 + memory read latency cycles exceeding 2 cycles
>   additionally when pulling n words from the stack: memory RAS latency
>   + n * bus cycles per access
>   (RAS latency applies only at n > 2, otherwise RAS latency is always 0)
>   -- RAS latency = RAS precharge cycles + RAS to CAS delay cycles

2.5. Instruction Timing (continued)

Fetch instruction:

> when the required number of instruction half-words are already prefetched in the instruction cache: 1 cycle
>
> otherwise
>
> 1 + (required number of half-words - number of half-words already prefetched)/2
> * bus cycles per access

Memory word instructions, non-stack address mode:

> 1 cycle

Memory word instructions, stack address mode:

> 3 cycles

Memory double-word instructions:

> 2 cycles

For timing calculations, double-word memory instructions are treated like a sequence of two single-word memory instructions.

Idle wait cycles are transparently inserted when a memory instruction has to wait for execution because the two-stage address pipeline is full.

Instruction execution proceeds after the execution of a Load instruction until the data requested is needed (that is, the register into which the data is to be loaded is addressed) by a further instruction.

The cycles executed between the memory instruction cycle requesting the data and the first cycle at which the data are available are called read latency cycles. These read latency cycles can be filled with instructions which do not need the requested data. When, after the execution of these optional fill instruction cycles, the data is still not available in the cycle needing it, idle wait cycles are inserted until the data is available. The idle wait cycles are inserted transparently to the program by an on-chip hardware interlock. The read latency is:

On an IRAM access:

> read latency = 1 cycle

On a non-RAS external memory or I/O access:

> read latency = address setup cycles + access cycles + 1

On a RAS memory access:

> read latency =   RAS precharge cycles + RAS to CAS delay cycles +
> access cycles + 1

Additional cycles are also inserted and add to the latency when the address pipeline is congested, these cycles must then also be taken into calculation.

A switch from an external memory or I/O read access to an immediately succeeding write access inserts one additional bus cycle.

Extended DSP instructions:

The instruction issue time is always 1 cycle. After the issue of an Extended DSP instruction, execution of non-Extended-DSP instructions proceeds while the Extended DSP instruction is executed in the multiply/accumulate unit.

2.5. Instruction Timing (continued)

Latency cycles are defined as the time that the multiply-accumulate execution unit is busy executing the Extended DSP instruction. In the last latency cycle of an Extended DSP instruction that is currently executed, the issue cycle of the next Extended DSP instruction may take place. An Extended DSP instruction succeeding a currently running Extended DSP instruction after less than the latency cycles for the running instructions is delayed until the last latency cycle of the running instruction is reached.

One additional latency cycle passes until the instruction result is available in the register G15 or register pair G14//G15 to an ALU instruction referencing that result. Any instruction referencing the Extended DSP instruction result earlier is delayed until the result is available in G15 or G14//G15.

The latency cycles are as follows:

EMUL instruction:
      when both operands are in the range of $-2^{15}..2^{15}-1$: 1 cycle
      all other cases: 3 cycles

EMULU instruction:
      when both operands are in the range of $0..2^{16}-1$: 1 cycle
      all other cases: 4 cycles

EMULS instruction:
      when both operands are in the range of $-2^{15}..2^{15}-1$: 1 cycle
      all other cases: 4 cycles

EMAC instruction:
      when both operands are in the range of $-2^{15}..2^{15}-1$: 1 cycle
      all other cases: 3 cycles

EMACD instruction:
      when both operands are in the range of $-2^{15}..2^{15}-1$: 1 cycle
      all other cases: 4 cycles

EMSUB instruction:
      when both operands are in the range of $-2^{15}..2^{15}-1$: 1 cycle
      all other cases: 3 cycles

EMSUBD instruction:
      when both operands are in the range of $-2^{15}..2^{15}-1$: 1 cycle
      all other cases: 4 cycles

EHMAC, EHMACD instructions: 2 cycles

EHCMULD, EHCMACD instructions: 4 cycles

EHCSUMD instruction: 1 cycles

EHCFFTD, EHCFFTSD instructions: 1 cycles

Thus, after issue of for example a EHCMULD instruction, there are three clock cycles available for the issue of ALU instructions until the next Extended DSP instruction can be issued, and the result of the EHCMULD instruction is available in G14//G15 five clock cycles after instruction issue.

3. Instruction Set

3.1. Memory Instructions

The memory instructions load data from memory in a register Rs (or a register pair Rs//Rsf) or store data from Rs (or Rs//Rsf) to memory using the data types byte unsigned/signed, half-word unsigned/signed, word or double-word. Since I/O devices are also addressed by memory instructions, "memory" stands here interchangeably also for I/O unless memory or I/O address space is specifically denoted.

The memory address is either specified by the operand Rd or Ld, by the sum Rd plus a signed displacement or by the displacement alone, depending on the address mode. Memory accesses to words and double-words ignore bits one and zero of the address, memory accesses to half-words ignore bit zero of the address, (since these operands are located at word or half-word boundaries respectively, these address bits are redundant).

If the content of any register Rd except SR is zero, the memory is not accessed and a trap to Pointer Error occurs (see section 4. Exceptions). Thus, uninitialized pointers are automatically checked.

Load and Store instructions are pipelined to a total depth of two word entries for Load and Store, thus, a double-word Load or a double-word Store instruction can be executed without halting the processor in a wait state. (The address pipeline provides a depth of two addresses common to load and store).

Double-word memory instructions insert two separate word and address entries into the pipeline and start two independent memory cycles. The first memory cycle, loading or storing the high-order word, uses the address specified by the address mode, the second cycle uses this address incremented by four and also places it on the address bus.

Accessing data in the same DRAM memory page by any number of succeeding memory cycles is performed in page mode.

Memory instructions leave all condition flags unchanged.

3.1.1. Address Modes

Register Address Mode:

Notation: LDxx.**R**,   STxx.**R**   -- xx: word or double-word data type

The content of the destination register Ld is used as an address into memory address space.

Postincrement Address Mode:

Notation: LDxx.**P**,   STxx.**P**   -- xx: word or double-word data type

The content of the destination register Ld is used as an address into memory address space, then Ld is incremented according to the specified data size of a word or double-word memory instruction by 4 or 8 respectively, regardless of any exception occuring. In the case of a double-word data type, Ld is incremented by 8 at the first memory cycle.

Displacement Address Mode:

Notation: LDxx.**D**,   STxx.**D**   -- xx: any data type

The sum of the contents of the destination register Rd plus a signed displacement dis is used as an address into memory address space.

Rd may denote any register except the SR; Rd not denoting the SR differentiates this mode from the absolute address mode.

In the case of all data types except byte, bit zero of dis is treated as zero for the calculation of Rd + dis.

Note: Specification of the PC for Rd provides addressing relative to the address of the first byte after the memory instruction.

Absolute Address Mode:

Notation: LDxx.**A**,   STxx.**A**   -- xx: any data type

The displacement dis is used as an address into memory address space. Rd must denote the SR to differentiate this mode from the displacement address mode; the content of the SR is not used.

In the case of all data types except byte, address bit zero is supplied as zero.

Note: The displacement provides absolute addressing at the beginning and the end (MEM3 area) of the memory.

I/O Displacement Address Mode:

Notation: LDxx.**IOD**,   STxx.**IOD**   -- xx: word or double-word data type

The sum of the contents of the destination register Rd plus a signed displacement dis is used as an address into I/O address space.

Rd may denote any register except the SR; Rd not denoting the SR differentiates this mode from the I/O absolute address mode.

Bits one and zero of dis are treated as zero for the calculation of Rd + dis.

Execution of a memory instruction with I/O displacement address mode does not disrupt any page mode sequence.

Note: The I/O displacement address mode provides dynamic addressing of peripheral devices.

When on a load instruction only a byte or half-word is placed on the (lower part) of the data bus, the higher-order bits are undefined and must be masked out before the loaded operand is used further.

I/O Absolute Address Mode:

Notation: LDxx.**IOA**,   STxx.**IOA**   -- xx: word or double-word data type

The displacement dis is used as an address into I/O address space.

Rd must denote the SR to differentiate this mode from the I/O displacement address mode; the content of the SR is not used.

Address bits one and zero are supplied as zero.

Execution of a memory instruction with I/O address mode does not disrupt any page mode sequence.

Note: The I/O absolute address mode provides code efficient absolute addressing of peripheral devices and allows simple decoding of I/O addresses.

When on a load instruction only a byte or a half-word is placed on the (lower part) of the data bus, the higher-order bits are undefined and must be masked out before the loaded operand is used further.

Next Address Mode:

Notation: LDxx.**N**,   STxx.**N**   -- xx: any data type

The content of the destination register Rd is used as an address into memory address space, then Rd is incremented by the signed displacement dis regardless of any exception occurring. At a double-word data type, Rd is incremented at the first memory cycle.

Rd must not denote the PC or the SR.

In the case of all data types except byte, bit zero of dis is treated as zero for the calculation of Rd + dis.

Stack Address Mode:

Notation: LDW.**S**,   STW.**S**   -- only word data type

The content of the destination register Rd is used as stack address, then Rd is incremented by dis regardless of any exception occurred.

A stack address addresses memory address space if it is lower than the stack pointer SP; otherwise bits 7..2 of it (higher bits are ignored) address a register in the register part of the stack absolutely (not relative to the frame pointer FP).

Bits one and zero of dis are treated as zero for the calculation of Rd + dis.

Rd must not denote the PC or the SR.

Note: The stack address mode must be used to address an operand in the stack regardless of its present location either in the memory part or in the register part of the stack. Rd may be set by the Set Stack Address instruction.

Address Mode Encoding:

The encoding of the displacement and absolute address mode types of memory instructions is shown in table 3.1:

			LDxx.D/A/IOD/IOA		STxx.D/A/IOD/IOA	
D-code	dis(1)	dis(0)	Rd does not denote SR	Rd denotes SR	Rd does not denote SR	Rd denotes SR
0	X	X	LDBS.D	LDBS.A	STBS.D	STBS.A
1	X	X	LDBU.D	LDBU.A	STBU.D	STBU.A
2	X	0	LDHU.D	LDHU.A	STHU.D	STHU.A
2	X	1	LDHS.D	LDHS.A	STHS.D	STHS.A
3	0	0	LDW.D	LDW.A	STW.D	STW.A
3	0	1	LDD.D	LDD.A	STD.D	STD.A
3	1	0	LDW.IOD	LDW.IOA	STW.IOD	STW.IOA
3	1	1	LDD.IOD	LDD.IOA	STD.IOD	STD.IOA

Table 3.1: Encoding of Displacement and Absolute Address Mode

The encoding of the next and stack address mode types of memory instructions is shown in table 3.2:

			With the instructions below, Rd must not denote the PC or the SR	
D-code	dis(1)	dis(0)	LDxx.N/S	STxx.N/S
0	X	X	LDBS.N	STBS.N
1	X	X	LDBU.N	STBU.N
2	X	0	LDHU.N	STHU.N
2	X	1	LDHS.N	STHS.N
3	0	0	LDW.N	STW.N
3	0	1	LDD.N	STD.N
3	1	0	Reserved	Reserved
3	1	1	LDW.S	STW.S

Table 3.2: Encoding of Next and Stack Address Mode

3.1.2. Load Instructions

The Load instructions transfer data from the addressed memory location into a register Rs or a register pair Rs//Rsf.

In the case of data types word and double-word, one or two words are read from memory and transferred unchanged into Rs or Rs//Rsf respectively.

In the case of byte and half-word data types, up to one word (depending on bus size) is read from memory, the byte or half-word addressed by bits one and zero or bit one of the memory address respectively is extracted, right adjusted, expanded to 32 bits and placed in Rs. Unsigned bytes and half-words are expanded by leading zeros; signed bytes and half-words are expanded by leading sign bits.

Execution of a Load instruction enters the register address of Rs, memory address bits one and zero and a code for the data type into the load pipeline, places the memory address onto the address bus and starts a memory cycle. A double-word Load instruction enters the register address of Rsf and the same control information into the load pipeline as a second entry, places the memory address incremented by four onto the address bus and starts a second memory cycle.

After execution of a Load instruction, the next instructions are executed without waiting for the data to be loaded. A wait is enforced only if an instruction uses a register whose register address is still in the load pipeline. The data read from memory is placed in the register whose register address is at the head of the load pipeline, its pipeline entry is then deleted.

Rs must not denote the PC, the SR, G14 or G15; these registers cannot be loaded from memory.

3.1.2. **Load Instructions** (continued)

Format	Notation	Operation	Data Type xx
LR	LDxx.R Ld, Rs	Rs := Ld^; [Rsf := (Ld + 4)^;] -- register address mode	W,D
LR	LDxx.P Ld, Rs	Rs := Ld^; Ld := Ld + size; -- size = 4 or 8 [Rsf := (old Ld + 4)^;] -- post-increment address mode	W,D
RRdis	LDxx.D Rd, Rs, dis	Rs := (Rd + dis)^; [Rsf := (Rd + dis + 4)^;] -- displacement address mode	BU,BS,HU,HS,W,D
RRdis	LDxx.A 0, Rs, dis	Rs := dis^; [Rsf := (dis + 4)^;] -- absolute address mode	BU,BS,HU,HS,W,D
RRdis	LDxx.IOD Rd, Rs, dis	Rs := (Rd + dis)^; [Rsf := (Rd + dis + 4)^;] -- I/O displacement address mode	W,D
RRdis	LDxx.IOA 0, Rs, dis	Rs := dis^; [Rsf := (dis + 4)^;] -- I/O absolute address mode	W,D
RRdis	LDxx.N Rd, Rs, dis	Rs := Rd^; Rd := Rd + dis; [Rsf := (old Rd + 4)^;] -- next address mode	BU,BS,HU,HS,W,D
RRdis	LDxx.S Rd, Rs, dis	Rs := Rd^; Rd := Rd + dis; -- stack address mode	W

The expressions in brackets are only executed at double-word data types.

Data Type xx is with:

BU: byte unsigned;	HU: half-word unsigned;	W: word;
BS: byte signed;	HS: half-word signed;	D: double-word;

3.1.3. Store Instructions

The Store instructions transfer data from the register Rs or the register pair Rs//Rsf to the addressed memory location.

In the case of data types word or double-word, one or two words are placed unchanged from Rs or Rs//Rsf respectively onto the data bus to be stored in the memory.

In the case of byte and half-word data types, the low-order byte or half-word is placed onto the data bus at the byte or half-word position addressed by bits one and zero or bit one of the memory address respectively; it is implied to be merged (via byte write enable) with the other data in the same memory word.

In the case of signed byte and signed half-word data types, any content of Rs exceeding the value range of the specified data type causes a trap to Range Error. The byte or half-word is stored regardless of a Range Error.

If Rs denotes the SR, zero is stored regardless of the content of SR (or of SR//G2 at double-word).

Execution of a Store instruction enters the contents of Rs, memory address bits one and zero and a code for the data type into the store pipeline, places the memory address onto the address bus and starts a memory cycle. A double-word Store instruction enters the contents of Rsf and the same control information into the store pipeline as a second entry, places the memory address incremented by four onto the address bus and starts a second memory cycle.

After execution of a Store instruction, the next instructions are executed without waiting for the store memory cycle to finish. The data at the head of the store pipeline is put on the data bus on demand from the on-chip memory control logic and its pipeline entry is deleted.

When Rsf denotes the same register as Rd (or Ld) at double-word instructions with next address or post-increment address mode, the incremented content of Rsf is stored in the second memory cycle; in all other cases, the unchanged content of Rs or Rsf is stored.

3.1.3. **Store Instructions** (continued)

Format	Notation	Operation	Data Type xx
LR	STxx.R Ld, Rs	Ld^ := Rs; [(Ld + 4)^ := Rsf;] -- register address mode	W,D
LR	STxx.P Ld, Rs	Ld^ := Rs; Ld := Ld + size; -- size = 4 or 8 [(old Ld + 4)^ := Rsf;] -- post-increment address mode	W,D
RRdis	STxx.D Rd, Rs, dis	(Rd + dis)^ := Rs; [(Rd + dis + 4)^ := Rsf;] -- displacement address mode	BU,BS,HU,HS,W,D
RRdis	STxx.A 0, Rs, dis	dis^ := Rs; [(dis + 4)^ := Rsf;] -- absolute address mode	BU,BS,HU,HS,W,D
RRdis	STxx.IOD Rd, Rs, dis	(Rd + dis)^ := Rs; [(Rd + dis + 4)^ := Rsf;] -- I/O displacement address mode	W,D
RRdis	STxx.IOA 0, Rs, dis	dis^ := Rs; [(dis + 4)^ := Rsf;] -- I/O absolute address mode	W,D
RRdis	STxx.N Rd, Rs, dis	Rd^ := Rs; Rd := Rd + dis; [(old Rd + 4)^ := Rsf;] -- next address mode	BU,BS,HU,HS,W,D
RRdis	STxx.S Rd, Rs, dis	Rd^ := Rs; Rd := Rd + dis; -- stack address mode	W

The expressions in brackets are only executed at double-word data types.

In the case of signed byte and half-word data types, a trap to Range Error occurs when the value of the operand to be stored exceeds the value range of the specified data type; the byte or half-word is stored regardless of a Range Error.

Data Type xx is with:

BU: byte unsigned;	HU: half-word unsigned;	W: word;
BS: byte signed;	HS: half-word signed;	D: double-word;

3.2. Move Word Instructions

The source operand or the immediate operand is copied to the destination register and the condition flags are set or cleared accordingly.

Format	Notation	Operation
RR	MOV Rd, Rs	Rd := Rs; Z := Rd = 0; N := Rd(31); V := undefined;
Rimm	MOVI Rd, imm	Rd := imm; Z := Rd = 0; N := Rd(31); V := undefined;

3.3. Move Double-Word Instruction

The double-word source operand is copied to the double-word destination register pair and the condition flags are set or cleared accordingly. The high-order word in Rs is copied first.

When the SR is denoted as a source operand, the source operand is supplied as zero regardless of the content of SR//G2. When the PC is denoted as destination, the Return instruction RET is executed instead of the Move Double-Word instruction.

Format	Notation	Operation
RR	MOVD Rd, Rs	if Rd does not denote PC and Rs does not denote SR then Rd := Rs; Rdf := Rsf; Z := Rd//Rdf = 0; N := Rd(31); V := undefined;
RR	MOVD Rd, 0	if Rd does not denote PC and Rs denotes SR then Rd := 0; Rdf := 0; Z := 1; N := 0; V := undefined;
RR	RET PC, Rs	if Rd denotes PC then execute the RET instruction;

3.4. Logical Instructions

The result of a bitwise logical AND, AND not (ANDN), OR or exclusive OR (XOR) of the source or immediate operand and the destination operand is placed in the destination register and the Z flag is set or cleared accordingly. At ANDN, the source operand is used inverted (itself remaining unchanged).

All operands and the result are interpreted as bit strings of 32 bits each.

Format	Notation	Operation	
RR	AND Rd, Rs	Rd := Rd and Rs; Z := Rd = 0;	-- logical AND
RR	ANDN Rd, Rs	Rd := Rd and not Rs; Z := Rd = 0;	-- logical AND with source used inverted
RR	OR Rd, Rs	Rd := Rd or Rs; Z := Rd = 0;	-- logical OR
RR	XOR Rd, Rs	Rd := Rd xor Rs; Z := Rd = 0;	-- logical exclusive OR
Rimm	ANDNI Rd, imm	Rd := Rd and not imm; Z := Rd = 0;	-- logical AND with imm used inverted
Rimm	ORI Rd, imm	Rd := Rd or imm; Z := Rd = 0;	-- logical OR
Rimm	XORI Rd, imm	Rd := Rd xor imm; Z := Rd = 0;	-- logical exclusive OR

Note: ANDN and ANDNI are the instructions complementary to OR and ORI: Where OR and ORI set bits, ANDN and ANDNI clear bits at bit positions with a "one" bit in the source or immediate operand, thus obviating the need for an inverted mask in most cases.

3.5. Invert Instruction

The source operand is placed bitwise inverted in the destination register and the Z flag is set or cleared accordingly.

The source operand and the result are interpreted as bit strings of 32 bits each.

Format   Notation   Operation

RR   NOT Rd, Rs   Rd := not Rs;
                                        Z := Rd = 0;

3.6. Mask Instruction

The result of a bitwise logical AND of the source operand and the immediate operand is placed in the destination register and the Z flag is set or cleared accordingly.

All operands and the result are interpreted as bit strings of 32 bits each.

Format   Notation   Operation

RRconst   MASK Rd, Rs, const   Rd := Rs and const;
                                        Z := Rd = 0;

Note: The Mask instruction may be used to move a source operand with bits partly masked out by an immediate operand used as mask. The immediate operand const is constrained in its range by bits 31 and 30 being either both zero or both one (see format RRconst). If these bits are required to be different, the instruction pair MOVI, AND may be used instead of MASK.

3.7. Add Instructions

The source operand, the source operand + C or the immediate operand is added to the destination operand, the result is placed in the destination register and the condition flags are set or cleared accordingly.

At ADD, ADDC and ADDI, both operands and the result are interpreted as either all signed or all unsigned integers. At ADDS and ADDSI, both operands and the result are signed integers and a trap to Range Error occurs at overflow.

Format	Notation	Operation	
RR	ADD Rd, Rs	Rd := Rd + Rs; Z := Rd = 0; N := Rd(31); V := overflow; C := carry;	-- signed or unsigned Add -- sign
RR	ADDS Rd, Rs	Rd := Rd + Rs; Z := Rd = 0; N := Rd(31); V := overflow; if overflow then trap ⇒ Range Error;	-- signed Add with trap -- sign
RR	ADDC Rd, Rs	Rd := Rd + Rs + C; Z := Z and (Rd = 0); N := Rd(31); V := overflow; C := carry;	-- signed or unsigned Add with carry -- sign

When the SR is denoted as a source operand at ADD, ADDS and ADDC, C is added instead of the SR. The notation is then:

Format	Notation	Operation	
RR	ADD Rd, C	Rd := Rd + C;	-- signed or unsigned Add C
RR	ADDS Rd, C	Rd := Rd + C;	-- signed Add C with trap
RR	ADDC Rd, C	Rd := Rd + C;	

The flags and the trap condition are treated as defined by ADD, ADDS or ADDC.

3.7. Add Instructions (continued)

Format	Notation	Operation	
Rimm	ADDI Rd, imm	Rd := Rd + imm; Z := Rd = 0; N := Rd(31); V := overflow; C := carry;	-- signed or unsigned Add -- sign
Rimm	ADDSI Rd, imm	Rd := Rd + imm; Z := Rd = 0; N := Rd(31); V := overflow; if overflow then trap $\Rightarrow$ Range Error;	-- signed Add with trap -- sign

The following instructions are special cases of ADDI and ADDSI differentiated by $n = 0$ (see section 2.3.1. Table of Immediate Values):

Format	Notation	Operation	
Rimm	ADDI Rd, CZ	Rd := Rd + (C and (Z = 0 or Rd(0)));	-- round to even
Rimm	ADDSI Rd, CZ	Rd := Rd + (C and (Z = 0 or Rd(0)));	-- round to even

The flags and the trap condition are treated as defined by ADDI or ADDSI.

Note: At ADDC, Z is cleared if Rd $\neq$ 0, otherwise left unchanged; thus, Z is evaluated correctly for multi-precision operands.

The effect of a Subtract immediate instruction can be obtained by using the negated 32-bit value of the immediate operand to be subtracted (except zero). At unsigned, $C = 0$ indicates then a borrow (the unsigned number range is exceeded below zero).

At "round to even", C is only added to the destination operand if $Z = 0$ or Rd(0) is one. The Z flag is assumed to be set or cleared by a preceding Shift Left instruction. "Round to even" provides a better averaging of rounding errors than "add carry".

"Round to even" is equivalent to the "round to nearest" Floating-Point rounding mode and may be used to implement it efficiently.

3.8. Sum Instructions

The sum of the source operand and the immediate operand is placed in the destination register and the condition flags are set or cleared accordingly. At SUM, both operands and the result are interpreted as either all signed or all unsigned integers. At SUMS, both operands and the result are signed integers and a trap to Range Error occurs at overflow.

Format	Notation	Operation	
RRconst	SUM Rd, Rs, const	Rd := Rs + const; Z := Rd = 0; N := Rd(31); V := overflow; C := carry;	-- signed or unsigned Sum -- sign
RRconst	SUMS Rd, Rs, const	Rd := Rs + const; Z := Rd = 0; N := Rd(31); V := overflow; if overflow then trap $\Rightarrow$ Range Error;	-- signed Sum with trap -- sign

When the SR is denoted as a source operand at SUM and SUMS, C is added instead of the SR. The notation is then:

Format	Notation	Operation	
RRconst	SUM Rd, C, const	Rd := C + const;	-- signed or unsigned Sum C
RRconst	SUMS Rd, C, const	Rd := C + const;	-- signed Sum C

The flags are treated as defined by SUM or SUMS. A trap cannot occur.

Note: The effect of a Subtract immediate instruction can be obtained by using the negated 32-bit value of the immediate operand to be subtracted (except zero). At unsigned, C = 0 indicates then a borrow (the unsigned number range is exceeded below zero).

The immediate operand is constrained to the range of const. The instruction pair MOV, ADDI or MOV, ADDSI may be used where the full integer range is required.

3.9. Subtract Instructions

The source operand or the source operand + C is subtracted from the destination operand, the result is placed in the destination register and the condition flags are set or cleared accordingly.

At SUB and SUBC, both operands and the result are interpreted as either all signed or all unsigned integers. At SUBS, both operands and the result are signed integers and a trap to Range Error occurs at overflow.

Format	Notation	Operation	
RR	SUB Rd, Rs	Rd := Rd - Rs; Z := Rd = 0; N := Rd(31); V := overflow; C := borrow;	-- signed or unsigned Subtract -- sign
RR	SUBS Rd, Rs	Rd := Rd - Rs; Z := Rd = 0; N := Rd(31); V := overflow; if overflow then trap $\Rightarrow$ Range Error;	-- signed Subtract with trap -- sign
RR	SUBC Rd, Rs	Rd := Rd - (Rs + C); Z := Z and (Rd = 0); N := Rd(31); V := overflow; C := borrow;	-- signed or unsigned Subtract with borrow -- sign

When the SR is denoted as a source operand at SUB, SUBS and SUBC, C is subtracted instead of the SR. The notation is then:

Format	Notation	Operation	
RR	SUB Rd, C	Rd := Rd - C;	-- signed or unsigned Subtract C
RR	SUBS Rd, C	Rd := Rd - C;	-- signed Subtract C with trap
RR	SUBC Rd, C	Rd := Rd - C;	

The flags and the trap condition are treated as defined by SUB, SUBS or SUBC.

Note: At SUBC, Z is cleared if Rd $\neq$ 0, otherwise left unchanged; thus, Z is evaluated correctly for multi-precision operands.

3.10. Negate Instructions

The source operand is subtracted from zero, the result is placed in the destination register and the condition flags are set or cleared accordingly.

At NEG and NEGS, the source operand and the result are interpreted as either both signed or both unsigned integers. At NEGS, the source operand and the result are signed integers and a trap to Range Error occurs at overflow.

Format	Notation	Operation	
RR	NEG Rd, Rs	Rd := - Rs; Z := Rd = 0; N := Rd(31); V := overflow; C := borrow;	-- signed or unsigned Negate -- sign
RR	NEGS Rd, Rs	Rd := - Rs; Z := Rd = 0; N := Rd(31); V := overflow; if overflow then trap ⇒ Range Error;	-- signed Negate with trap -- sign

When the SR is denoted as a source operand at NEG and NEGS, C is negated instead of the SR. The notation is then:

Format	Notation	Operation	

RR	NEG Rd, C	Rd := - C;	-- signed or unsigned Negate C
			if C is set then
			     Rd := -1;
			else
			     Rd := 0;

RR	NEGS Rd, C	Rd := - C;	-- signed Negate C
			if C is set then
			     Rd := -1;
			else
			     Rd := 0;

The flags are treated as defined by NEG or NEGS. A trap cannot occur.

3.11. Multiply Word Instruction

The source operand and the destination operand are multiplied, the low-order word of the product is placed in the destination register (the high-order product word is not evaluated) and the condition flags are set or cleared according to the single-word product.

Both operands are either signed or unsigned integers, the product is a single-word integer.

Note that the low-order word of the product is identical regardless of whether the operands are signed or unsigned.

The result is undefined if the PC or the SR is denoted.

Format	Notation	Operation
RR	MUL Rd, Rs	Rd := low order word of product Rd $*$ Rs; Z := single-word product = 0; N := Rd(31); -- sign of single-word product; -- valid for signed operands; V := undefined; C := undefined;

3.12. Multiply Double-Word Instructions

The source operand and the destination operand are multiplied, the double-word product is placed in the destination register pair (the destination register expanded by the register following it) and the condition flags are set or cleared according to the double-word product.

At MULS, both operands are signed integers and the product is a signed double-word integer. At MULU, both operands are unsigned integers and the product is an unsigned double-word integer.

The result is undefined if the PC or the SR is denoted.

Format	Notation	Operation
RR	MULS Rd, Rs	Rd//Rdf := signed double-word product of Rd $*$ Rs; Z := Rd//Rdf = 0; -- double-word product is zero N := Rd(31); -- double-word product is negative V := undefined; C := undefined;
RR	MULU Rd, Rs	Rd//Rdf := unsigned double-word product of Rd $*$ Rs; Z := Rd//Rdf = 0; -- double-word product is zero N := Rd(31); V := undefined; C := undefined;

3.13. Divide Instructions

The double-word destination operand (dividend) is divided by the single-word source oper-
and (divisor), the quotient is placed in the low-order destination register (Rdf), the remain-
der is placed in the high-order destination register (Rd) and the condition flags are set or
cleared according to the quotient.

A trap to Range Error occurs if the divisor is zero or the value of the quotient exceeds the
integer value range (quotient overflow). The result (in Rd//Rdf) is then undefined. At
DIVS, a trap to Range Error also occurs and the result is undefined if the dividend is nega-
tive.

At DIVS, the dividend is a non-negative signed double-word integer, the divisor, the quo-
tient and the remainder are signed integers; a non-zero remainder has the sign of the divi-
dend.

At DIVU, the dividend is an unsigned double-word integer, the divisor, the quotient and
the remainder are unsigned integers.

The result is undefined if Rs denotes the same register as Rd or Rdf or if the PC or the SR
is denoted.

Format	Notation	Operation
RR	DIVS Rd, Rs	if Rs = 0 or quotient overflow or Rd(31) = 1 then
		-- dividend is negative
		Rd//Rdf := undefined;
		Z := undefined;
		N := undefined;
		V := 1;
		trap $\Rightarrow$ Range Error;
		else
		remainder Rd, quotient Rdf := (Rd//Rdf) / Rs;
		Z := Rdf = 0; -- quotient is zero
		N := Rdf(31); -- quotient is negative
		V := 0;
RR	DIVU Rd, Rs	if Rs = 0 or quotient overflow then
		Rd//Rdf := undefined;
		Z := undefined;
		N := undefined;
		V := 1;
		trap $\Rightarrow$ Range Error;
		else
		remainder Rd, quotient Rdf := (Rd//Rdf) / Rs;
		Z := Rdf = 0; -- quotient is zero
		N := Rdf(31);
		V := 0;

3.14. Shift Left Instructions

The destination operand is shifted left by a number of bit positions specified

at SHLI, SHLDI by n = 0..31 as a shift by 0..31;

at SHL, SHLD by bits 4..0 of the source operand as a shift by 0..31.

The higher-order bits of the source operand are ignored.

The destination operand is interpreted

at SHL and SHLI as a bit string of 32 bits or as a signed or unsigned integer;

at SHLD and SHLDI as a double-word bit string of 64 bits or as a signed or unsigned double-word integer.

All Shift Left instructions insert zeros in the vacated bit positions at the right.

The double-word Shift Left instructions execute in two cycles. The low-order operand in Ldf is shifted first. At SHLD, the result is undefined if Ls denotes the same register as Ld or Ldf.

Format	Notation	Operation	insert
Rn	SHLI Rd, n	Rd := Rd << by n;	-- 0..31 zeros
Ln	SHLDI Ld, n	Ld//Ldf := Ld//Ldf << by n;	-- 0..31 zeros
LL	SHL Ld, Ls	Ld := Ld << by Ls(4..0);	-- 0..31 zeros
LL	SHLD Ld, Ls	Ld//Ldf := Ld//Ldf << by Ls(4..0);	-- 0..31 zeros

The condition flags are set or cleared by all Shift Left instructions as follows:

```
Z := Ld = 0 or Rd = 0 on single-word;
Z := Ld//Ldf = 0 on double-word;
N := Ld(31) or Rd(31);
V := any bit ≠ new Ld(31) or Rd(31) is shifted out;          -- significant bits lost
C := undefined;
```

Note: The symbol << signifies "shifted left".

3.15. Shift Right Instructions

The destination operand is shifted right by a number of bit positions specified

> at SARI, SARDI, SHRI, SHRDI by n = 0..31 as a shift by 0..31.

> at SAR, SARD, SHR, SHRD by bits 4..0 of the source operand as a shift by 0..31.

> The higher-order bits of the source operand are ignored.

The destination operand is interpreted

> at SAR and SARI as a signed integer;

> at SARD and SARDI as a signed double-word integer;

> at SHR and SHRI as a bit string of 32 bits or as an unsigned integer;

> at SHRD and SHRDI as a double-word bit string of 64 bits or as an unsigned double-word integer.

All Shift Right instructions which interpret the destination operand as signed insert sign bits, all others insert zeros in the vacated bit positions at the left.

The double-word Shift Right instructions execute in two cycles. The high-order operand in Ld is shifted first. At SARD and SHRD, the result is undefined if Ls denotes the same register as Ld or Ldf.

Format	Notation	Operation	insert
Rn	SARI Rd, n	Rd := Rd >> by n;	-- 0..31 sign bits
Ln	SARDI Ld, n	Ld//Ldf := Ld//Ldf >> by n;	-- 0..31 sign bits
LL	SAR Ld, Ls	Ld := Ld >> by Ls(4..0);	-- 0..31 sign bits
LL	SARD Ld, Ls	Ld//Ldf := Ld//Ldf >> by Ls(4..0);	-- 0..31 sign bits
Rn	SHRI Rd, n	Rd := Rd >> by n;	-- 0..31 zeros
Ln	SHRDI Ld, n	Ld//Ldf := Ld//Ldf >> by n;	-- 0..31 zeros
LL	SHR Ld, Ls	Ld := Ld >> by Ls(4..0);	-- 0..31 zeros
LL	SHRD Ld, Ls	Ld//Ldf := Ld//Ldf >> by Ls(4..0);	-- 0..31 zeros

The condition flags are set or cleared by all Shift Right instructions as follows:

> Z := Ld = 0 or Rd = 0 on single-word;
> Z := Ld//Ldf = 0 on double-word;
> N := Ld(31) or Rd(31);
> C := last bit shifted out is "one";

Note: The symbol >> signifies "shifted right".

3.16. Rotate Left Instruction

The destination operand is shifted left by a number of bit positions and the bits shifted out are inserted in the vacated bit positions; thus, the destination operand is rotated. The condition flags are set or cleared accordingly. Bits 4..0 of the source operand specify a rotation by 0..31 bit positions; bits 31..5 of the source operand are ignored.

The destination operand is interpreted as a bit string of 32 bits.

Format	Notation	Operation
LL	ROL Ld, Ls	Ld := Ld rotated left by Ls(4..0);
		Z := Ld = 0;
		N := Ld(31);
		V := undefined;
		C := undefined;

3.17. Index Move Instructions

The source operand is placed shifted left by 0, 1, 2 or 3 bit positions in the destination register, corresponding to a multiplication by 1, 2, 4 or 8. At XM1..XM8, a trap to Range Error occurs if the source operand is higher than the immediate operand lim (upper bound).

All condition flags remain unchanged. All operands and the result are interpreted as unsigned integers.

The SR must not be denoted as a source nor as a destination, nor the PC as a destination operand; these notations are reserved for future expansion. When the PC is denoted as a source operand, a trap to Range Error occurs if $PC \geq lim$.

X-code	Format	Notation	Operation
0	RRlim	XM1 Rd, Rs, lim	Rd := Rs ∗ 1; if Rs > lim then trap ⇒ Range Error;
1	RRlim	XM2 Rd, Rs, lim	Rd := Rs ∗ 2; if Rs > lim then trap ⇒ Range Error;
2	RRlim	XM4 Rd, Rs, lim	Rd := Rs ∗ 4; if Rs > lim then trap ⇒ Range Error;
3	RRlim	XM8 Rd, Rs, lim	Rd := Rs ∗ 8; if Rs > lim then trap ⇒ Range Error;
4	RRlim	XX1 Rd, Rs, 0	Rd := Rs ∗ 1; -- Move without flag change
5	RRlim	XX2 Rd, Rs, 0	Rd := Rs ∗ 2;
6	RRlim	XX4 Rd, Rs, 0	Rd := Rs ∗ 4;
7	RRlim	XX8 Rd, Rs, 0	Rd := Rs ∗ 8;

Note: The Index Move instructions move an index value scaled (multiplied by 1, 2, 4 or 8). XM1..XM8 check also the unscaled value for an upper bound, optionally also excluding zero. If the lower bound is not zero, it may be mapped to zero by subtracting it from the index value before applying an Index Move instruction.

3.18. Check Instructions

The destination operand is checked and a trap to Range Error occurs

> at CHK if the destination operand is higher than the source operand,

> at CHKZ if the destination operand is zero.

All registers and all condition flags remain unchanged. All operands are interpreted as unsigned integers.

CHKZ shares its basic OP-code with CHK, it is differentiated by denoting the SR as source operand.

Format	Notation	Operation
RR	CHK Rd, Rs	if Rs does not denote SR and Rd > Rs then trap $\Rightarrow$ Range Error;
RR	CHKZ Rd, 0	if Rs denotes SR and Rd = 0 then trap $\Rightarrow$ Range Error;

When Rs denotes the PC, CHK traps if Rd $\geq$ PC. Thus, CHK, PC, PC always traps. Since CHK, PC, PC is encoded as 16 zeros, an erroneous jump into a string of zeros causes a trap to Range Error, thus trapping some address errors.

Note: CHK checks the upper bound of an unsigned value range, implying a lower bound of zero. If the lower bound is not zero, it can be mapped to zero by subtracting it from the value to be checked and then checking against a corrected upper bound (lower bound also subtracted). When the upper bound is a constant not exceeding the range of lim, the Index instructions may be used for bounds checks.

CHKZ may be used to trap on uninitialized pointers with the value zero.

3.19. No Operation Instruction

The instruction CHK, L0, L0 cannot cause any trap. Since CHK leaves all registers and condition flags unchanged, it can be used as a No Operation instruction with the notation:

Format	Notation	Operation
RR	NOP	no operation;

Note: The NOP instruction may be used as a fill instruction.

3.20. Compare Instructions

Two operands are compared by subtracting the source operand or the immediate operand from the destination operand. The condition flags are set or cleared according to the result; the result itself is not retained. Note that the N flag indicates the correct compare result even in the case of an overflow.

All operands and the result are interpreted as either all signed or all unsigned integers.

Format	Notation	Operation	
RR	CMP Rd, Rs	result := Rd - Rs;	
		Z := Rd = Rs;	-- result is zero
		N := Rd < Rs signed;	-- result is true negative
		V := overflow;	
		C := Rd < Rs unsigned;	-- borrow
Rimm	CMPI Rd, imm	result := Rd - imm;	
		Z := Rd = imm;	-- result is zero
		N := Rd < imm signed;	-- result is true negative
		V := overflow;	
		C := Rd < imm unsigned;	-- borrow

When the SR is denoted as a source operand at CMP, C is subtracted instead of SR. The notation is then:

Format	Notation	Operation	
RR	CMP, Rd, C	result := Rd - C;	
		Z := Rd = C;	-- result is zero
		N := Rd < C signed;	-- result is true negative
		V := overflow;	
		C := Rd < C unsigned;	-- borrow

3.21. Compare Bit Instructions

The result of a bitwise logical AND of the source or immediate operand and the destination operand is used to set or clear the Z flag accordingly; the result itself is not retained.

All operands and the result are interpreted as bit strings of 32 bits each.

Format	Notation	Operation
RR	CMPB Rd, Rs	Z := (Rd and Rs) = 0;
Rimm	CMPBI Rd, imm	Z := (Rd and imm) = 0;

The following instruction is a special case of CMPBI differentiated by $n = 0$ (see section 2.3.1. Table of Immediate Values):

Format	Notation	Operation
Rimm	CMPBI Rd, ANYBZ	Z := Rd(31..24) = 0 or Rd(23..16) = 0 or Rd(15..8) = 0 or Rd(7..0) = 0; -- any Byte of Rd = 0

3.22. Test Leading Zeros Instruction

The number of leading zeros in the source operand is tested and placed in the destination register. A source operand equal to zero yields 32 as a result. All condition flags remain unchanged.

Format	Notation	Operation
LL	TESTLZ Ld, Ls	Ld := number of leading zeros in Ls;

3.23. Set Stack Address Instruction

The frame pointer FP is placed, expanded to the stack address, in the destination register. The FP itself and all condition flags remain unchanged. The expanded FP address is the address at which the content of L0 would be stored if pushed onto the memory part of the stack.

The Set Stack Address instruction shares the basic OP-code SETxx, it is differentiated by n = 0 and not denoting the SR or the PC.

n	Format	Notation	Operation
0	Rn	SETADR Rd	Rd := SP(31..9)//SR(31..25)//00 + carry into bit 9 -- SR(31..25) is FP -- carry into bit 9 := (SP(8) = 1 and SR(31) = 0)

Note: The Set Stack Address instruction calculates the stack address of the beginning of the current stack frame. L0..L15 of this frame can then be addressed relative to this stack address in the stack address mode with displacement values of 0..60 respectively.

Provided the stack address of a stack frame has been saved, for example in a global register, any data in this stack frame can then be addressed also from within all younger generations of stack frames by using the saved stack address. (Addressing of local variables in older generations of stack frames is required by all block oriented programming languages like Pascal, Modula-2 and Ada.)

The basic OP-code SETxx is shared as indicated:

❐ n = 0 while not denoting the SR or the PC differentiates the Set Stack Address instruction.

❐ n = 1..31 while not denoting the SR or the PC differentiates the Set Conditional instructions.

❐ Denoting the SR differentiates the Fetch instruction.

❐ Denoting the PC is reserved for future use.

3.24. Set Conditional Instructions

The destination register is set or cleared according to the states of the condition flags specified by n. The condition flags themselves remain unchanged.

The Set Conditional instructions share the basic OP-code SETxx, they are differentiated by n = 1..31 and not denoting the SR or the PC.

3.24. Set Conditional Instructions (continued)

Format is Rn

n	Notation	or	Alternative	Operation
1	Reserved			
2	SET1 Rd			Rd := 1;
3	SET0 Rd			Rd := 0;
4	SETLE Rd			if N = 1 or Z = 1 then Rd := 1 else Rd := 0;
5	SETGT Rd			if N = 0 and Z = 0 then Rd := 1 else Rd := 0;
6	SETLT Rd		SETN Rd	if N = 1 then Rd := 1 else Rd := 0;
7	SETGE Rd		SETNN Rd	if N = 0 then Rd := 1 else Rd := 0;
8	SETSE Rd			if C = 1 or Z = 1 then Rd := 1 else Rd := 0;
9	SETHT Rd			if C = 0 and Z = 0 then Rd := 1 else Rd := 0;
10	SETST Rd		SETC Rd	if C = 1 then Rd := 1 else Rd := 0;
11	SETHE Rd		SETNC Rd	if C = 0 then Rd := 1 else Rd := 0;
12	SETE		SETZ	if Z = 1 then Rd := 1 else Rd := 0;
13	SETNE		SETNZ	if Z = 0 then Rd := 1 else Rd := 0;
14	SETV Rd			if V = 1 then Rd := 1 else Rd := 0;
15	SETNV Rd			if V = 0 then Rd := 1 else Rd := 0;
16	Reserved			
17	Reserved			
18	SET1M Rd			Rd := -1;
19	Reserved			
20	SETLEM Rd			if N = 1 or Z = 1 then Rd := -1 else Rd := 0;
21	SETGTM Rd			if N = 0 and Z = 0 then Rd := -1 else Rd := 0;
22	SETLTM Rd		SETNM Rd	if N = 1 then Rd := -1 else Rd := 0;
23	SETGEM Rd		SETNNM Rd	if N = 0 then Rd := -1 else Rd := 0;
24	SETSEM Rd			if C = 1 or Z = 1 then Rd := -1 else Rd := 0;
25	SETHTM Rd			if C = 0 and Z = 0 then Rd := -1 else Rd := 0;
26	SETSTM Rd		SETCM Rd	if C = 1 then Rd := -1 else Rd := 0;
27	SETHEM Rd		SETNCM Rd	if C = 0 then Rd := -1 else Rd := 0;
28	SETEM		SETZM	if Z = 1 then Rd := -1 else Rd := 0;
29	SETNEM		SETNZM	if Z = 0 then Rd := -1 else Rd := 0;
30	SETVM Rd			if V = 1 then Rd := -1 else Rd := 0;
31	SETNVM Rd			if V = 0 then Rd := -1 else Rd := 0;

3.25. Branch Instructions

The Branch instruction BR, and any of the conditional Branch instructions when the branch condition is met, place the branch address PC + rel (relative to the address of the first byte after the Branch instruction) in the program counter PC and clear the cache-mode flag M; all condition flags remain unchanged. Then instruction execution proceeds at the branch address placed in the PC.

When the branch condition is not met, the M flag and the condition flags remain unchanged and instruction execution proceeds sequentially.

Besides these explicit Branch instructions, the instructions MOV, MOVI, ADD, ADDI, SUM, SUB may denote the PC as a destination register and thus be executed as an implicit branch; the M flag is cleared and the condition flags are set or cleared according to the specified instruction. All other instructions, except Compare instructions, must not be used with the PC as destination, otherwise possible Range Errors caused by these instructions would lead to ambiguous results on backtracking.

Format is PCrel

Notation	or alternative	Operation	Comment
BLE rel		if N = 1 or Z = 1 then BR;	-- **L**ess or **E**qual signed
BGT rel		if N = 0 and Z = 0 then BR;	-- **G**reater **T**han signed
BLT rel	BN rel	if N = 1 then BR;	-- **L**ess **T**han signed
BGE rel	BNN rel	if N = 0 then BR;	-- **G**reater or **E**qual signed
BSE rel		if C = 1 or Z = 1 then BR;	-- **S**maller or **E**qual unsigned
BHT rel		if C = 0 and Z = 0 then BR;	-- **H**igher **T**han unsigned
BST rel	BC rel	if C = 1 then BR;	-- **S**maller **T**han unsigned
BHE rel	BNC rel	if C = 0 then BR;	-- **H**igher or **E**qual unsigned
BE rel	BZ rel	if Z = 1 then BR;	-- **E**qual
BNE rel	BNZ rel	if Z = 0 then BR;	-- **N**ot **E**qual
BV rel		if V = 1 then BR;	-- o**V**erflow
BNV rel		if V = 0 then BR;	-- **N**ot o**V**erflow
BR rel		PC := PC + rel; M := 0;	

Note: rel is signed to allow forward or backward branches.

3.26. Delayed Branch Instructions

The Delayed Branch instruction DBR, and any of the conditional Delayed Branch instructions when the branch condition is met, place the branch address PC + rel (relative to the address of the first byte after the Delayed Branch instruction) in the program counter PC. All condition flags and the cache mode flag M remain unchanged.

Then the instruction after the Delayed Branch instruction, called the delay instruction, is executed regardless of whether the delayed branch is taken or not taken.

When the delayed branch is not taken, the delay instruction is executed like a regular instruction. The PC and the ILC are updated accordingly and instruction execution proceeds sequentially.

When the delayed branch is taken, the delay instruction is executed before execution proceeds at the branch target. The PC (containing the delayed-branch target address) is not updated by the delay instruction. Any reference to the PC by the delay instruction references the delayed-branch target address.

In the case of an Error exception caused by a delay instruction succeeding a delayed branch taken, the location of the saved return PC contains the address of the first byte of the delay instruction. The saved ILC contains the length (1 or 2 half-words) of the Delayed Branch instruction. In the case of all other exceptions following a delay instruction succeeding a delayed branch taken, the location of the saved return PC contains the branch target address of the delayed branch and the saved ILC is invalid.

The following restrictions apply to delay instructions:

The sum of the length of the Delayed Branch instruction and the delay instruction must not exceed three half-words, otherwise an arbitrary bit pattern may be supplied and erroneously used for the second or third half-word of the delay instruction without any warning.

Only a Reset exception can occur between a Delayed Branch instruction and a delay instruction, all other exceptions are locked out.

A Fetch or any branching instruction must not be placed as a delay instruction. A misplaced Delayed Branch instruction would be executed like the corresponding non-delayed Branch instruction to inhibit a permanent exception lock-out.

3.26. Delayed Branch Instructions (continued)

Format is PCrel

Notation or alternative	Operation	Comment
DBLE rel	if N = 1 or Z = 1 then DBR;	-- **L**ess or **E**qual signed
DBGT rel	if N = 0 and Z = 0 then DBR;	-- **G**reater **T**han signed
DBLT rel DBN rel	if N = 1 then DBR;	-- **L**ess **T**han signed
DBGE rel DBNN rel	if N = 0 then DBR;	-- **G**reater or **E**qual signed
DBSE rel	if C = 1 or Z = 1 then DBR;	-- **S**maller or **E**qual unsigned
DBHT rel	if C = 0 and Z = 0 then DBR;	-- **H**igher **T**han unsigned
DBST rel DBC rel	if C = 1 then DBR;	-- **S**maller **T**han unsigned
DBHE rel DBNC rel	if C = 0 then DBR;	-- **H**igher or **E**qual unsigned
DBE rel DBZ rel	if Z = 1 then DBR;	-- **E**qual
DBNE rel DBNZ rel	if Z = 0 then DBR;	-- **N**ot **E**qual
DBV rel	if V = 1 then DBR;	-- o**V**erflow
DBNV rel	if V = 0 then DBR;	-- **N**ot o**V**erflow
DBR rel	PC := PC + rel;	

Note: rel is signed to allow forward or backward branches.

Attention: Since the PC seen by the delay instruction depends on the delayed branch taken or not taken, a delay instruction after a conditional Delayed Branch instruction must not reference the PC.

3.27. Call Instruction

The Call instruction causes a branch to a subprogram.

The branch address Rs + const, or const alone if Rs denotes the SR, is placed in the program counter PC. The old PC containing the return address is saved in Ld; the old supervisor-state flag S is also saved in bit zero of Ld. The old status register SR is saved in Ldf; the saved instruction-length code ILC contains the length (2 or 3) of the Call instruction.

Then the frame pointer FP is incremented by the value of the Ld-code (Ld-code = 0 is interpreted as Ld-code = 16) and the frame length FL is set to six, thus creating a new stack frame. The cache-mode flag M is cleared. All condition flags remain unchanged. Then instruction execution proceeds at the branch address placed in the PC.

The value of the Ld-code must not exceed the value of the old FL (FL = 0 is interpreted as FL = 16), otherwise the beginning of the register part of the stack at the SP could be overwritten without any warning. Bit zero of const must be 0.

Rs and Ld may denote the same register.

Format	Notation	Operation

LRconst	CALL Ld, Rs, const
	or CALL Ld, 0, const
		if Rs denotes not SR then
		    PC := Rs + const;
		else
		    PC := const;
		Ld := old PC(31..1)//old S;
		    -- Ld-code 0 selects L16
		Ldf := old SR;
		FP := FP + Ld code;
		    -- Ld-code 0 is treated as 16
		FL := 6;
		M := 0;

Note: At the new stack frame, the saved PC is located in L0 and the saved SR is located in L1.

A Frame instruction must be executed immediately after a Call instruction, otherwise an Interrupt, Parity Error, Extended Overflow or Trace exception could separate the Call from the corresponding Frame instruction before the frame pointer FP is decremented to include (optionally) passed parameters. After a Call instruction, an Interrupt, Parity Error, Extended Overflow or Trace exception is locked out for one instruction regardless of the interrupt lock flag L.

3.28. Trap Instructions

The Trap instructions TRAP and any of the conditional Trap instructions when the trap condition is met, cause a branch to one out of 64 supervisor subprogram entries (see section 2.4. Entry Tables).

When the trap condition is not met, instruction execution proceeds sequentially.

When the subprogram branch is taken, the subprogram entry address adr is placed in the program counter PC and the supervisor-state flag S is set to one. The old PC containing the return address is saved in the register addressed by FP + FL; the old S flag is also saved in bit zero of this register. The old status register SR is saved in the register addressed by FP + FL + 1 (FL = 0 is interpreted as FL = 16); the saved instruction-length code ILC contains the length (1) of the Trap instruction.

Then the frame pointer FP is incremented by the old frame length FL and FL is set to six, thus creating a new stack frame. The cache-mode flag M and the trace-mode flag T are cleared, the interrupt-lock flag L is set to one. All condition flags remain unchanged. Then instruction execution proceeds at the entry address placed in the PC.

The trap instructions are differentiated by the 12 code values given by the bits 9 and 8 of the OP-code and bits 1 and 0 of the adr-byte (code = OP(9..8)//adr-byte(1..0)). Since OP(9..8) = 0 does not denote Trap instructions (the code is occupied by the BR instruction), trap codes 0..3 are not available.

3.28. Trap Instructions (continued)

Format is PCadr

Code	Notation	Operation
4	TRAPLE trapno	if N = 1 or Z = 1 then execute TRAP else execute next instruction;
5	TRAPGT trapno	if N = 0 and Z = 0 then execute TRAP else execute next instruction;
6	TRAPLT trapno	if N = 1 then execute TRAP else execute next instruction;
7	TRAPGE trapno	if N = 0 then execute TRAP else execute next instruction;
8	TRAPSE trapno	if C = 1 or Z = 1 then execute TRAP else execute next instruction;
9	TRAPHT trapno	if C = 0 and Z = 0 then execute TRAP else execute next instruction;
10	TRAPST trapno	if C = 1 then execute TRAP else execute next instruction;
11	TRAPHE trapno	if C = 0 then execute TRAP else execute next instruction;
12	TRAPE trapno	if Z = 1 then execute TRAP else execute next instruction;
13	TRAPNE trapno	if Z = 0 then execute TRAP else execute next instruction;
14	TRAPV trapno	if V = 1 then execute TRAP else execute next instruction;
15	TRAP trapno	PC := adr; S := 1; (FP + FL)^ := old PC(31..1)//old S; (FP + FL + 1)^ := old SR; FP := FP + FL; -- FL = 0 is treated as FL = 16 FL := 6; M := 0; T := 0; L := 1;

trapno indicates one of the traps 0..63.

Note: At the new stack frame, the saved PC is located in L0 and the saved SR is located in L1; L2..L5 are free for use as required.

A Frame instruction must be executed before executing any other Trap, Call or Software instruction or before the interrupt-lock flag L is being cleared, otherwise the beginning of the register part of the stack at the SP could be overwritten without any warning.

3.29. Frame Instruction

A Frame instruction restructures the current stack frame by

❐ decrementing the frame pointer FP to include (optionally) passed parameters in the local register addressing range; the first parameter passed is then addressable as L0;

❐ resetting the frame length FL to the actual number of registers needed for the current stack frame.

It also restores the reserve number of 10 registers in the register part of the stack to allow any further Call, Trap or Software instructions and clears the cache mode flag M.

The frame pointer FP is decremented by the value of the Ls-code and the Ld-code is placed in the frame length FL (FL = 0 is always interpreted as FL = 16). Then the difference (available number of registers) - (required number of registers + 10) is evaluated and interpreted as a signed 7-bit integer.

If the difference is not negative, all the registers required plus the reserve of 10 fit into the register part of the stack; no further action is needed and the Frame instruction is finished.

If the difference is negative, the content of the old stack pointer SP is compared with the address in the upper stack bound UB. If the value in the SP is equal or higher than the value in the UB, a temporary flag is set. Then the contents of the number of local registers equal to the negative difference evaluated are pushed onto the memory part of the stack, beginning with the content of the local register addressed absolutely by SP(7..2) being pushed onto the location addressed by the SP. After each memory cycle, the SP is incremented by four until the difference is eliminated. A trap to Frame Error occurs after completion of the push operation when the temporary flag is set.

All condition flags remain unchanged.

3.29. Frame Instruction (continued)

Format	Notation	Operation

LL	FRAME Ld, Ls	FP := FP - Ls code;
		FL := Ld code;
		M := 0;
		difference(6..0) := SP(8..2) + (64 - 10) - (FP + FL);
		    -- FL = 0 is treated as FL = 16
		    -- difference is signed, difference(6) = sign bit
		    -- 64 = number of local registers
		    -- 10 = number of reserve registers
		if difference $\geq$ 0 then
		    continue at next instruction;
		    -- Frame is finished
		else
		    temporary flag := SP $\geq$ UB;
		    repeat
		        memory SP^ := register SP(7..2)^;
		            -- local register $\Rightarrow$ memory
		        SP := SP + 4;
		        difference := difference + 1;
		    until difference = 0;
		    if temporary flag = 1 then
		        trap $\Rightarrow$ Frame Error;

Note: Ls also identifies the same source operand which must be denoted by the Return in-struction to address the saved return PC.

Ld (L0 is interpreted as L16) also identifies the register in which the return PC is being saved by a Trap or Software instruction or by an exception; therefore only local registers with a lower register code than the interpreted Ld-code of the Frame instruction may be used after execution of a Frame instruction.

The reserve of 10 registers is to be used as follows:

❑ A Call, Trap or Software instruction uses six registers.

❑ A subsequent exception, occurring before a Frame instruction is executed, uses another two registers.

❑ Two registers remain in reserve.

Note that the Frame instruction can write into the memory stack at address locations up to 37 words higher than indicated by the address in the UB. This is due to the fact that the upper bound is checked before the execution of the Frame instruction.

Attention: The Frame instruction must always be the first instruction executed in a func-tion entered by a Call instruction, otherwise the Frame instruction could be separated from the preceding Call instruction by an Interrupt, Parity Error, Extended Overflow or Trace exception (see section 3.27. Call instruction).

3.30. Return Instruction

The Return instruction returns control from a subprogram entered through a Call, Trap or Software instruction or an exception to the instruction located at the return address and restores the status from the saved return status.

The source operand pair Rs//Rsf is placed in the register pair PC//SR. The program counter PC is restored first from Rs. Then all bits of the status register SR are replaced by Rsf, except the supervisor flag S, which is restored from bit zero of Rs and except the instruction length code ILC, which is cleared to zero.

If the return occurred from user to supervisor state or if the interrupt-lock flag L was changed from zero to one on return from any state to user state, a trap to Privilege Error occurs. Exception processing saves the restored contents of the register pair PC//SR; an illegally set S or L flag is also saved.

Then the difference between frame pointer FP - stack pointer SP(8..2) is evaluated and interpreted as a signed 7-bit integer. If the difference is not negative, the register pointed to by FP(5..0) is in the register part of the stack; no further action is then required and the Return instruction is completed.

If the difference is negative, the number of words equal to the negative difference are pulled from the memory part of the stack and transferred to the register part of the stack, beginning with the contents of the memory location SP - 4 being transferred to the local register addressed absolutely by bits 7..2 of SP - 4. After each memory cycle, the SP is decremented by four until the difference is eliminated.

The Return instruction shares its basic OP-code with the Move Double-Word instruction. It is differentiated from it by denoting the PC as destination register Rd.

The PC or the SR must not be denoted as a source operand; these notations are reserved for future expansion.

3.30. Return Instruction (continued)

Format   Notation   Operation

RR   RET PC, Rs   old S := S;
                                        old L := L;
                                        PC := Rs(31..1)//0;
                                        SR := Rsf(31..21)//00//Rs(0)//Rsf(17..0);
                                            -- ILC := 0;
                                            -- S := Rs(0);
                                        if old S = 0 and S = 1 or
                                            S = 0 and old L = 0 and L = 1 then
                                            trap $\Rightarrow$ Privilege Error;
                                        difference(6..0) := FP - SP(8..2);
                                            -- difference is signed, difference(6) = sign bit
                                        if difference $\geq$ 0 then
                                            continue at next instruction;
                                            -- RET is finished
                                        else
                                            repeat
                                                SP := SP - 4;
                                                register SP(7..2)^ := memory SP^;
                                                    -- memory $\Rightarrow$ local register
                                                difference := difference + 1;
                                            until difference = 0;

3.31. Fetch Instruction

The instruction execution is halted until a number of at least $n/2 + 1$ ($n = 0, 2, 4..30$) instruction half-words succeeding the Fetch instruction are prefetched in the instruction cache. Since instruction words are fetched, one more half-word may be fetched. The number $n/2$ is derived by using bits 4..1 of n, bit 0 of n must be zero.

The Fetch instruction must not be placed as a delay instruction; when the preceding branch is taken, the prefetch is undefined.

The Fetch instruction shares the basic OP-code SETxx, it is differentiated by denoting the SR for the Rd-code (see section 2.3. Instruction Formats).

n	Format	Notation	Operation
0	Rn	FETCH 1	Wait until 1 instruction half-word is fetched;
.	.	.	
.	.	.	
.	.	.	
30	Rn	FETCH 16	Wait until 16 instruction half-words are fetched

Note: The Fetch instruction supplements the standard prefetch of instruction words. It may be used to speed up the execution of a sequence of memory instructions by avoiding alternating between instruction and data memory pages. By executing a Fetch instruction preceding a sequence of memory instructions addressing the same data memory page, the memory accesses can be constrained to the data memory page by prefetching all required instructions in advance.

A Fetch instruction may also be used preceding a branch into a program loop; thus, flushing the cache by the first branch repeating the loop can be avoided.

3.32. Extended DSP Instructions

The Extended DSP instructions use the on-chip multiply-accumulate unit. Single word results always use register G15 as destination register, while double-word results are always placed in G14 and G15. The condition flags remain unchanged.

Format	Notation	Operation
LLext	EMUL Ld, Ls	G15 := Ld * Ls; -- signed or unsigned multiplication, single word product
LLext	EMULU Ld, Ls	G14//G15 := Ld * Ls; -- unsigned multiplication, double word product
LLext	EMULS Ld, Ls	G14//G15 := Ld * Ls; -- signed multiplication, double word product
LLext	EMAC Ld, Ls	G15 := G15 + Ld * Ls; -- signed multiply/add, single word product sum
LLext	EMACD Ld, Ls	G14//G15 := G14//G15 + Ld * Ls; -- signed multiply/add, double word product sum
LLext	EMSUB Ld, Ls	G15 := G15 - Ld * Ls; -- signed multiply/subtract, single word product difference
LLext	EMSUBD Ld, Ls	G14//G15 := G14//G15 - Ld * Ls; -- signed multiply/subtract, double word product difference
LLext	EHMAC Ld, Ls	G15 := G15 + Ld(31..16) * Ls(31..16) + Ld(15..0) * Ls(15..0); -- signed half-word multiply/add, single word product sum
LLext	EHMACD Ld, Ls	G14//G15 := G14//G15 + Ld(31..16) * Ls(31..16) + Ld(15..0) * Ls(15..0); -- signed half-word multiply/add, double word product sum
LLext	EHCMULD Ld, Ls	G14 := Ld(31..16) * Ls(31..16) - Ld(15..0) * Ls(15..0); G15 := Ld(31..16) * Ls(15..0) + Ld(15..0) * Ls(31..16); -- half-word complex multiply
LLext	EHCMACD Ld, Ls	G14 := G14 + Ld(31..16) * Ls(31..16) - Ld(15..0) * Ls(15..0); G15 := G15 + Ld(31..16) * Ls(15..0) + Ld(15..0) * Ls(31..16); -- half-word complex multiply/add
LLext	EHCSUMD Ld, Ls	G14(31..16) := Ld(31..16) + G14; G14(15..0) := Ld(15..0) + G15; G15(31..16) := Ld(31..16) - G14; G15(15..0) := Ld(15..0) - G15; -- half-word (complex) add/subtract -- Ls is not used and should denote the same register as Ld
LLext	EHCFFTD Ld, Ls	G14(31..16) := Ld(31..16) + (G14 >> 15); G14(15..0) := Ld(15..0) + (G15 >> 15); G15(31..16) := Ld(31..16) - (G14 >> 15); G15(15..0) := Ld(15..0) - (G15 >> 15); -- half-word (complex) add/subtract with fixed-point adjustment -- Ls is not used and should denote the same register as Ld

3.32. Extended DSP Instructions (continued)

Format	Notation	Operation
LLext	EHCFFTSD Ld, Ls	G14(31..16) := (Ld(31..16) + (G14 >> 15)) >> 1; G14(15..0) := (Ld(15..0) + (G15 >> 15)) >> 1; G15(31..16) := (Ld(31..16) - (G14 >> 15)) >> 1; G15(15..0) := (Ld(15..0) - (G15 >> 15)) >> 1; -- half-word (complex) add/subtract with fixed-point adjustment and shift -- Ls is not used and should denote the same register as Ld

The instructions EMAC through EHCFFTSD can cause an Extended Overflow exception when the Extended Overflow Exception flag is enabled (FCR(16) = 0). Note that this over-flow occurs asynchronously to the execution of the Extended DSP instruction and any suc-ceeding instructions.

Attention: A new Extended DSP instruction can be started before the Extended Overflow exception trap is executed!

An Extended DSP instruction is issued in one cycle; the processor starts execution of the next instructions before the Extended DSP instruction is finished. The execution of suc-ceeding non-Extended-DSP instructions is only stopped and wait cycles are inserted when an instruction addresses G15 or G14//G15 respectively before a preceding Extended DSP instruction placed its result into G15 or G14//G15. Thus, DSP programs can place Load/Store or loop administration instructions into the slot cycles between issue of an Ex-tended DSP instruction and availability of its result. See also section 2.5. Instruction Tim-ing.

3.33. Software Instructions

The Software instructions cause a branch to the subprogram associated with each Software instruction. Its entry address (see section 2.4. Entry Tables), deduced from the OP-code of the Software instruction, is placed in the program counter PC. Data is saved in the register sequence beginning at register address FP + FL (FL = 0 is interpreted as FL = 16) in ascending order as follows:

❐ Stack address of the destination operand

❐ High-order word of the source operand

❐ Low-order word of the source operand

❐ Old program counter PC, containing the return address and the old S flag in bit zero

❐ Old status Register SR, ILC contains the instruction-length code (ILC = 1) of the software instruction

Then the frame pointer FP is incremented by the old frame length FL and FL is set to six, thus creating a new stack frame. The cache-mode flag M and the trace-mode flag T are cleared, the interrupt-lock flag L is set to one. All condition flags remain unchanged.

Instruction execution then proceeds at the entry address placed in the PC.

Ls or Lsf and Ld may denote the same register.

Format	Notation	Operation

LL	see specific instructions	if (trap table in Mem3) then
		    PC := 23 ones//0//OP(11..8)//4 zeros;
		else
		    PC = MCR(13..12)//21 zeros//1//~OP(11..8)//1100;
		(FP + FL)^ := stack address of Ld;
		(FP + FL + 1)^ := Ls;
		(FP + FL + 2)^ := Lsf;
		(FP + FL + 3)^ := old PC(31..1)//old S;
		(FP + FL + 4)^ := old SR;
		FP := FP + FL; -- FL = 0 is treated as FL = 16
		FL := 6;
		M := 0;
		T := 0;
		L := 1;

Note: At the new stack frame, the stack address of the destination operand can be addressed as L0, the source operand as L1//L2, the saved PC as L3 and the saved SR as L4; L5 is free for use as required.

A Frame instruction must be executed before executing any other Software instruction, Trap or Call instruction or before the interrupt-lock flag L is being cleared, otherwise the beginning of the register part of the stack at SP could be overwritten without any warning.

3.33.1. Do Instruction

The Do instruction is executed as a Software instruction. The associated subprogram is entered, the stack address of the destination operand and one double-word source operand are passed to it (see section 3.33. Software Instructions for details).

The half-word succeeding the Do instruction will be used by the associated subprogram to differentiate branches to subordinate routines; the associated subprogram must increment the saved return program counter PC by two.

Format	Notation	Operation
LL	DO xx... Ld, Ls	execute Software instruction;

"xx..." stands for the mnemonic of the differentiating half-word after the OP-code of the Do instruction.

The Do instruction must not be placed as delay instruction since then xx... cannot be located.

Note: The Do instruction provides very code efficient passing of parameters to routines executing software implemented extensions of the instruction set.

Branching to unimplemented subordinate routines with the interrupt-lock flag L set to one must be excluded by bounds checks of the differentiating half-word at runtime; out-of-range values cannot be securely excluded at the assembly level.

The L flag must be cleared when the execution of a subordinate routine exceeds the regular interrupt latency time.

Application Note: The definition of subprograms entered via the Do instruction is reserved for system implementations. The values assigned to the differentiating half-word xx... after the OP-code of the Do instruction must be in ascending and contiguous order, starting with zero. This order enables fast range checking for an upper bound and also avoids unused space in the differentiating branch table.

3.33.2. Floating-Point Instructions

The Floating-Point instructions comply with the ANSI/IEEE standard 754-1985. In the present version, they are executed as Software instructions. The following description provides a general overview of the architectural integration.

The basic instructions use single-precision (single-word) and double-precision (double-word) operands. Floating-Point instructions must not be placed as delay instructions (see 3.26. Delayed Branch Instructions).

Except at the Floating-Point Compare instructions, all condition flags remain unchanged to allow future concurrent execution.

The rounding modes FRM are encoded as:

SR(14)	SR(13)	Description
0	0	Round to nearest
0	1	Round toward zero
1	0	Round toward - infinity
1	1	Round toward + infinity

The floating-point trap enable flags FTE and the exception flags are assigned as:

floating-point trap enable FTE	accrued exceptions	actual exceptions	exception type
SR(12)	G2(4)	G2(12)	Invalid Operation
SR(11)	G2(3)	G2(11)	Division by Zero
SR(10)	G2(2)	G2(10)	Overflow
SR(9)	G2(1)	G2(9)	Underflow
SR(8)	G2(0)	G2(8)	Inexact

The reserved bits G2(31..13) and G2(7..5) must be zero.

A floating-point Not a Number (NaN) is encoded by bits 30..19 = all ones in the operand word containing the exponent; all other bits of the operand are ignored for differentiating a NaN from a non-NaN.

In the case of an operand word containing a NaN, bit zero = 0 differentiates a quiet NaN, bit zero = 1 differentiates a signalling NaN; the bits 18..1 may be used to encode further information.

3.33.2. Floating-Point Instructions (continued)

Format	Notation	Operation

LL   FADD Ld, Ls   Ld := Ld + Ls;

LL   FADDD Ld, Ls   Ld//Ldf := (Ld//Ldf) + (Ls//Lsf);

LL   FSUB Ld, Ls   Ld := Ld - Ls;

LL   FSUBD Ld, Ls   Ld//Ldf := (Ld//Ldf) - (Ls//Lsf);

LL   FMUL Ld, Ls   Ld := Ld $*$ Ls;

LL   FMULD Ld, Ls   Ld//Ldf := (Ld//Ldf) $*$ (Ls//Lsf);

LL   FDIV Ld, Ls   Ld := Ld / Ls;

LL   FDIVD Ld, Ls   Ld//Ldf := (Ld//Ldf) / (Ls//Lsf);

LL   FCVT Ld, Ls   Ld := Ls//Lsf;   -- Convert double $\Rightarrow$ single

LL   FCVTD Ld, Ls   Ld//Ldf := Ls;   -- Convert single $\Rightarrow$ double

LL   FCMP Ld, Ls   result := Ld - Ls;
                                  Z := Ld = Ls and not unordered;
                                  N := Ld < Ls or unordered;
                                  C := Ld < Ls and not unordered;
                                  V := unordered;
                                  if unordered then
                                      Invalid Operation exception;

LL   FCMPD Ld, Ls   result := (Ld//Ldf) - (Ls//Lsf);
                                  Z := (Ld//Ldf) = (Ls//Lsf) and not unordered;
                                  N := (Ld//Ldf) < (Ls//Lsf) or unordered;
                                  C := (Ld//Ldf) < (Ls//Lsf) and not unordered;
                                  V := unordered;
                                  if unordered then
                                      Invalid Operation exception;

LL   FCMPU Ld, Ls   result := Ld - Ls;
                                  Z := Ld = Ls and not unordered;
                                  N := Ld < Ls or unordered;
                                  C := Ld < Ls and not unordered;
                                  V := unordered;   -- no exception

LL   FCMPUD Ld, Ls   result := (Ld//Ldf) - (Ls//Lsf);
                                  Z := (Ld//Ldf) = (Ls//Lsf) and not unordered;
                                  N := (Ld//Ldf) < (Ls//Lsf) or unordered;
                                  C := (Ld//Ldf) < (Ls//Lsf) and not unordered;
                                  V := unordered;   -- no exception

3.33.2. Floating-Point Instructions (continued)

A floating-point instruction, except a Floating-point Compare, can raise any of the exceptions Invalid Operation, Division by Zero, Overflow, Underflow or Inexact. FCMP and FCMPD can raise only the Invalid Operation exception (at unordered). FCMPU and FCMPUD cannot raise any exception.

At an exception, the following additional action is performed:

❐ Any corresponding accrued-exception flag whose corresponding trap-enable flag is zero (not enabled) is set to one; all other accrued-exception flags remain unchanged.

❐ If a corresponding trap-enable flag is one (enabled), any corresponding actual-exception flag is set to one; all other actual-exception flags are cleared. The destination remains unchanged.
In the present software version, the software emulation routine must branch to the corresponding user-supplied exception trap handler. The (modified) result, the source operand, the stack address of the destination operand and the address of the floating-point instruction are passed to the trap handler. In the future hardware version, a trap to Range Error will occur; the Range Error handler will then initiate re-execution of the floating-point instruction by branching to the entry of the corresponding software emulation routine, which will then act as described before.

The only exceptions that can coincide are Inexact with Overflow and Inexact with Underflow. An Overflow or Underflow trap, if enabled, takes precedence over an Inexact trap; the Inexact accrued-exception flag G2(0) must then be set as well.

3.33.2. Floating-Point Instructions (continued)

The table below shows the combinations of Floating-Point Compare and Branch instructions to test all 14 floating-point relations:

relation	Compare	Branch on true	Branch on false	exception if unordered
=	FCMPU	BE	BNE	--
?≠	FCMPU	BNE	BE	--
>	FCMP	BGT	BLE	x
≥	FCMP	BGE	BLT	x
<	FCMP	BLT	BGE	x
≤	FCMP	BLE	BGT	x
?	FCMPU	BV	BNV	--
≠	FCMP	BNE	BE	x
<=>	FCMP	--	--	x
?>	FCMPU	BHT	BSE	--
?≥	FCMPU	BHE	BST	--
?<	FCMPU	BLT	BGE	--
?≤	FCMPU	BLE	BGT	--
?=	FCMPU	BE, BV	BST, BGT	--

The symbol ? signifies unordered.

Note: At the test <=> (ordered), no branch after FCMP is required since the result of the test is an Invalid Operation exception occurred or not occurred.

4. Exceptions

4.1. Exception Processing

Exceptions are events which redirect the flow of control to a supervisor subprogram associated with the type of exception, that is, a trap occurs as a response to the exception. (See a detailed description of exceptions further below.) If exceptions coincide, the exception with the highest priority takes precedence over all exceptions with lower priority.

Processing of an exception proceeds as follows:

The entry address (see section 2.4. Entry Tables) of the associated subprogram is placed in the program counter PC and the supervisor-state flag S is set to one. The old PC is saved in the register addressed by FP + FL; the old S flag is also saved in bit zero of this register. The old status register SR is saved in the register addressed by FP + FL + 1 (FL = 0 is interpreted as FL = 16); the saved instruction-length code ILC contains (in general, see section 4.3. Exception Backtracking). the instruction-length code of the preceding instruction.

Then the frame pointer FP is incremented by the old frame length FL and FL is set to two, thus creating a new stack frame. The cache-mode flag M and the trace-mode flag T are cleared, the interrupt-lock flag L is set to one. All condition flags remain unchanged.

Operation

PC := entry address of exception subprogram;
S := 1;
(FP + FL)^ := old PC(31..1)//old S;
(FP + FL + 1)^ := old SR;
FP := FP + FL;   -- FL = 0 is treated as FL = 16
FL := 2;
M := 0;
T := 0;
L := 1;

Note: At the new stack frame, the saved PC can be addressed as L0 and the saved SR as L1. Since FL = 2, no other local registers are free for use.

A Frame instruction must be executed before the interrupt-lock flag L is cleared, before any Call, Trap, Software instruction or any instruction with the potential to cause an exception is executed. Otherwise, the beginning of the register part of the stack at the SP could be overwritten without any warning.

An entry caused by an exception can be differentiated from an entry caused by a Trap instruction by the value of FL: FL is set to two by an exception and set to six by a Trap instruction.

4.2. Exception Types

The following exception are types ordered by priorities, Reset has the highest priority. In case of coincidental exceptions, higher-priority exceptions overrule lower-priority exceptions.

4.2.1. Reset

A Reset exception occurs on a transition of the RESET# signal from low to high or as a result of a watchdog overrun in IO3 Watchdog mode or after a reset following a clock-down command. The Reset exception overrules all other exceptions and is used to start execution at the Reset entry.

The load and store pipelines are cleared. The BCR, MCR, FCR and TPR initialization in the three reset cases is specified in the table 4.1; all other registers and flags, except those set or cleared explicitly by the exception processing itself, remain undefined and must be initialized by software.

In the reset handler, ISR bits 9 and 10 can be used to discriminate between the three reset sources.

Reset source	BCR	MCR	FCR	TPR
RESET#	initialized	initialized	initialized	initialized
Watchdog	initialized	initialized	initialized	preserved
Clock-Down	initialized	initialized	preserved	initialized

Table 4.1: BCR, MCR, FCR, TPR initialization on Reset

The FCR is preserved on a clock-down reset in order to have the correct interrupt mask and polarity for the wakeup from clock-down. TPR is preserved on a watchdog reset to allow the use of the watchdog reset as a controlled time-out without losing the time base. The other registers are initialized to their specific reset value.

Note: The frame pointer FP can only be set to a defined value by restoring it from the FP in the return SR through a Return instruction.

4.2.2. Range, Pointer, Frame and Privilege Error

These exceptions share a common entry since they cannot occur coincidentally at the same instruction. The error-causing instruction can be identified by backtracking.

A Range Error exception occurs when an operand or result exceeds its value range.

A Pointer Error is caused by an attempted memory access using an address register (Rd or Ld) with the content zero. The memory is not accessed, but the content of the address register is updated in case of a post-increment or next address mode.

A Frame Error occurs when the restructuring of the stack frame reaches or exceeds the upper bound UB of the memory part of the stack. No further Frame instruction must be executed by the error routine for Pointer, Frame and Privilege Error before the UB is set to a higher value and thus, an expanded stack frame fits into the higher stack bound.

A Privilege Error occurs when a privileged operation is executed in user or on return to user state (see section 1.5. Privilege States for details).

4.2.3. Extended Overflow

An Extended Overflow condition is raised on an overflow caused by an add or subtract operation as part of the execution of one of the Extended instructions EMAC through EHCFFTSD when the Extended Overflow exception is enabled. The Extended Overflow exception is enabled by clearing bit 16 of the function control register FCR to zero.

When the Extended Overflow exception is blocked by a higher-priority exception or by the L flag being set, the Extended Overflow condition is saved internally; the exception trap occurs then when the blocking is released.

The Extended Overflow condition is cleared by the exception trap or by setting FCR(16) to one (disabled).

The Extended Overflow exception trap occurs asynchronously to the causing instruction; thus, the causing instruction cannot be identified by backtracking. Usually, there is only one instruction in a loop which can cause an Extended Overflow exception; thus, a handler can identify that instruction. When a second Extended Overflow condition is raised before the first one caused a trap, it is ored and only one trap is taken.

4.2.4. Parity Error

A Parity Error exception can be enabled individually for each of the memory areas MEM0..MEM3. When enabled, a parity error on an access to the corresponding memory area causes a Parity Error exception.

When the Parity Error exception is blocked by a higher-priority exception or by the L flag being set, the Parity Error condition is saved internally, the exception trap occurs then when the blocking is released.

The Parity Error condition is cleared only by the exception trap; it is not cleared by setting any of the disable bits 31..28 in the BCR after a Parity Error condition is saved internally.

The Parity Error exception trap occurs asynchronously to the causing memory instruction. Since memory accesses are pipelined, a Parity Error exception cannot be related to a specific memory instruction.

4.2.5. Interrupt

An Interrupt exception is caused by an external interrupt signal, by the timer interrupt or by an IO3 Control Mode. Since the interrupt-lock flag L is set by the exception processing, no further interrupts can occur until the L flag is cleared. The interrupt exception processing sets also the interrupt-mode flag I to one. See also sections 2.4. Entry Tables, 5. Timer and CPU Clock Modes and 6.9. Bus Signals.

The I flag is used by the operating system, it must not be cleared by the interrupt handler. A Return instruction restores the old value from the saved SR automatically.

4.2.6. Trace Exception

A Trace exception occurs after each execution of an instruction except a Delayed Branch instruction when the trace mode is enabled (trace flag T = 1) and the trace pending flag P is one. After a Call instruction, a Trace exception is suppressed until the next instruction is executed regardless of the trace mode being enabled; the T flag is not affected.

The P flag in the saved return status register SR must be cleared by the trace handler to prevent tracing the same instruction again.

The instruction preceding the Trace exception cannot be backtracked since only potentially error-causing instructions can and need be backtracked.

4.3. Exception Backtracking

In the case of a Pointer, Frame, Privilege and Range Error exception caused by a delay instruction succeeding a delayed branch taken, the location of the saved PC contains the address of the delay instruction and the saved instruction length code ILC contains the length of the Delayed Branch instruction (in half-words).

In the case of all other exceptions, the location of the saved PC contains the return address, that is, the address of the instruction which would have been executed next if the exception had not occurred. The saved ILC contains the length of the last instruction except when the last instruction executed was a branch taken; a Return instruction clears the ILC and thus, the saved ILC after a Return instruction contains zero.

An exception caused by a Pointer, Frame, Privilege or Range Error, except following a Return instruction, can be backtracked. For backtracking, the content of the adjusted saved ILC is subtracted from the address contained in the location of the saved PC.

If the backtrack-address calculated in this way points to a Delayed Branch instruction, the error-causing instruction is a delay instruction with a preceding delayed branch taken and the address contained in the location of the saved PC points to the address of this delay instruction.

If the backtrack-address calculated does not point to a Delayed Branch instruction, it points directly to the error-causing instruction. This instruction is then either not a delay instruction or a delay instruction with the preceding delayed branch not taken.

The error-causing instruction can then be inspected and the cause of an error analyzed in detail.

In the case of a Privilege Error, the ILC must be tested for zero to single out an exception caused by a Return instruction before backtracking. Thus, an exception caused by a Return instruction can be identified. However, it cannot be backtracked to the instruction address of the Return instruction because the return address saved does not succeed the address of the Return instruction. All other branching instructions cannot be backtracked either. Since these instructions cause no errors, backtracking is not required.

The stack address of a local register denoted by a backtracked instruction can be calculated according to the following formula:

```
stack address of preceding stack frame := stack address of
current stack frame - (((FP - saved FP) modulo 64) * 4);
        --  bits 5..0 of the difference (FP - saved FP) are used zero-expanded
        --  * 4 converts word difference ⇒ byte difference
        --  the stack address of the current stack frame is provided by the
            Set Stack Address instruction
stack address of local register := stack address of preceding
stack frame + (local register address code * 4);
        --  * 4 converts local register word offset ⇒ byte offset
```

Note: Backtracking allows a much more detailed analysis of error causes than a more differentiated trapping could provide. Exception handlers can get more information about error causes and the precise messages required by most programming languages can be easily generated.

5. Timer and CPU Clock Modes

5.1. Overview

The on-chip timer is controlled via three registers:

        Timer prescaler register TPR   G21

        Timer register TR   G23

        Timer compare register TCR   G22

The timer prescaler register also controls the processor clock output of the PLL circuit.

G21..G23 can be addressed only via the high global flag H by a MOV or MOVI instruction. The content of G21 (timer prescaler register) cannot be read.

Additionally, two different power saving modes are implemented: power-down mode and sleep mode (clock-down mode).

5.1.1. Timer Prescaler Register TPR

Global register G21 is the write-only Timer Prescaler Register TPR. The TPR adapts the timer clock to different processor clock frequencies and controls the PLL clock output.

Bits 26 to 28 select the processor clock. Bits 23..16 determine the basic time unit via

    frequency of timer clock = frequency of processor clock divided by (n+2)

n is the value of bits 23..16, n is in the range from 0 to 255 yielding division factors from 2 to 257. Given a basic time unit, n can be calculated as

    n = (time unit * frequency of processor clock) - 2.

Bit 31 determines the effect of a write to TPR. If bit 31 is 0, a write to TPR takes effect immediately, the processor clock divider is changed and the timer prescaler divider is reloaded. If bit 31 is 1, the processor clock divider and timer prescaler divider update is delayed until the current basic time unit ends. At the end of the current time unit, the processor clock divider and the timer prescaler divider are updated with the new values. This allows keeping absolute timing even when the processor clock is changed by simultaneously changing the processor clock divider and the timer prescaler divider.

The TPR is initialized to bit 28=0, 27..26=1, and 23..16=0 on reset (from the RESET# pin or by a Clock-Down reset), i.e. the processor starts with CPU clock = XTAL1 clock, the prescaler divides by 2. During a Watchdog (IO3 Timer) Reset, the TPR is preserved. This allows the use of the Watchdog as a controlled time-out without losing the time base.

Bits 30..29, 25..24 and 15..0 are reserved and must be zero on a move to TPR.

The processor clock divider control can be used to slow down the CPU clock in order to save power during times when only a part of the processing power of the CPU is needed. Whenever the full processing power is needed, the CPU clock can be switched back to full speed.

Bits	Name	Description
31	LoadEnable	1 = TPR update is delayed until current prescaler time unit ends 0 = TPR update is performed immediately
30..29		reserved
28..26	ClockDivider	CPU Clock Divider Control 111 = reserved 110 = reserved 101 = reserved 100 = CPU clock = XTAL1 clock / 2 011 = CPU clock = XTAL1 clock 010 = CPU clock = XTAL1 clock * 2 001 = CPU clock = XTAL1 clock * 4 000 = CPU clock = XTAL1 clock * 8
25..24		reserved
23..16	TimerPrescaler	Timer Prescaler Division factor n Range n = 0..255, Timer Prescaler divides by n+2
15..0		reserved

Table 5.1: Timer Prescaler Register TPR

5.1.2. Timer Register TR

The TR is a 32-bit register which is incremented by one on each time unit modulo 2^{32}. Its content can be used as the lower word of a double-word integer, representing the time inclusive date.

The TPR and the TR should be set only once on system initialization, whereby the following instruction sequence must be observed strictly (interrupts must be locked out):

```
        :
        :
FETCH 4
ORI    SR, $20        ; set H-flag
MOV    TPR, Lx        ; load prescaler register from local register x
ORI    SR, $20        ; set H-flag
MOV    TR, Ly         ; load timer register from local register y
        :
        :
```

Note: The Fetch instruction is necessary to prevent insertion of idle cycles during the prescribed instruction sequence.

5.1.3. Timer Compare Register TCR

The content of the TCR is compared continuously with the content of the timer register TR. An unsigned modulo comparison is performed according to:

result(31..0) := TR(31..0) - TCR(31..0)

On result(31) = 0, the TR is higher than or equal to the TCR.

When the timer interrupt is enabled (FCR(23) = 0) and the value in the TR is higher than or equal to the value in the TCR, a timer interrupt is generated. This interrupt is cleared by loading the TCR with a value higher than the current content of the TR.

Timer interrupts can be masked out by FCR(23) = 1; FCR(23) is set to one on Reset. The timer interrupt disable bit FCR(23) does not affect the timer and compare function.

A delay time in the TCR is calculated according to the formula:

TCR := current content of TR + number of delay time units

The maximum number of delay time units allowed for this calculation is 2^{31}-1.

For example:

TR(31..0)   = hex FFFF FF00

delay time units (= 1000) = hex 0000 03E8

TCR(31..0)   = hex 0000 02E8

Since the modulo comparison is an unsigned operation, only unsigned arithmetic must be used for calculations with timer and timer compare values. Do not use the N or C flag to test for the result of the comparison TR - TCR, use only result bit 31!

5.1.4. Power-Down Mode

When the power-down mode is entered, the execution pipeline of the processor is halted. Only the logic for the timer, IO3 control modes, interrupt and refresh is being clocked, all other clocks are disabled. The processor is temporarily activated for refresh and bus arbitration cycles, no instructions are executed during these temporary clock cycles. The processor resumes execution by any interrupt or on a reset.

Power-down mode can be entered by executing an I/O write instruction with address bits A(27) and A(25..23) set to one and A(22) set to zero.

When power-down mode is entered via the I/O write instruction, the power-down mode takes effect at the time when the I/O access is performed. Until this time, instruction execution continues. To ensure that the power-down mode takes effect, the power-down I/O access must be followed by a dummy I/O load accesses to the same address with 2 access and 2 hold cycles. A following dependent instruction then waits until both I/O accesses are performed. Thus, instructions following the MOV instruction are not executed until wakeup. Note that even though the power-down request is an internal operation of the processor, bus grant must be given so that the power-down I/O access can be performed.

Power-down mode can be set by a program sequence as in the following example:

```
PowerDownIO    EQU          1 << 27 | %1110 << 22    ; Bits 27, 25..23, 22


               ...
               STW.IOA   0, 0, PowerDownIO        ; set power-down mode
               LDW.IOA   0, L4, PowerDownIO | 8   ; wait until power-down
               MOV       L4, L4                   ; I/O is executed
               ...                                ; execution continues
                                                  ; here after wakeup
```

5.1.5. Additional Power Saving

The CPU clock divider control can be used for example to switch the CPU to a slow clock during power-down for additional power savings. In the following example, the XTAL1 clock is 10 MHz, the CPU runs at 80 MHz and is switched back to 10 MHz during power-down. The timer prescaler setting is changed so that a time unit of 1 µs is kept through the power-down sequence. Using the "delayed TPR update" feature, the 1 µs absolute time is maintained even for the time units where the TPR setting changes.

Interrupts are locked out during power-down using the L bit in SR. This is done so that the TPR setting can be changed back to fast clock and corresponding prescaler setting after wakeup from power-down before the interrupt handler is called. The interrupt occurs at the time the lock bit L in SR is cleared.

The power-down is initiated by executing the power-down I/O access. The power-down is guaranteed to be effective before the next (dummy) I/O load access is done, thus the following MOV instruction is not executed until wakeup. The instructions to restore the CPU clock speed and the prescaler setting can thus be placed after the dummy load and MOV instructions.

```
TPR_fast       EQU     %000 << 26 | 78 << 16    ; fast TPR, divide by 80
TPR_slow       EQU     %011 << 26 |  8 << 16    ; slow TPR, divide by 10
DelayTPRUpd    EQU     1 << 31                  ; delayed TPR update
L_Bit          EQU     1 << 15                  ; Interrupt Lock in SR
H_Bit          EQU     1 << 5                   ; High-Global Bit in SR
PowerDownIO    EQU     1 << 27 | %1110 << 22    ; Power-Down I/O address
               ...

               MOVI    L5, TPR_slow             ; TPR for power-down
               MOVI    L6, TPR_fast             ; TPR after power-down
               ORI     L5, DelayTPRUpd          ; set delayed TPR update
               ORI     L6, DelayTPRUpd          ; set delayed TPR update

               ORI     SR, L_Bit | H_Bit        ; set Interrupt Lock
               MOV     TPR, L5                  ; set slow clock

               STW.IOA   0, 0, PowerDownIO      ; set power-down mode
               LDW.IOA   0, L4, PowerDownIO | 8 ; dummy load
               MOV       L4, L4                 ; wait till done

                                                ; next instruction is
                                                ; executed after wakeup
               ORI     SR, H_Bit
               MOV     TPR, L6                  ; restore fast clock
               ANDNI   SR, L_Bit                ; allow interrupt now

               ...                              ; continue here after
                                                ; interrupt routine has
                                                ; been executed
```

5.1.6. Sleep Mode

To further reduce power dissipation, the processor can be set into sleep mode. In this case, the clock of the processor is completely switched off. When a quartz crystal is used for processor clock generation, it is also switched off. An external reset signal or an interrupt awakes the processor from sleep mode and the processor continues with the standard reset procedure. Bit 10 in ISR indicates that the reset was caused by a wakeup from sleep mode. The sleep mode can be entered by an I/O write instruction with address bits A(27) and A(25..22) set to one. Note that any content of the internal RAM and the external DRAM as well as the timer count will be lost during sleep mode.

The sleep mode takes effect when the I/O access is performed. After this, the processor behaves as in reset, i.e. the bus request is deactivated until wakeup by an interrupt or reset. On wakeup by an interrupt, the FCR setting is preserved through the reset sequence. As with the power-down I/O access, a dummy load access could be placed after the sleep mode I/O access to ensure that the sleep mode takes effect. Since the processor continues with a reset at wakeup from sleep mode, an empty loop can be used as well to wait until the sleep mode I/O access has taken effect. Note that even though sleep mode is an internal operation of the processor, bus grant must be given so that the sleep mode set I/O access can be performed.

An interrupt signal awaking the processor from sleep mode must stay active at least until the processor has begun executing its reset sequence. This latency time includes the startup time of the crystal oscillator and of the PLL circuit. If the interrupt goes inactive before this latency time has elapsed, the processor may fall back into sleep mode. In order to have the effect of causing a processor interrupt, the interrupt signal should stay active until it is acknowledged by the interrupt handler.

The sleep mode can be set by a program sequence as in the following example:

```
SleepModeIO  EQU       1 << 27 | %1111 << 22   ; Bits 27, 25..22

             ...
             STW.IOA  0, 0, SleepModeIO         ; set sleep mode
SleepWait:   BR       SleepWait                 ; wait until sleep
                                                ; mode I/O is executed
```

6. Bus Interface

6.1. Bus Control General

The processor provides on-chip all functions for controlling memory and peripheral devices, including RAS-CAS multiplexing, DRAM refresh and parity generation and checking. Supported DRAM types include Fast Page Mode, EDO, and Synchronous DRAM. The number of bus cycles used for a memory or I/O access is also defined by the processor, thus, no external bus controllers are required. All memory and peripheral devices can be connected directly, pin by pin, without any glue logic.

The memory address space is divided into five partitions as follows:

Address (Hex)	Address Space	Memory Type
0000 0000..3FFF FFFF	MEM0	ROM, SRAM, DRAM
4000 0000..7FFF FFFF	MEM1	ROM, SRAM
8000 0000..BFFF FFFF	MEM2	ROM, SRAM
C000 0000..DFFF FFFF	IRAM	Internal RAM (IRAM)
E000 0000..FFFF FFFF	MEM3	ROM, SRAM

Table 6.1: Memory Address Spaces

The bus timing, refresh control and parity error disable for memory access is defined in the Bus Control Register BCR. The bus timing for I/O Bus Access is defined by address bits in the I/O address.

On a memory or I/O access, the address bus signals are valid through the whole access. On a memory access, the chip select signal for the selected memory area MEM0..MEM3 is switched to low through the whole access. On a write access to memory or I/O, the data bus and the parity signals are also activated and the write enable signal WE# is switched to low through the whole access.

A bus wait cycle is inserted automatically to guarantee a minimum of one idle cycle between the end of an output enable signal (OE#, IORD#, CASx# at read) and the beginning of a subsequent write access. After a DRAM read access with an access time > 2 cycles, two bus wait cycles are inserted before a subsequent write access.

6.1.1. Boot Width Selection

The processor provides two pins (BOOTW and BOOTB) for selecting the data bus width for memory area MEM3 (boot memory area). Table 6.2 shows the encoding for selecting the desired data bus width. The pin state is sampled during reset.

BOOTW	BOOTB	Data Bus Width
HIGH	HIGH	8-bit
LOW	LOW	16-bit
HIGH	LOW	32-bit
LOW	HIGH	reserved

Table 6.2: Data bus width encoding for memory area MEM3

For the E1-16XS processor the BOOTW pin is connected to the BOOTB pin internally. Thus the BOOTB pin can be used to select between 8-bit and 16-bit MEM3 bus width.

6.1.2. SRAM and ROM Bus Access

On a one-cycle SRAM or EPROM read access, the output enable signal OE# is switched to low during the second half of the access cycle; on a multi-cycle read access, OE# is switched to low after the first access cycle and remains low through the rest of the specified access cycles. On a SRAM write access, the write enable signals WE0#..WE3# corresponding to the bytes to be written are switched to low analogous to the OE# signal for single and multiple access cycles.

For memory area MEM0, MEM2 and MEM3, an address setup cycle preceding the access cycles can be specified. For MEM0..MEM3, bus hold cycles can be specified. Bus hold cycles are additional cycles succeeding the access cycles where neither OE# nor WE0#..WE3# is low but all other bus signals are asserted. The bus hold cycles can be specified to be skipped or enforced. (see section 6.4.6. MEMx Bus Hold Break).

6.1.3. DRAM Bus Access, Fast Page Mode or EDO DRAM

A DRAM access to the same DRAM page as addressed by the previous DRAM access is executed as fast page mode access. See Bus Control Register BCR(17..16) for the access time and low-cycles of the CASx# signals. CAS0#..CAS3# signals enable the corresponding memory bytes 0..3.

A RAS access occurs when the DRAM page is different from the previously accessed DRAM page. The RAS# signal is switched to high for the number of specified precharge cycles. The high-order row address bits are multiplexed to the bit positions of the low-order column address bits according to the specified page size after the first bus cycle until the end of the specified RAS-to-CAS delay cycles. After the RAS-to-CAS delay cycles, the column address bits are available on the low-order bit positions and the CAS access cycle begins.

The row address bits are available at the high-order bit positions for the whole DRAM access. After a DRAM access, the addressed DRAM page is being available for fast page mode accesses to the same page until either a new DRAM page is addressed, the processor

is released to another bus master for DMA or a DRAM refresh takes place (see also section 6.11. Bus Cycles).

For Fast Page Mode DRAM, the OE# processor signal is not switched, it always remains high during DRAM accesses. The DRAM's OE# signal must be connected to ground. For EDO DRAM, the processor's OE# signal must be connected to the corresponding DRAM signal.

6.1.3.1. DRAM Row Address Bits Multiplexing

Table 6.3 shows the DRAM address bit multiplexing for Fast Page or EDO DRAM. The page size code (PSC) is specified in the Bus Control Register BCR. The grey fields denote the multiplexed DRAM address bits. The white fields denote the DRAM address bits which are not multiplexed. R denotes a row access, C denotes a column access.

PSC		25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	R	25	24	–	29	28	27	26	25	24	23	29	27	25	21	21	19	17	28	26	24	22	20	18	16	–	–
0	C	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	–	–
1	R	25	24	–	29	28	27	26	25	24	23	22	27	25	23	21	19	17	15	26	24	22	20	18	16	28	29
1	C	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
2	R	25	24	–	29	28	27	26	25	24	23	22	21	25	23	21	19	17	15	14	24	22	20	18	16	26	27
2	C	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
3	R	25	24	–	29	28	27	26	25	24	23	22	21	20	23	21	19	17	15	14	13	22	20	18	16	24	25
3	C	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
4	R	25	24	23	22	28	27	26	25	24	23	22	21	20	19	21	19	17	15	14	13	12	20	18	16	22	23
4	C	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
5	R	25	24	23	22	21	20	26	25	24	23	22	21	20	19	18	19	17	15	14	13	12	11	18	16	20	21
5	C	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
6	R	25	24	23	22	21	20	19	18	24	23	22	21	20	19	18	17	17	15	14	13	12	11	10	16	18	19
6	C	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
7	R	25	24	23	22	21	20	19	18	17	16	22	21	20	19	18	17	16	15	14	13	12	11	10	9	16	17
7	C	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0

Table 6.3: FPM and EDO DRAM Row Address Bits Multiplexing

Note: DRAM can only be connected to memory area MEM0. The address bit A0 of the address bus is not used in case of a 16-bit bus size for memory area MEM0. The address bits A1 and A0 of the address bus are not used in case of a 32-bit bus size for memory area MEM0. In case of page size code 0, only a 32-bit bus size for memory area MEM0 can be used. Memory area MEM0 is only selected if address bits A31 and A30 of a memory address are zero.

6.1.4. SDRAM Bus Access

The E1-32XS processor supports the direct connection of up to 512 Mbyte of SDRAM, addressed using address bits A0 to A28. Address line A29 is used for SDRAM configuration as indicated in the following table.

A31..A30	A29	A28	A27..A0	Function
00	0	address	address	SDRAM access
00	1	0	*	set SDRAM Mode Register (from address bits)
00	1	1	*	set SDRAM Control Register SDCR (from address bits)

Table 6.4: SDRAM memory and configuration access select

The address bits for the SDRAM bank addresses can be selected from address bits A20 to A28. The E1-32XS processor supports the generation of two SDRAM chip select signals so that two SDRAM banks can be connected directly. The address bit that discriminates between the two SDRAM chip selects can be selected from address bits A21 to A28. The second SDRAM chip select signal is not available on the E1-16XS. See the SDRAM Control Register description in section 6.5.

6.1.4.1. SDRAM Row Address Bits Multiplexing

For row access and column access, the address bits are multiplexed corresponding to the SDRAM address mapping table given below depending on the Page Size Code (PSC). At a column access, additional to the address bits in the column address range, the bank address bits are also enabled. The remaining address bits are forced to zero for normal accesses or forced to 1 for the "precharge all" command used during refresh, respectively. Page Size Code 0 is reserved, page size code 1 is not allowed for 8 bit bus size. Address bus bits 23..25 always carry address bits 23..25. The grey fields denote the multiplexed SDRAM address bits. The white fields denote the SDRAM address bits which are not multiplexed. R denotes a row access, C denotes a column access.

PSC		22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	R												reserved											
	C																							
1	R	0	28	27	26	25	24	23	22	27	25	23	21	19	17	15	26	24	22	20	18	16	28	–
	C	0	28|0	27|0	26|0	25|0	24|0	23|0	22|0	14	13	12	11	10	9	8	7	6	5	4	3	2	1	–
2	R	0	28	27	26	25	24	23	22	21	25	23	21	19	17	15	14	24	22	20	18	16	26	27
	C	0	28|0	27|0	26|0	25|0	24|0	23|0	22|0	21|0	13	12	11	10	9	8	7	6	5	4	3	2	1	0
3	R	0	28	27	26	25	24	23	22	21	20	23	21	19	17	15	14	13	22	20	18	16	24	25
	C	0	28|0	27|0	26|0	25|0	24|0	23|0	22|0	21|0	20|0	12	11	10	9	8	7	6	5	4	3	2	1	0
4	R	0	28	27	26	25	24	23	22	21	20	19	21	19	17	15	14	13	12	20	18	16	22	23
	C	0	28|0	27|0	26|0	25|0	24|0	23|0	22|0	21|0	20|0	19|0	11	10	9	8	7	6	5	4	3	2	1	0
5	R	0	28	27	26	25	24	23	22	21	20	19	18	19	17	15	14	13	12	11	18	16	20	21
	C	0	28|0	27|0	26|0	25|0	24|0	23|0	22|0	21|0	20|0	19|0	18|0	10	9	8	7	6	5	4	3	2	1	0
6	R	0	28	27	26	25	24	23	22	21	20	19	18	17	17	15	14	13	12	11	10	16	18	19
	C	0	28|0	27|0	26|0	25|0	24|0	23|0	22|0	21|0	20|0	19|0	18|0	17|0	9	8	7	6	5	4	3	2	1	0
7	R	0	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	16	17
	C	0	28|0	27|0	26|0	25|0	24|0	23|0	22|0	21|0	20|0	19|0	18|0	17|0	16|0	8	7	6	5	4	3	2	1	0

Table 6.5: SDRAM Row Address Bits Multiplexing

6.1.4.2. SDRAM Mode Register Setting

The SDRAM Mode Register (internal to the SDRAM devices) specifies SDRAM access parameters like burst length, burst type and CAS latency. The SDRAM mode register is set

from the SDRAM address bits on a Mem0 write access with address bits 29 set to 1 and address bit 28 set to 0.

The E1-32XS SDRAM interface does not use the burst capability of the SDRAM devices. Thus, for correct operation, the SDRAM mode register setting must specify a burst length of 1 and a CAS latency of 1 or 2 according to the SDRAM Control Register CASLatency setting.

6.1.4.3. SDRAM Connection

The connection of SDRAM devices to the E1-32XS and E1-16XS is specified in the following table. The table lists the SDRAM pins and the corresponding E1-32XS or E1-16XS pins for all the SDRAM signals.

SDRAM pin	E1-32XS pin	E1-16XS pin	Signal
CLK	CAS3#	CAS1#	SDRAM Clock signal SDCLK
CKE	DP3	DP1	SDRAM Clock Enable signal
CS	DP2 DP1	DP0 —	SDRAM first bank chip select CS0# SDRAM second bank chip select CS1#
RAS	RAS#	RAS#	SDRAM Row Address Strobe
CAS	CAS2#	CAS0#	SDRAM Column Address Strobe
WE	WE#	WE#	SDRAM Write Enable
DQM, L/UDQM	WE0#..WE3#	WE0#..WE1#	SDRAM Data Mask
A0…	A…	A…	SDRAM Address Input
BA0…	A…	A…	SDRAM Bank Address Input
DQ0…	D…	D…	SDRAM Data Input/Output

Table 6.6: SDRAM Connection

The E1-32XS WE0#..WE3# signals act as the Data Mask SDRAM signals. WE0# is the DQM signal corresponding to data bits 31..24, WE1# corresponds to data bits 23..16, WE2# corresponds to data bits 15..8, and WE3# corresponds to data bits 7..0.

The E1-16XS WE0# and WE1# signals act as the Data Mask SDRAM signals. WE0# is the DQM signal corresponding to data bits 15..8, and WE1# corresponds to data bits 7..0.

The SDRAM address signals connect to the address pins of the E1-32XS/E1-16XS starting at address bit 2 for a memory bus width of 32 bits, starting at address bit 1 for a memory bus width of 16 bits, and starting with address bit 0 for 8 bit memory bus width. The Page Size Code in BCR is selected based on the number of column address bits. The remaining address bits (including A10/AP) and the bank address pins are connected to the higher E1-32XS addresses.

If the bus grant is removed from the E1-32XS, all SDRAM control lines return to the high state before the bus is released. The E1-32XS assumes that it will get the bus back in the same state.

The E1-32XS uses the memory parity signals DP1..DP3 (DP0 and DP1 for the E1-16XS) for the SDRAM chip select and clock enable signals. Thus, these signals can not be used as memory parity signals if SDRAM is connected to the E1-32XS. All four parity disable bits in MCR must be set to 1 if SDRAM is used.

6.2. I/O Bus Access

Hyperstone provides a completely separate I/O address range which makes it possible to connect numerous peripheral devices each with individual behavior.

Bus timing and access mode for an I/O access is specified by bits 11..3 of the I/O address.

On an I/O access, the I/O read strobe IORD# or the I/O write strobe IOWR# is switched low for a read or write access respectively after the first access cycle, and it remains low for the rest of the specified access cycles. The beginning of the IORD# or IOWR# signal can be delayed by more than one cycle by specifying additional address setup cycles preceding the access cycles. The beginning of the next bus access can be delayed by specifying bus hold cycles succeeding the access cycles. Bus hold cycles are required by many I/O devices due to the time required to switch from driving the data bus to three-state.

Bit 11 of the I/O address enables a wait-pin controlled I/O access. The INT3/WAIT input of the processor is sampled after the first three access cycles of the specified I/O access time. The I/O access will be extended by inserting further access cycles as long as the signal at the WAIT input is asserted. When the WAIT signal becomes deasserted, the access will be terminated. Note that there is latency of about 2..3 processor cycles until a signal change at the WAIT input becomes effective. The polarity of the WAIT signal can be programmed via bit 26 of the Function Control Register FCR. When FCR(26) is set to 1 (default after reset), the WAIT signal is high asserted; when FCR(26) is set to 0, the WAIT signal is low asserted. A minimum of four I/O access cycles must be specified when the I/O wait mode is being enabled.

When an I/O device requires R/W# direction and data strobe control, IORD# can be specified (by address bit 10 = 1) as data strobe. WE# is then used as R/W# signal.

For normal I/O accesses, address bits 31..26 must be zero. Address bit 27 = 1 indicates an internal I/O access of the processor. This is currently only used for the power-down and sleep modes (see Timer and CPU Clock Modes).

For I/O accesses, address setup, access and bus hold time can be specified by bits in the I/O address as described in Figure 6.1. Reserved bits must always be supplied as zero when specifying an I/O address in a program.


```
         25        21          15    13 12 11 10 9  8   7     5  4  3  2  0
```

Reserved (must be 0)

I/O Address and/or I/O Chip Select
E1-16X: 6 Bits
E1-32X: 10 Bits

I/O Register Address

Reserved for System Peripheral

Wait Enable

Peripheral Device Control Mode
0 = IORD# / IOWR# Strobe Control
1 = R/W# / Data Strobe Control

Address Setup Time before Read or Write Access
00 = 0 cycles
01 = 2 cycles
10 = 4 cycles
11 = 6 cycles

Access Time for Read or Write Access
000 = 2 cycles
001 = 4 cycles
010 = 6 cycles
011 = 8 cycles
100 = 10 cycles
101 = 12 cycles
110 = 14 cycles
111 = 16 cycles

Bus Hold Time after Read or Write Access
00 = 0 cycles
01 = 2 cycles
10 = 4 cycles
11 = 6 cycles

Reserved for Internal Use (must be 0)

Figure 6.1: I/O Bus Control

6.3. Bus Control Register BCR

Global register G20 is the write-only bus control register BCR. The BCR defines the parameters (bus timing, refresh control) for accessing external memory located in address spaces MEM0..MEM3.

All bits of the BCR are set to one on Reset. They are intended to be initialized according to the hardware environment.

Bits	Name	Description
31..28	Mem3Access	Access time for address space MEM3 1111 = 16 clock cycles 1110 = 15 clock cycles 1101 = 14 clock cycles 1100 = 13 clock cycles 1011 = 12 clock cycles 1010 = 11 clock cycles 1001 = 10 clock cycles 1000 = 9 clock cycles 0111 = 8 clock cycles 0110 = 7 clock cycles 0101 = 6 clock cycles 0100 = 5 clock cycles 0011 = 4 clock cycles 0010 = 3 clock cycles 0001 = 2 clock cycles 0000 = 1 clock cycle
27..24	Mem2Access	Access time for address space MEM2 1111 = 16 clock cycles 1110 = 15 clock cycles 1101 = 14 clock cycles 1100 = 13 clock cycles 1011 = 12 clock cycles 1010 = 11 clock cycles 1001 = 10 clock cycles 1000 = 9 clock cycles 0111 = 8 clock cycles 0110 = 7 clock cycles 0101 = 6 clock cycles 0100 = 5 clock cycles 0011 = 4 clock cycles 0010 = 3 clock cycles 0001 = 2 clock cycles 0000 = 1 clock cycle

6.3. Bus Control Register BCR (continued)

Bits	Name	Description
23	Mem1Hold	Bus hold time for address space MEM1 When BCR(22) = 1: 1 = 2 clock cycles 0 = 1 clock cycle When BCR(22) = 0: 1 = 1 clock cycle 0 = 0 clock cycles
22..20	Mem1Access	Access time for address space MEM1 111 = 8 clock cycles 110 = 7 clock cycles 101 = 6 clock cycles 100 = 5 clock cycles 011 = 4 clock cycles 010 = 3 clock cycles 001 = 2 clock cycles 000 = 1 clock cycle
MEM0 = Non-DRAM (MCR(21) = 1):		
19..16	Mem0Access	Access time for address space MEM0 1111 = 16 clock cycles 1110 = 15 clock cycles 1101 = 14 clock cycles 1100 = 13 clock cycles 1011 = 12 clock cycles 1010 = 11 clock cycles 1001 = 10 clock cycles 1000 = 9 clock cycles 0111 = 8 clock cycles 0110 = 7 clock cycles 0101 = 6 clock cycles 0100 = 5 clock cycles 0011 = 4 clock cycles 0010 = 3 clock cycles 0001 = 2 clock cycles 0000 = 1 clock cycle
15..14	Mem0Setup	Address setup time for address space MEM0 11 = 3 clock cycles 10 = 2 clock cycles 01 = 1 clock cycle 00 = 0 clock cycles
13..11	Mem0Hold	Bus hold time for address space MEM0 111 = 7 clock cycles 110 = 6 clock cycles 101 = 5 clock cycles 100 = 4 clock cycles 011 = 3 clock cycles 010 = 2 clock cycles 001 = 1 clock cycle 000 = 0 clock cycles

6.3. Bus Control Register BCR (continued)

Bits	Name	Description
MEM0 = DRAM (MCR(21) = 0):		
19..18	RasPrecharge	RAS precharge time for address space MEM0 　　　　when MCR(8)=0　　　when MCR(8)=1 11 = 4 clock cycles　　　6 clock cycles 10 = 3 clock cycles　　　5 clock cycles 01 = 2 clock cycles　　　4 clock cycles 00 = 1 clock cycle　　　3 clock cycles
17..16	CASAccess	CAS access time for address space MEM0 　　　　when MCR(8)=0　　　when MCR(8)=1 11 = 4 clock cycles　　　6 clock cycles 10 = 3 clock cycles　　　5 clock cycles 01 = 2 clock cycles　　　4 clock cycles 00 = 1 clock cycle　　　3 clock cycles
15..14	RasToCas	RAS to CAS delay time 11 = 4 clock cycles 10 = 3 clock cycles 01 = 2 clock cycles 00 = 1 clock cycle
13..11	RefreshSelect	Refresh rate select (CAS before RAS refresh) 111 = Refresh disabled 110 = Refresh every 4 prescaler time units 101 = Refresh every 8 prescaler time units 100 = Refresh every 16 prescaler time units 011 = Refresh every 32 prescaler time units 010 = Refresh every 64 prescaler time units 001 = Refresh every 128 prescaler time units 000 = Refresh every 256 prescaler time units
10..8	Mem3Hold	Bus hold time for address space MEM3 111 = 7 clock cycles 110 = 6 clock cycles 101 = 5 clock cycles 100 = 4 clock cycles 011 = 3 clock cycles 010 = 2 clock cycles 001 = 1 clock cycle 000 = 0 clock cycles
7	Mem3Setup	Address setup time for address space MEM3 1 = 1 clock cycle 0 = 0 clock cycles
6..4	PageSizeCode	Page size code

6.3. Bus Control Register BCR (continued)

Bits	Name	Description
3	Mem2Setup	Address setup time for address space MEM2 1 = 1 clock cycle 0 = 0 clock cycles
2..0	Mem2Hold	Bus hold time for address space MEM2 111 = 7 clock cycles 110 = 6 clock cycles 101 = 5 clock cycles 100 = 4 clock cycles 011 = 3 clock cycles 010 = 2 clock cycles 001 = 1 clock cycle 000 = 0 clock cycles

Table 6.7: Bus Control Register BCR

The DRAM type used and the physical page size of the DRAM are specified by bits 6..4 in the BCR. Table 6.8 shows the encoding of BCR(6..4) and the associated column address ranges for memory areas with bus sizes of 32, 16 and 8 bits.

BCR(6..4)	Column Address Range		
	32-bit Bus Size	**16-bit Bus Size**	**8-bit Bus Size**
000	A15..A2	A15..A1	A15..A0
001	A14..A2	A14..A1	A14..A0
010	A13..A2	A13..A1	A13..A0
011	A12..A2	A12..A1	A12..A0
100	A11..A2	A11..A1	A11..A0
101	A10..A2	A10..A1	A10..A0
110	A9..A2	A9..A1	A9..A0
111	A8..A2	A8..A1	A8..A0

Table 6.8: Column Address Ranges

6.4. Memory Control Register MCR

Global register G27 is the write-only memory control register MCR. The MCR controls additional parameters for the external memory and the mapping of the entry table. All bits of the MCR are set to one on Reset except for the MEM3BusSize bits that are initialized from the BOOTW and BOOTB pads. The MCR bits must be initialized according to the hardware environment and the desired function.

Bits	Name	Description
31	MEM3ParityDisable	Parity check disable for address space MEM3 1 = disabled 0 = enabled
30	MEM2ParityDisable	Parity check disable for address space MEM2 1 = disabled 0 = enabled
29	MEM1ParityDisable	Parity check disable for address space MEM1 1 = disabled 0 = enabled
28	MEM0ParityDisable	Parity check disable for address space MEM0 1 = disabled 0 = enabled
27		reserved
26	MEM2WaitDisable	Wait signal disable for address space MEM2 1 = disabled 0 = enabled
25..24		reserved
23	MEM2ByteMode	Byte write access mode for address space MEM2 1 = WE0# .. WE3# act as byte write strobe 0 = WE0# .. WE3# act as byte enable signal
MEM0 = Non-DRAM (MCR(21) = 1):		
22		reserved
MEM0 = DRAM (MCR(21) = 0):		
22	DRAMType2	1 = Mem0 DRAM type is according to MCR(15) 0 = Mem0 DRAM type is SDRAM
21	MEM0MemoryType	1 = Non-DRAM 0 = DRAM
20		reserved
19	MEM1ByteMode	Byte write access mode for address space MEM1 1 = WE0# .. WE3# act as byte write strobe 0 = WE0# .. WE3# act as byte enable signal
18..16		reserved

6.4. Memory Control Register MCR (continued)

Bits	Name	Description
MEM0 = Non-DRAM (MCR(21) = 1):		
15	MEM0ByteMode	Byte write access mode for address space MEM0 1 = WE0# .. WE3# act as byte write strobe 0 = WE0# .. WE3# act as byte enable signal
MEM0 = DRAM (MCR(21) = 0):		
15	DRAMType	1 = Fast Page Mode DRAMs 0 = EDO DRAMs
14..12	EntryTableMap	111 = MEM3 110 = reserved 101 = reserved 100 = reserved 011 = Internal RAM (IRAM) 010 = MEM2 001 = MEM1 000 = MEM0
11	MEM3BusHoldBreak	1 = Break Disabled 0 = Break Enabled
10	MEM2BusHoldBreak	1 = Break Disabled 0 = Break Enabled
9	MEM1BusHoldBreak	1 = Break Disabled 0 = Break Enabled
MEM0 = Non-DRAM (MCR(21) = 1):		
8	MEM0BusHoldBreak	1 = Break Disabled 0 = Break Enabled
MEM0 = DRAM (MCR(21) = 0):		
8	DRAMBusHold	1 = Break Enabled, Bus Hold time 1 cycle 0 = Break Enabled, Bus Hold time 0 cycles

6.4. Memory Control Register MCR (continued)

Bits	Name	Description
7..6	MEM3BusSize	11 = 8 bit 10 = 16 bit 01 = reserved 00 = 32 bit
5..4	MEM2BusSize	11 = 8 bit 10 = 16 bit 01 = reserved 00 = 32 bit
3..2	MEM1BusSize	11 = 8 bit 10 = 16 bit 01 = reserved 00 = 32 bit
1..0	MEM0BusSize	11 = 8 bit 10 = 16 bit 01 = reserved 00 = 32 bit

Table 6.9: Memory Control Register MCR

6.4.1. MEMx Parity Disable

Bits 31..28 of the MCR control parity generation and parity check for each memory area. The default setting is parity check disabled. The appropriate MCR bit must be cleared to enable the parity check for that memory area.

Since the SDRAM interface uses the data parity signals as SDRAM control signals, the MEMxParityDisable bits must all be set to 1 when the SDRAM interface is used.

6.4.2. MEM2 Wait Disable

Bit 26 of the MCR controls the wait pin function for the memory area MEM2. The default setting is wait function disabled. The MCR bit must be cleared to enable the wait function for the MEM2 memory area. When this function is enabled, the INT3/WAIT input of the processor is used as wait pin. Any MEM2 memory access remains active as long as the signal at the WAIT input is asserted (the WAIT input is sampled after the first three access cycles of the memory access). The access will be terminated after the WAIT input becomes deasserted. Whether the input is low-asserted or high-asserted can be programmed via bit 26 of the Function Control Register FCR. A minimum access time of four cycles must be specified for a memory area with the wait function enabled.

If the INT3/WAIT input is used as wait pin, bit 30 of the FCR (INT3Mask) should be set to 1 so that no interrupts are generated on the assertion of WAIT.

6.4.3. MEMx Byte Mode

Bit 23, 19, and 15 of the MCR control the byte write access mode for memory areas MEM2, MEM1, and MEM0, respectively. The default setting is byte-write-strobe, meaning that the signals WE0#..WE3# are used as write strobe signals for writing the appropriate

data byte to the external memory. When the MCR bit is cleared, the signals WE0#..WE3# act as a byte enable signal and the general WE# signal must be used for writing the data to the memory.

Note: Most SRAM chips with 16-bit or 32-bit wide data interface require a single write-enable signal and dedicated enable signals for each byte. The setting MEMxByteMode = 0 is intended specifically for those types of memories.

6.4.4. DRAMType and DRAMType2

When the MEM0 memory type is set to DRAM (MCR(21) = 0), bits 15 and 22 of the MCR act as control bits for selecting the DRAM type as specified in the following table. The default setting is Fast Page Mode DRAM.

MCR(22)	MCR(15)	DRAM Type
1	1	Fast Page Mode
1	0	EDO
0	1	SDRAM
0	0	reserved

Table 6.9: DRAM Type Selection

When the DRAM type indicates Fast-Page-Mode DRAMs, the OE# signal of the processor is left deasserted during DRAM accesses. The OE# pin of the DRAMs must then be tied low for correct DRAM operation.

When the DRAM type indicates EDO DRAMs, OE# must be connected to the DRAMs and is asserted on DRAM read accesses. OE# stays active for one half clock cycle past the end of the CAS# signals, the read data is sampled at the end of OE#. Thus, the processor can take advantage of the EDO feature.

When the DRAM type indicates SDRAM, SDRAM accesses are enabled through the SDRAM Control Register SDCR. Since the SDRAM interface uses the data parity signals as SDRAM control signals, the MEMxParityDisable bits must all be set to 1 when the SDRAM interface is used.

6.4.5. Entry Table Map

Bits 14..12 of the MCR map the entry table to one of the memory areas MEM0..MEM3 or to the IRAM. With a mapping to MEM3 (default setting), the entry table is mapped to the end of MEM3, with all other settings, the entry table is mapped to the beginning of the specified memory area.

6.4.6. MEMx Bus Hold Break

Bits 11..8 specify a memory bus hold break for MEM3..MEM0 respectively. The default setting is disabled. With enabled, bus hold cycles are skipped when the next memory access addresses the same memory area. Regularly, the bus hold break should be enabled; it must only be left disabled to accommodate (rare) SRAMs or ROMs which need all specified cycles before a new access can be started (e.g. for charge restore).

If the MEM0 memory type is DRAM, MCR bit 8 changes the RasPrecharge and CASAccess cycle counts specified in BCR, and specifies a bus hold time of 0 or 1 cycles. Bus hold break for DRAM is always enabled.

6.4.7. MEMx Bus Size

Bits 7..0 specify the bus size for each of the four memory areas.

6.5. SDRAM Control Register SDCR

The SDRAM Control Register SDCR specifies the SDRAM access parameters. This register must be set before the first SDRAM access (SDRAM mode register set) is performed. All bits of this register are initialized to 1 on reset. The SDCR is set from the address bits of a Mem0 write access with address bits 29 and 28 set to 1 (see section 6.1.4 SDRAM Bus Access).

Bits	Name	Description
31..28		Must be 0011
27..21		Reserved, must be 0
20..12	BankAddrEnable	Enable bits for Bank Address bits 28..20 1 = corresponding address bit is a bank address bit 0 = corresponding address bit is not a bank address bit
11	CS1Enable	Enable for second SDRAM chip select output 1 = second SDRAM chip select CS1# is disabled 0 = second SDRAM chip select CS1# is enabled
10..8	CS1Select	Code for selection between SDRAM chip selects CS0# and CS1# 111 = address bit 28 selects between CS0# and CS1# 110 = address bit 27 selects between CS0# and CS1# … 000 = address bit 21 selects between CS0# and CS1# If the corresponding address bit is 0, CS0# is activated, if the address bit is 1, CS1# is activated.
7		Reserved, must be 1
6	CASLatency	1 = CAS Latency 2 clock cycles 0 = CAS Latency 1 clock cycle
5..4		Reserved, must be 1
3	SDCLKSelect	SDCLK Clock Rate Select 1 = SDCLK is CPU clock / 2 0 = SDCLK is CPU clock
2		Reserved, must be 0
1..0		Must be 00

6.5.1. BankAddrEnable

The BankAddrEnable parameter specifies which of the CPU address bits 28..20 are SDRAM bank address bits. For SDRAM devices with two memory banks, only one of these bits should be set. For SDRAM devices with four memory banks, two of these bits should be set. If the second SDRAM Chip Select is used, the corresponding BankAddrEnable bit must also be set.

The E1-32XS supports holding two different SDRAM banks active.

6.5.2. CS1Enable

Normally, a single SDRAM chip select signal CS0# is generated. In systems with a second (identical) bank of SDRAM devices, setting CS1Enable to 0 enables the generation of the chip select signal CS1# for this second bank of SDRAM devices. This feature is not supported on the E1-16XS, the CS1Enable bit must be set to 1 in this case.

6.5.3. CS1Select

On systems with two banks of identical SDRAM devices, the CS1Select bits specify which address bit should be used to discriminate between the chip select signals CS0# and CS1#. The bit corresponding the CS1Select address line must also be set in the BankAddrEnable field.

6.5.4. CASLatency

The CASLatency bit specifies the CAS latency of the SDRAM devices. This bit must reflect the CAS latency setting in the SDRAM Mode Register.

6.5.5. SDCLKSelect

The SDCLKSelect bit specifies the SDRAM clock signal rate. The SDCLK signal can be selected to run at the full CPU clock rate or at half the CPU clock rate. For a CPU clock of more than 40 MHz, the SDRAM clock rate must be set to half the CPU clock rate.

The CAS access time in BCR must be set according to the SDCLKSelect bit in SDCR. If SDCLK is the CPU clock, the CAS access time must be set to 1 clock cycle, if SDCLK is CPU clock / 2, the CAS access time must be set to 2 clock cycles.

The RAS precharge time and RAS-to-CAS delay time settings in BCR must be set to a multiple of two (2, 4 or 6) if SDCLK is CPU clock / 2. The RAS precharge setting controls the time for the SDRAM precharge command, the RAS-to-CAS delay setting controls the time for the SDRAM row activate command.

6.5.6. SDRAM Connection Example

One 64 Mbit SDRAM device (4 banks × 1M × 16 bits) is connected to the E1-16XS to form a 16 bit wide 8 Mbyte SDRAM memory space. Column addresses are SDRAM pins A0 to A7, row address pins are SDRAM pins A0 to A11. There are two bank address pins BA0 and BA1.

Since the memory system is 16 bit wide, the SDRAM is connected to the E1-16XS starting with E1-16XS address pin 1. There are 8 column addresses, so the page size code is 7.

The SDRAM address pins A0..A7 carry E1-16XS address bits 1..8 on a column access, and E1-16XS address bits 9..16 on a row access. SDRAM pins A8, A9, A10/AP and A11 must be connected to E1-16XS address bits 17..20. These are available on E1-16XS address pins A10 to A13. The bank address pins BA0 and BA1 are connected to E1-16XS address bits 21 and 22 on pins A14 and A15.

The data bus connects E1-16XS D0..D15 to DQ0..DQ15, LDQM connects to WE1#, and UDQM to WE0#.

The SDCR settings are thus:

BankAddrEnable	000000110	bank address bits 21, 22
CS1Enable	1	CS1# signal disabled
CS1Select	111	- unused

6.6. Input Status Register ISR

Global register G25 is the read-only input status register ISR. The ISR reflects the input levels at the pins IO1..IO3 as well as the input levels at the four interrupt pins INT1..INT4 and contains the EventFlag, the EqualFlag, the WatchdogFlag and the ClockOnFlag. Reserved bits are read as zeros.

The input levels are not affected by the polarity bits in the Function Control Register FCR, they reflect always the true signal level at the corresponding pins with a latency of 2..3 cycles, a 1 signals high level.

Bits	Name	Description
31..11		reserved
10	ClockOnFlag	Determines the source of the last reset event 1 = Last reset caused by sleep mode wakeup 0 = Last reset caused by RESET# signal or watchdog timer
9	WatchdogFlag	Determines the source of the last reset event 1 = Last reset caused by watchdog timer (IO3 timer) 0 = Last reset caused by RESET# signal or sleep mode wakeup
8	EventFlag	Set to 1 in IO3Timing Mode when IO3Level is equal to IO3Polarity Cleared to 0 by FCR(13) = 1 or write to the WCR
7	EqualFlag	Set to 1 in IO3Timing Mode or IO3TimerInterrupt Mode when WCR(15..0) = TR(15..0) Cleared to 0 by FCR(13) = 1 or write to the WCR
6	IO3Level	Reflects the signal level at the IO3 Pin 1 = High Level 0 = Low Level
5	IO2Level	Reflects the signal level at the IO2 Pin 1 = High Level 0 = Low Level
4	IO1Level	Reflects the signal level at the IO1 Pin 1 = High Level 0 = Low Level
3	INT4Level	Reflects the signal level of interrupt input INT4 1 = High Level 0 = Low Level
2	INT3Level	Reflects the signal level of interrupt input INT3 1 = High Level 0 = Low Level
1	INT2Level	Reflects the signal level of interrupt input INT2 1 = High Level 0 = Low Level
0	INT1Level	Reflects the signal level of interrupt input INT1 1 = High Level 0 = Low Level

Table 6.10: Input Status Register ISR

6.7. Function Control Register FCR

Global register G26 is the write-only function control register FCR. The FCR controls the polarity and function of the I/O pins IO1..IO3 and the interrupt pins INT1..INT4, the timer interrupt mask and priority, the bus lock, the CLKOUT pin and the Extended Overflow exception. All bits of the FCR are set to one on a Reset exception (from the RESET# pin or as a result of a watchdog overrun). They must be initialized according to the hardware environment and the desired function. The reserved bits must not be changed when the FCR is updated. The FCR is preserved on a clock-down reset in order to have the correct interrupt mask and polarity for the wakeup from clock-down.

Each of the four interrupt pins INT1..INT4 can cause a processor interrupt when the corresponding interrupt mask bit is cleared. The corresponding polarity bit determines whether the signal at the interrupt pin must be low (polarity bit = 0) or high (polarity bit = 1) to cause an interrupt. Additionally, the internal timer interrupt can be enabled or disabled separately.

Each of the I/O pins IO1..IO3 can be either used as input or interrupt signal (IOxDirection = 1) or as output (IOxDirection = 0). The CLKOUT pin of the processor can be programmed to provide a static output level of either high or low, or it can be configured to provide the processor's internal clock signal divided by a programmable factor.

Bits	Name	Description
31	INT4Mask	1 = Interrupt INT4 Disabled 0 = Interrupt INT4 Enabled
30	INT3Mask	1 = Interrupt INT3 Disabled 0 = Interrupt INT3 Enabled
29	INT2Mask	1 = Interrupt INT2 Disabled 0 = Interrupt INT2 Enabled
28	INT1Mask	1 = Interrupt INT1 Disabled 0 = Interrupt INT1 Enabled
27	INT4Polarity	1 = Non-Inverted (Interrupt on High Level) 0 = Inverted (Interrupt on Low Level)
26	INT3Polarity	1 = Non-Inverted (Interrupt on High Level) 0 = Inverted (Interrupt on Low Level)
25	INT2Polarity	1 = Non-Inverted (Interrupt on High Level) 0 = Inverted (Interrupt on Low Level)
24	INT1Polarity	1 = Non-Inverted (Interrupt on High Level) 0 = Inverted (Interrupt on Low Level)
23	TINTDisable	1 = Timer Interrupt Disabled 0 = Timer Interrupt Enabled
22	CLKOUTPolarity	1 = Inverted / High 0 = Non-Inverted / Low
21..20	TimerPriority	11 = Priority 6 (higher than Priority of INT1) 10 = Priority 8 (higher than Priority of INT2) 01 = Priority 10 (higher than Priority of INT3) 00 = Priority 12 (higher than Priority of INT4)
19..18	CLKOUTControl	CLKOUT pin control

6.7. Function Control Register FCR (continued)

Bits	Name	Description
17	BusLock	DMA Access: 1 = Non-Locked 0 = Locked out
16	EOVDisable	Extended Overflow Exception: 1 = Disabled 0 = Enabled
15..14		reserved
13..12	IO3Control	IO3 Control State: 11 = IO3Standard Mode 10 = Watchdog Mode 01 = IO3Timing Mode 00 = IO3TimerInterrupt Mode
11	CLKOUTControl2	CLKOUT pin control
10	IO3Direction	1 = Input 0 = Output
9	IO3Polarity	1 = Non-Inverted 0 = Inverted
8	IO3Mask	On Input: 1 = IO3 Interrupt Disabled 0 = IO3 Interrupt Enabled On Output: 1 = IO3 Output reflects IO3Polarity 0 = Reserved
7		reserved
6	IO2Direction	1 = Input 0 = Output
5	IO2Polarity	1 = Non-Inverted 0 = Inverted
4	IO2Mask	On Input: 1 = IO2 Interrupt Disabled 0 = IO2 Interrupt Enabled On Output: 1 = IO2 Output reflects IO2Polarity 0 = Reserved
3		reserved
2	IO1Direction	1 = Input 0 = Output
1	IO1Polarity	1 = Non-Inverted 0 = Inverted
0	IO1Mask	On Input: 1 = IO1 Interrupt Disabled 0 = IO1 Interrupt Enabled On Output: 1 = IO1 Output reflects IO1Polarity 0 = Reserved

Table 6.11: Function Control Register FCR

6.7.1. CLKOUTControl and CLKOUTControl2

The CLKOUTControl and CLKOUTControl2 fields control the function of the CLKOUT pin according to the following table:

FCR(11)	FCR(19)	FCR(18)	CLKOUT function
1	1	1	Output reflects CLKOUTPolarity
1	1	0	Processor clock
1	0	1	Processor clock / 2
1	0	0	Processor clock / 4
0	1	1	Processor clock / 6
0	1	0	Processor clock / 8
0	0	1	Processor clock / 12
0	0	0	Processor clock / 16

6.8. Watchdog Compare Register WCR

Global register G24 is the watchdog compare register WCR. Only bits 15..0 are used, bits 31..16 are reserved, they must be zero on a move to the WCR. In the present version, bits 31..16 are read as zero. The WCR is used by the IO3 control modes (see section 6.9. IO3 Control Modes).

6.9. IO3 Control Modes

Additionally to the standard use like IO1 and IO2 (see section 6.10.3. Bus Signal Description), there are special control modes in combination with the IO3 pin. These control modes are specified by FCR(13) and FCR(12).

On all IO3 control modes, the watchdog compare register WCR must be set before the control mode is specified in the FCR, otherwise the EqualFlag could be set erroneously.

The EqualFlag and the EventFlag are being cleared on all IO3 control modes by either setting FCR(13) to one or a move to the watchdog compare register WCR.

6.9.1. IO3Standard Mode

FCR(13) = 1, FCR(12) = 1 specifies IO3Standard mode.

Standard use of IO3 without any additional IO3 control functions. See section 6.10.3. for signals IO1..IO3.

6.9.2. Watchdog Mode

FCR(13) = 1, FCR(12) = 0 specifies Watchdog mode.

A Reset exception occurs when WCR(15..0) = TR(15..0). The standard use of IO3 is not affected.

6.9.3. IO3Timing Mode

FCR(13) = 0, FCR(12) = 1 specifies the IO3Timing mode.

On IO3Direction = Input:

When input signal IO3Level = IO3Polarity, the EventFlag ISR(8) is set and the current contents of the TR(15..0) is copied to the WCR. Thus, the time of the event indicated by the 16 low-order bits of the TR is captured in the WCR. When WCR(15..0) = TR(15..0) before the EventFlag is set, the EqualFlag ISR(7) is set. Either flag set causes an interrupt when the IO3 interrupt is enabled.

Note: The EventFlag and the EqualFlag can be used to distinguish between an input signal transition and a time-out. The EventFlag can be set even after the EqualFlag (but not vice versa) during the interrupt latency time; thus, when the EventFlag is set, WCR(15..0) contains always the time when the input reached the level specified by IO3Polarity. Note that the EventFlag is immediately set on entering IO3Timing mode when the input signal is already on the specified level. WCR(15..0) must be set to a value different from the value of the TR(15..0), otherwise the EqualFlag is set immediately. The maximum span for the time-out is 2^{16}-1 ticks of the TR.

IO3Direction = Output:

When WCR(15..0) = TR(15..0), the EqualFlag is set and an interrupt occurs when the IO3 interrupt is enabled. Additionally, an internal toggle latch is toggled. The IO3 output signal is high when the value of the toggle latch and IO3Polarity are not equal, otherwise low. Thus, each toggling causes a transition of the IO3 output signal. The toggle latch is cleared by setting FCR(13) to 1.

Note: This mode can be used to create an arbitrary output signal sequence by just updating the WCR. When the program switches to IO3Standard mode after the end of a signal sequence and the toggle latch remained set to 1, FCR(13) must be set to 1 and IO3Polarity be inverted coincidentally in the same move to FCR to avoid a transition of the IO3 output signal. The IO3 interrupt must also be disabled in the same move to FCR to avoid an interrupt from the output signal.

6.9.4. IO3TimerInterrupt Mode

FCR(13) = 0, FCR(12) = 0 specifies the IO3TimerInterrupt mode.

Additionally to the standard use of IO3, the condition WCR(15..0) = TR(15..0) sets the EqualFlag ISR(7) and causes an IO3 interrupt regardless of the IO3Mask in FCR(8).

Note: When the IO3 interrupt is disabled, the IO3TimerInterrupt mode can be used independently of the use of IO3 as input or output. When the IO3 interrupt is enabled, the IO3TimerInterrupt mode can be used as a time-out for the IO3 interrupt. The EqualFlag can then be used to distinguish between time-out and an IO3 interrupt.

6.10. Bus Signals

6.10.1. Bus Signals for the E1-32XS Processor

The following table is an overview of the bus signals of the *hyperstone* E1-32XS microprocessor. For a detailed description of the function of the bus signals refer to section 6.10.3. Bus Signal Description.

The signal states are defined as I = input, O = output and Z = three-state (inactive).

States	Pin count	Signal Name	Description
I	1	XTAL1/CLKIN	External Crystal, optionally Clock Input
O	1	XTAL2	External Crystal
O	1	CLKOUT	Clock Output
O/Z	26	A25..A0	Address Bus
O/I	32	D31..D0	Data Bus
O/I	4	DP0..DP3	Parity bits
O/Z	1	RAS#	DRAM RAS signal / Chip Select for MEM0
O/Z	4	CAS0#..CAS3#	DRAM CAS signal for bytes 0..3 / SDRAM Control
O/Z	1	WE#	Write Enable
O/Z	3	CS1#..CS3#	Chip Select for MEM1..MEM3
O/Z	4	WE0#..WE3#	Write Enable/Byte Enable for SRAM bytes 0..3
O/Z	1	OE#	Output Enable for SRAMs, EPROMs, EDO DRAMs
O/Z	1	IORD#	I/O Read Strobe, optionally I/O Data Strobe
O/Z	1	IOWR#	I/O Write Strobe
O	1	RQST	Bus Request Output
I	1	GRANT#	Bus Grant Input
O	1	ACT	Active as Bus Master
I	3	INT1..INT2, INT4	Interrupt Inputs
I	1	INT3/WAIT	Interrupt Input or Wait Input
O/I	3	IO1..IO3	Programmable Input / Output
I	2	BOOTW, BOOTB	Boot bus width selection inputs for MEM3
I	1	RESET#	Reset Input
	6	VCCint	Power Supply Voltage, processor core
	6	GNDint	Ground, processor core
	18	VCC	Power Supply Voltage, processor I/O
	20	GND	Ground, processor I/O

Total: 144

Table 6.12: Bus Signals for the E1-32XS Processor

6.10.2. Bus Signals for the E1-16XS Processor

The following table is an overview of the bus signals of the *hyperstone* E1-16XS microprocessor. For detailed description of the function of the bus signals refer to section 6.10.3. Bus Signal Description.

The signal states are defined as I = input, O = output and Z = three-state (inactive).

States	Pin count	Signal-Names	Description
I	1	**XTAL1/CLKIN**	External Crystal, optionally Clock Input
O	1	**XTAL2**	External Crystal
O	1	**CLKOUT**	Clock Output
O/Z	22	**A21..A0**	Address Bus
O/I	16	**D15..D0**	Data Bus
O/I	2	**DP0..DP1**	Parity bits
O/Z	1	**RAS#**	DRAM RAS signal / Chip Select for MEM0
O/Z	2	**CAS0#..CAS1#**	DRAM CAS signal for bytes 0..1 / 2..3 / SDRAM Control
O/Z	1	**WE#**	Write Enable
O/Z	3	**CS1#..CS3#**	Chip Select for MEM1..MEM3
O/Z	2	**WE0#..WE1#**	Write Enable/Byte Enable for SRAM bytes 0..1 / 2..3
O/Z	1	**OE#**	Output Enable for SRAMs, EPROMs, EDO DRAMs
O/Z	1	**IORD#**	I/O Read Strobe, optionally I/O Data Strobe
O/Z	1	**IOWR#**	I/O Write Strobe
O	1	**RQST**	Bus Request Output
I	1	**GRANT#**	Bus Grant Input
O	1	**ACT**	Active as Bus Master
I	3	**INT1..INT2, INT4**	Interrupt Inputs
I	1	**INT3/WAIT**	Interrupt Input or Wait Input
O/I	3	**IO1..IO3**	Programmable Input / Output
I	1	**BOOTB**	Boot bus width selection input for MEM3
I	1	**RESET#**	Reset Input
	6	**VCCint**	Power Supply Voltage, processor core
	6	**GNDint**	Ground, processor core
	9	**VCC**	Power Supply Voltage, processor I/O
	12	**GND**	Ground, processor I/O

   Total: 100

Table 6.13: Bus Signals for the E1-16XS Processor

6.10.3. Bus Signal Description

The following section describes the bus signals for both the *hyperstone* E1-32XS and E1-16XS microprocessor in detail.

In the following signal description, the signal states are defined as I = input, O = output and Z = three-state (inactive).

States	Names	Use
I	**XTAL1/CLKIN**	Input for quartz crystal. When the clock is generated by an external clock generator, XTAL1 is used as clock input. The clock signal is multiplied by eight and divided according to the TPR setting to generate the internal clock.
O	**XTAL2**	Output for quartz crystal. XTAL2 is not connected when an external clock generator is used.
O	**CLKOUT**	Clock signal output or programmable output. CLKOUT can be selected as a programmable output pin or as output delivering the CPU clock signal divided by factors from 1 to 16. CLKOUT can be used to supply a clock signal to peripheral devices.
O/Z	**A25..A0**	The address bits A25..A0 represent the address bus. An active high bit signals a "one". A0 is the least significant bit. With the E1-16X, only A21..A0 are connected to the address bus pins.
O/I	**D31..D0**	Data bus. The signals D31..D0 (D15..D0 with the E1-16XS) represent the bi-directional data bus; active high signals a "one". At a read access, data is transferred from the data bus to the register set or to the instruction cache only at the cycle corresponding to the last actual read access cycle, thus inhibiting garbled data from being transferred. At a write access, the data bus signals are activated during the address setup, write and bus hold cycle(s). A half-word or byte to be written is multiplexed from its right-adjusted position in a register to the addressed half-word or byte position. Thus, no external multiplexing of data signals is required. On a 32-bit wide memory area, byte addresses 0, 1, 2 and 3 correspond to D31..D24, D23..D16, D15..D8 and D7..D0 respectively. On a 16-bit wide memory area, byte address 2 and 3 in the first access and byte addresses 0 and 1 in the second access correspond to D15..D8 and D7..D0 respectively. On a 8-bit wide memory area, byte addresses 3..0 correspond to D7..D0 in succeeding accesses.

6.10.3. Bus Signal Description (continued)

States	Names	Use

O/I   **DP0..DP3**

Data Parity signals if SDRAM interface is not used. DP0..DP3 represent the bi-directional parity signals; active high indicates a "one". With the E1-32XS, DP0, DP1, DP2 and DP3 correspond to D31..D24, D23..D16, D15..D8 and D7..D0 respectively. With the E1-16XS, DP0 and DP1 correspond to D15..D8 and D7..D0 respectively.

At a write access, all data parity signals are activated during the address setup, write and bus hold cycles.

At a read access, the corresponding data parity signals are evaluated at the last read access cycle when parity checking for the addressed memory area is enabled.

Parity "odd" is used, that is, the correct parity bit is "one" when all bits of the corresponding byte are "zero".

If the SDRAM interface is used, the parity signals are not available, and the DP pins are redefined as SDRAM control signals.

DP3 (DP1 for the E1-16XS) acts as the SDRAM CKE (clock enable) signal. A pull-up resistor should be connected to this signal.

DP2 (DP0 for the E1-16XS) acts as the SDRAM Chip Select signal for SDRAM bank 0. DP1 acts as the SDRAM Chip Select signal for SDRAM bank 1 (not available for the E1-16XS).

DP0 is not used on the E1-32XS when the SDRAM interface is selected.

O/Z   **RAS#**

Row Address Strobe. Active low indicates row address strobe asserted.

RAS# is activated high and then again low when the processor accesses a new page in the DRAM address space, that is when any of the (high order) RAS address bits is different from the RAS address bits of the last DRAM access. RAS# is left low after any own DRAM access.

RAS# is activated high, low and then high by a refresh cycle.

After the bus has been regained from another bus master, the processor starts the next DRAM access as a RAS access.

At any non-RAS address cycle, RAS# is left unchanged, thus, a previously selected DRAM page is not affected.

When the SDRAM interface is used, this signal provides the SDRAM RAS signal.

When non-DRAM memory is placed in memory area MEM0, RAS# is used as the chip select signal for this memory.

6.10.3. Bus Signal Description (continued)

States	Names	Use
O/Z	**CAS0#..CAS3#**	Column Address Strobe for Fast Page or EDO DRAM. Active low indicates column address strobe asserted. CAS0#..CAS3# are only used by a DRAM for column access cycles and for "CAS before RAS" refresh.

With the E1-32XS, CAS0#..CAS3# correspond to the column address enable signals for D31..D24, D23..D16, D15..D8 and D7..D0 respectively.

With the E1-16XS, CAS0# and CAS1# correspond to the column address enable signals for D15..D8 and D7..D0 respectively.

If the SDRAM interface is used, these signals are redefined as SDRAM control signals.

CAS3# (CAS1# for the E1-16XS) provides the SDRAM clock signal.

CAS2# (CAS0# for the E1-16XS) provides the SDRAM CAS signal.

CAS0# and CAS1# are not used on the E1-32XS when the SDRAM interface is selected.

States	Names	Use
O/Z	**WE#**	Write Enable. WE# is signaled in the same cycle(s) as the address signals. Active low indicates a write access, active high indicates a read access.

WE# is intended to be used as DRAM Write Enable and as R/W# for I/O access when IORD# is specified as data strobe (see IORD#). WE# is also used as SRAM Write Enable when the WE0#..WE3# signals are used as byte enable signals.

Note: WE# can also be used to control bus transceivers when peripheral devices or slow memories must be separated from the processor data bus in order to decrease the capacitive load of the processor data bus.

States	Names	Use
O/Z	**CS1#..CS3#**	Chip Select. Chip select is signaled in the same cycle(s) as the address signals. Active low of CS1#..CS3# indicates chip select for the memory areas MEM1..MEM3 respectively.

Note: RAS# is used as chip select for a non-DRAM memory in MEM0.

States	Names	Use
O/Z	**WE0#/BE0# ..WE3#/BE3#**	SRAM Write Enable. Active low indicates write enable for the corresponding byte, active high indicates write disable.

When the byte mode for the corresponding memory area is enabled, WE0#..WE3# are used as byte enables BE0#..BE3#; low indicates enable, high indicates disable. The WE# signal is then used as write enable signal.

If the SDRAM interface is used, these signals provide the DQM signals for the SDRAM memory.

With the E1-32XS, WE0#..WE3# correspond to the enable signals for D31..D24, D23..D16, D15..D8 and D7..D0 respectively.

With the E1-16XS, WE0# and WE1# correspond to the enable signals for D15..D8 and D7..D0 respectively.

6.10.3. Bus Signal Description (continued)

States	Names	Use
O/Z	**OE#**	Output Enable for SRAM, EPROM, EDO DRAM, and SDRAM. OE# is active low on a SRAM, EPROM or DRAM (except Fast Page Mode) read access.
O/Z	**IORD#**	I/O Read Strobe, optionally I/O data strobe. The use of IORD# is specified in the I/O address. Address bit $10 = 0$ specifies I/O read strobe, address bit $10 = 1$ specifies I/O data strobe. When specified as I/O read strobe, IORD# is low on I/O read access cycles, high on all other cycles. When specified as I/O data strobe, IORD# is low on any I/O access cycles, high on all other cycles. Note: When IORD# is specified as I/O data strobe, WE# can be used as R/W# signal.
O/Z	**IOWR#**	I/O Write Strobe. When specified as I/O write strobe by I/O address bit $10 = 0$, IOWR# is active low on I/O write access cycles.
O	**RQST**	RQST signals the bus request for a memory or I/O access. RQST is high from the beginning of the request until the requested access is completed.
I	**GRANT#**	Bus Grant. GRANT# is signaled low by an (off-chip) bus arbiter to grant access to the bus for memory and I/O cycles. When GRANT# is switched from low to high during an access, the bus is only released to another bus master after completion of the current access. The GRANT# signal supplied by a bus arbiter may be asynchronous to the clock; it is synchronized on-chip to avoid metastability. For systems with a single bus master, GRANT# must be tied low. Note: GRANT# is recommended to be kept low by the bus arbiter on the bus master with the last access; thus, any subsequent access by the same bus master saves the synchronization time.
O	**ACT**	Active as bus master. ACT is signaled high when GRANT# is low and it is kept high during a current bus access. Since GRANT# is asynchronous, ACT follows GRANT# with a delay of 2..3 cycles. ACT is also kept high on a bus lock (FCR(17) $= 0$) from the beginning of the first access after FCR(17) is cleared to zero until the bus lock is released by setting FCR(17) to one. Note: When ACT transits from high to low, the address and data bus are switched to threestate (inactive). All bus control signals marked O/Z are driven high and then switched to threestate. These signals are kept high by an on-chip resistor (ca. 1 MΩ) tied on-chip to Vcc.

6.10.3. Bus Signal Description (continued)

States	Names	Use

States Names   Use

I   **INT1..INT4**   Interrupt Request. A signal of a specified level on any of the INT1..INT4 interrupt request pins causes an interrupt exception when the interrupt lock flag L is zero and the corresponding INTxMask bit in FCR is not set. The INTxPolarity bits in FCR specify the level of the INTx signals: INTxPolarity = 1 causes an interrupt on a high input signal level, INTxPolarity = 0 causes an interrupt on a low input signal level. INT1..INT4 may be signaled asynchronously to the clock; they are not stored internally.

A transition of INT1..INT4 is effective after a minimum of three cycles. The response time may be much higher depending on the number of cycles to the end of the current instruction or the number of cycles until the interrupt lock flag L is cleared.

The signal on the INT3 input can also be used as WAIT signal when the wait controlled memory or I/O access mode is enabled.

Note: The signal level of INT1..INT4 can be inspected in ISR(0)..ISR(3). Thus, with the corresponding INTxMask bit set, INT1..INT4 can be used just as input signals.

O/I   **IO1..IO3**   General Input-Output. IO1..IO3 can be individually configured via IOxDirection bits in the FCR as either input or output pins.

When configured as input, IO1..IO3 can be used like INT1..INT4 for additional interrupt or input signals.

When configured as output, the IOxPolarity bit in FCR specifies the output signal level. IOxPolarity = 1 specifies a high level, IOxPolarity = 0 specifies a low level. IO1..IO3 are always switched rail-to-rail regardless of the setting of MCR(25). An output signal at IO1 or IO2 cannot cause an interrupt regardless of the corresponding IOxMask bit; however, it can be inspected as IOxLevel in ISR (e.g. for testing). IO3 can be used for various control functions.

I   **RESET**#   Reset processor. RESET# low resets the processor to the initial state and halts all activity. RESET# must be low for at least one cycle. On a transition from low to high, a Reset exception occurs and the processor starts execution at the Reset entry. The transition may occur asynchronously to the clock.

I   **BOOTW, BOOTB**   Input pins for selecting the data bus width for boot memory area MEM3 (see section 6.1.1. Boot Width Selection).

I   **VCCint, GNDint** Power supply for the processor internal logic. The supply voltage is 2.5V.

I   **VCC, GND**   Power Supply for the I/O pads. The supply voltage is 3.3V. GND and GNDint must be connected.

6.11. Bus Cycles

6.11.1. MEMx Byte Mode = 1

6.11.1.1. SRAM and ROM Single-Cycle Read Access
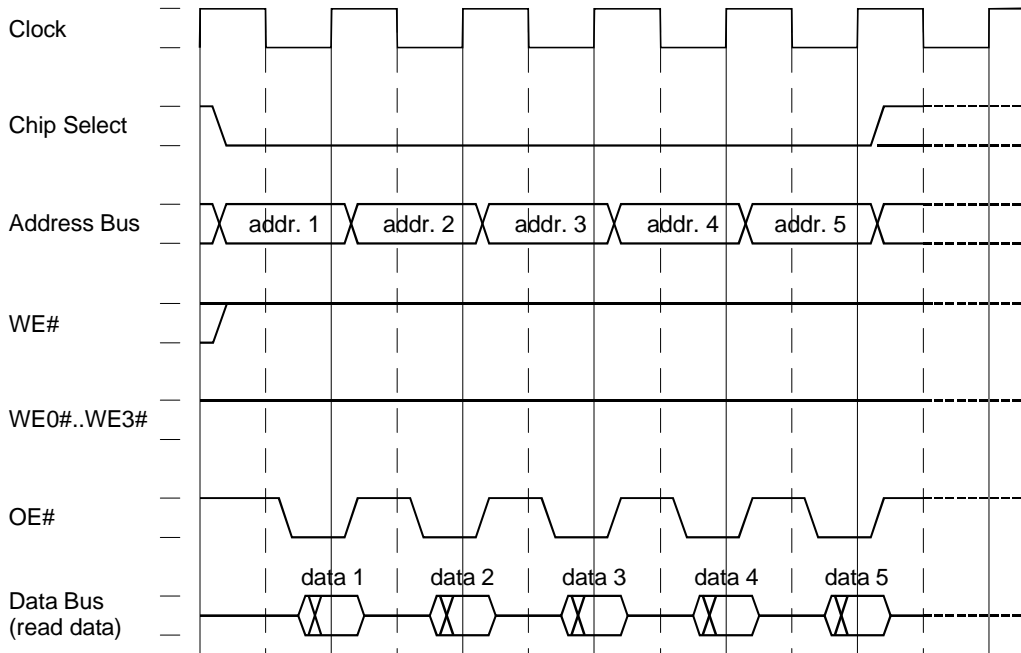
Figure 6.2: SRAM and ROM Single-Cycle Read Access, MEMx Byte Mode = 1

6.11.1.2. SRAM Single-Cycle Write Access
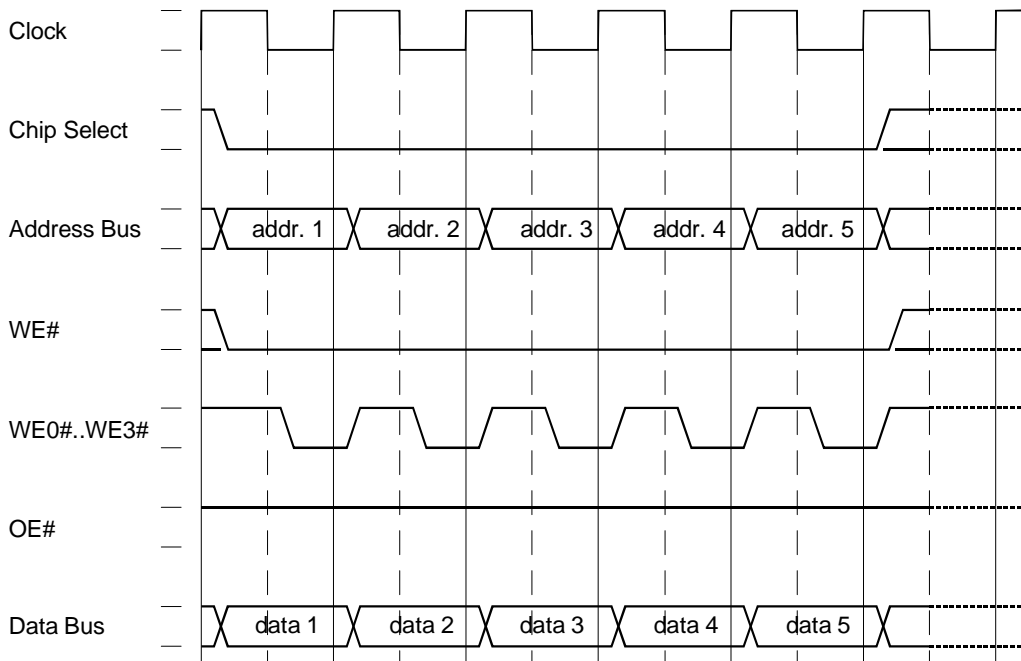
Figure 6.3: SRAM Single-Cycle Write Access, MEMx Byte Mode = 1

6.11.1.3. SRAM and ROM Multi-Cycle Read Access

Clock

Chip Select

Address Bus

WE#

WE0#..WE3#

OE#

Data Bus

Address
setup time
0..3 cycles

Access time
2..16 cycles

Bus hold
time
0..7 cycles
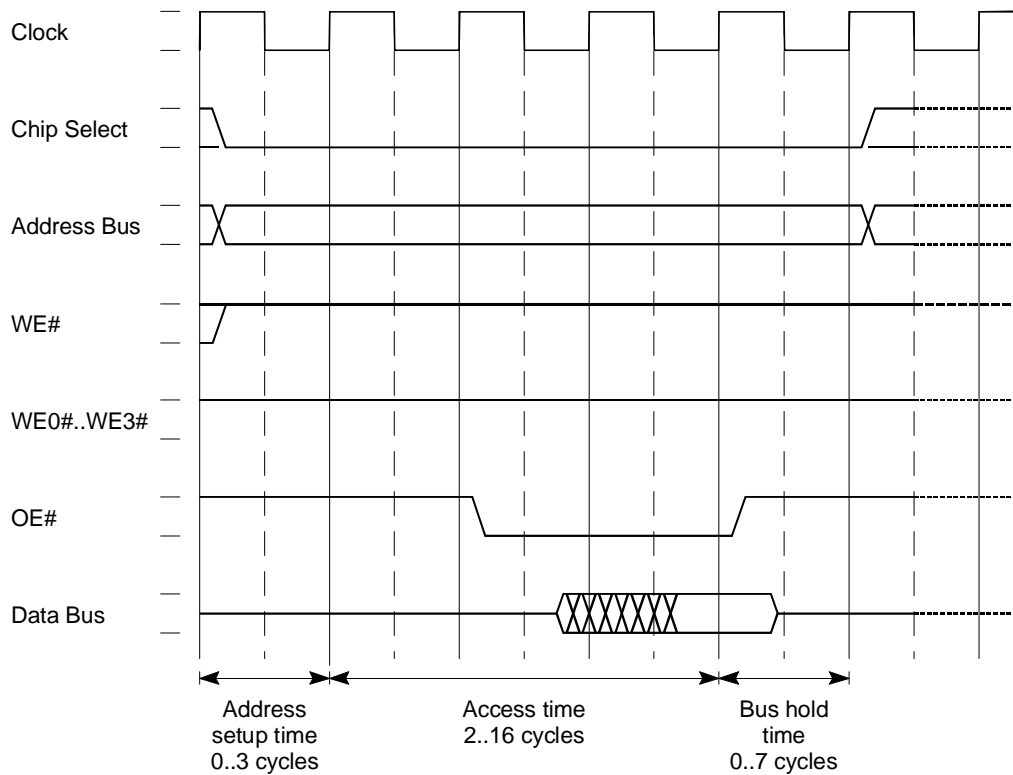
Figure 6.4: SRAM and ROM Multi-Cycle Read Access, MEMx Byte Mode = 1

6.11.1.4. SRAM Multi-Cycle Write Access

Clock

Chip Select

Address Bus

WE#

WE0#..WE3#

OE#

Data Bus

Address
setup time
0..3 cycles

Access time
2..16 cycles

Bus hold
time
0..7 cycles
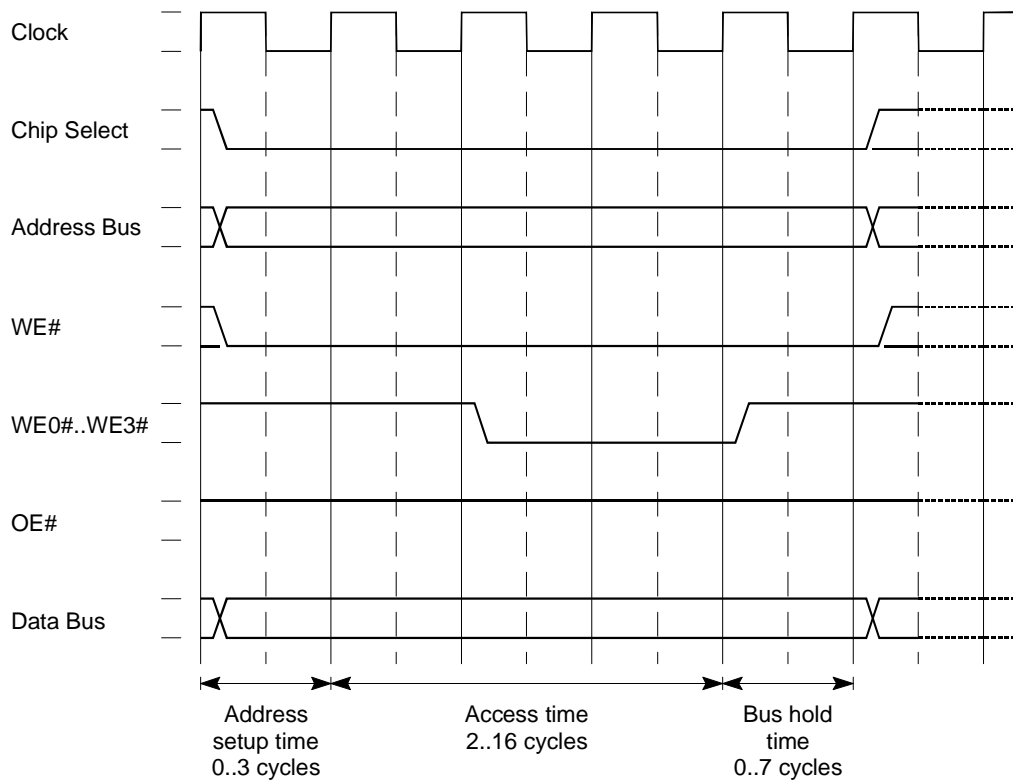
Figure 6.5: SRAM Multi-Cycle Write Access, MEMx Byte Mode = 1

6.11.2. MEMx Byte Mode = 0

6.11.2.1. SRAM Single-Cycle Read Access
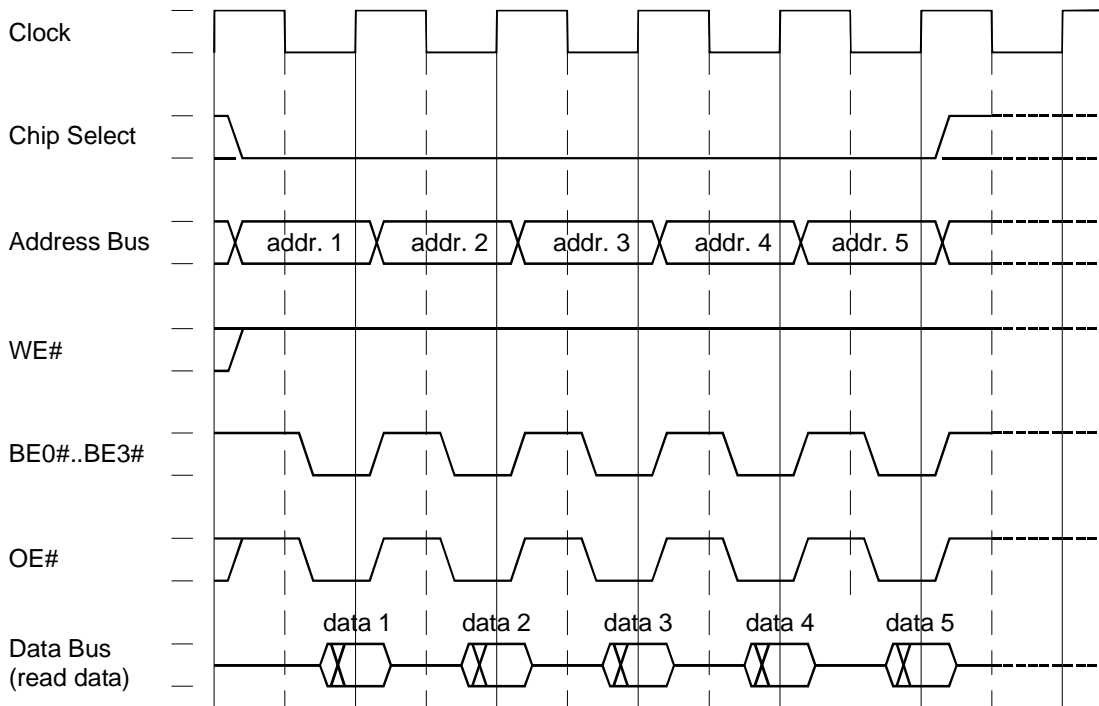
Figure 6.6: SRAM Single-Cycle Read Access, MEMx Byte Mode = 0

6.11.2.2. SRAM Single-Cycle Write Access
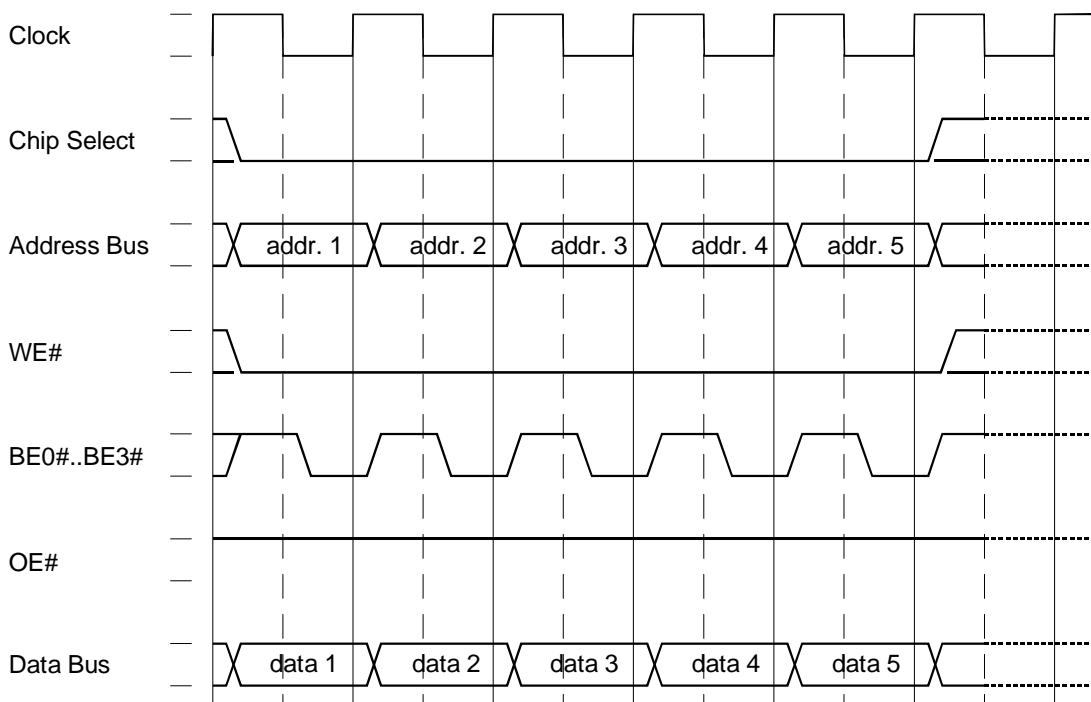
Figure 6.7: SRAM Single-Cycle Write Access, MEMx Byte Mode = 0

6.11.2.3. SRAM Multi-Cycle Read Access

Clock

Chip Select

Address Bus

WE#

BE0#..BE3#

OE#

Data Bus

Address
setup time
0..3 cycles

Access time
2..16 cycles

Bus hold
time
0..7 cycles
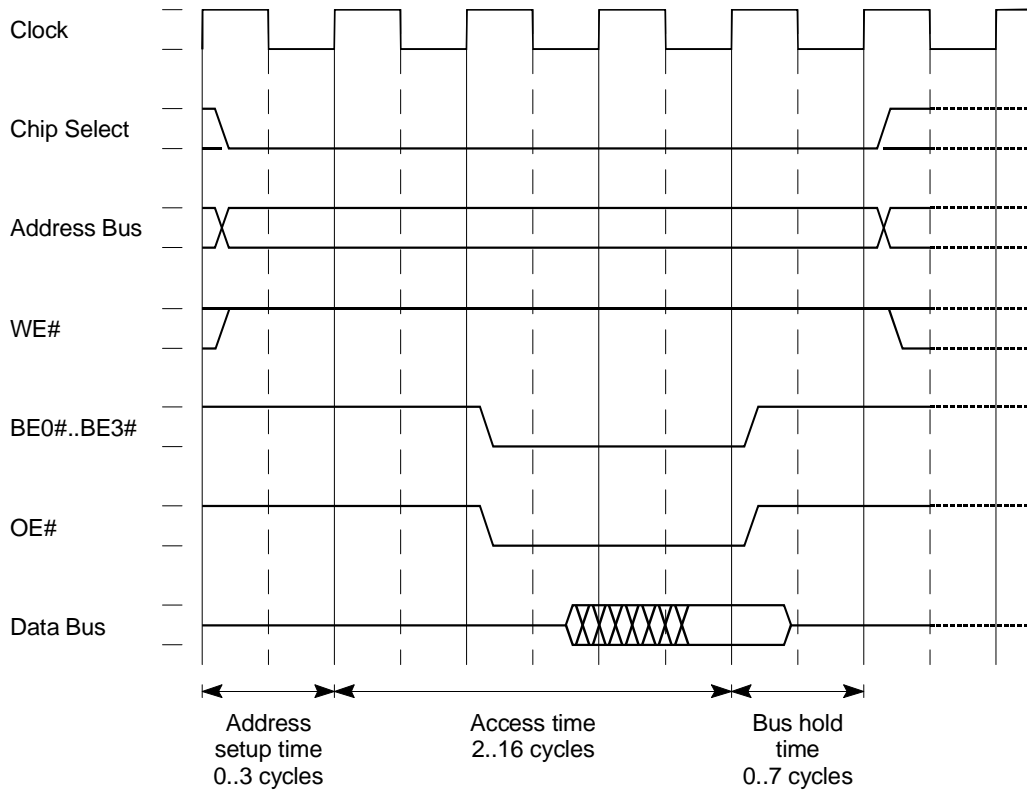
Figure 6.8: SRAM Multi-Cycle Read Access, MEMx Byte Mode = 0

6.11.2.4. SRAM Multi-Cycle Write Access

Clock

Chip Select

Address Bus

WE#

BE0#..BE3#

OE#

Data Bus

Address
setup time
0..3 cycles

Access time
2..16 cycles

Bus hold
time
0..7 cycles
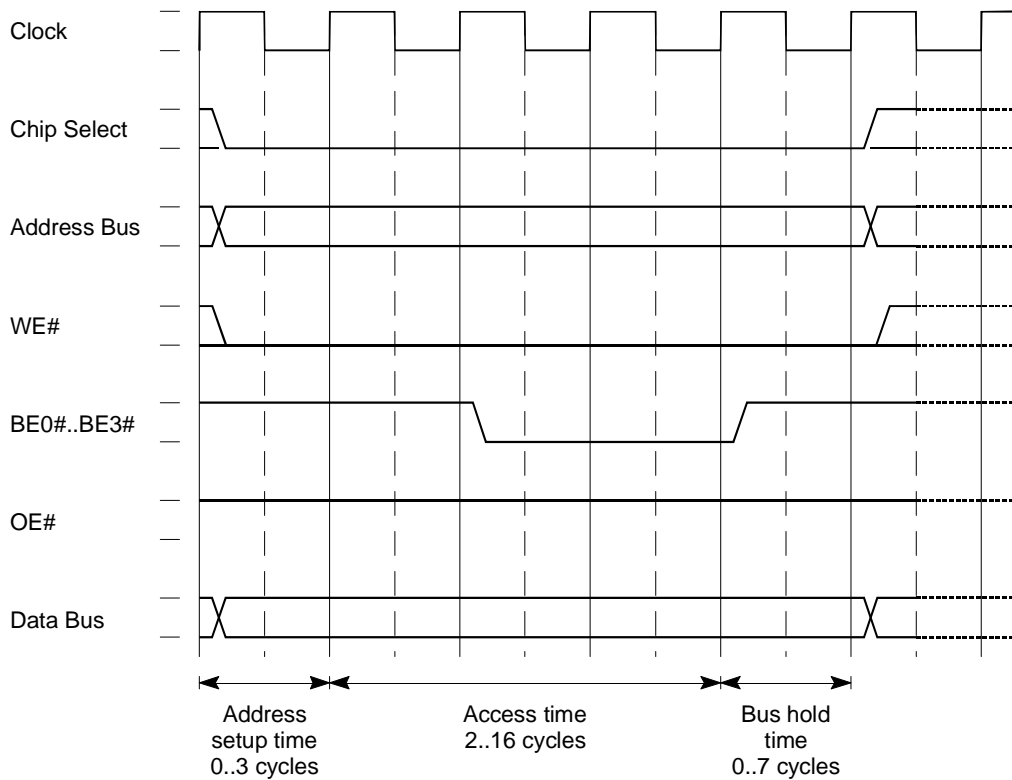
Figure 6.9: SRAM Multi-Cycle Write Access, MEMx Byte Mode = 0

6.11.3. MEM2 Read Access with WAIT Pin

MEM2 Byte Mode = 1, INT3Polarity = Inverted,
address setup time = 0 cycles, bus hold time = 0 cycles
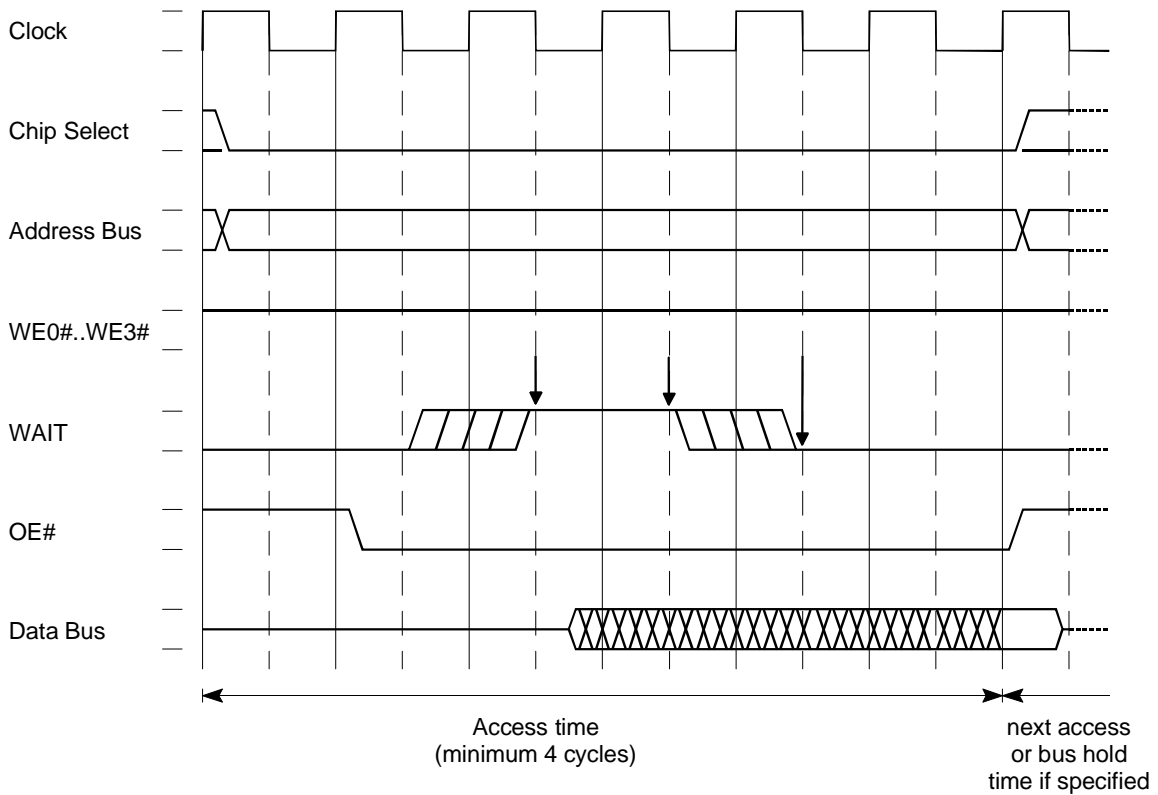
Figure 6.10: MEM2 Read Access with WAIT Pin

Note:

❏ Arrows on WAIT signal indicate the times where the signal is inspected.

❏ In this example
specified access time: 4 cycles
actual access time: 6 = 4 cycles + 2 additional cycles caused by WAIT pin

6.11.4. I/O Read Access
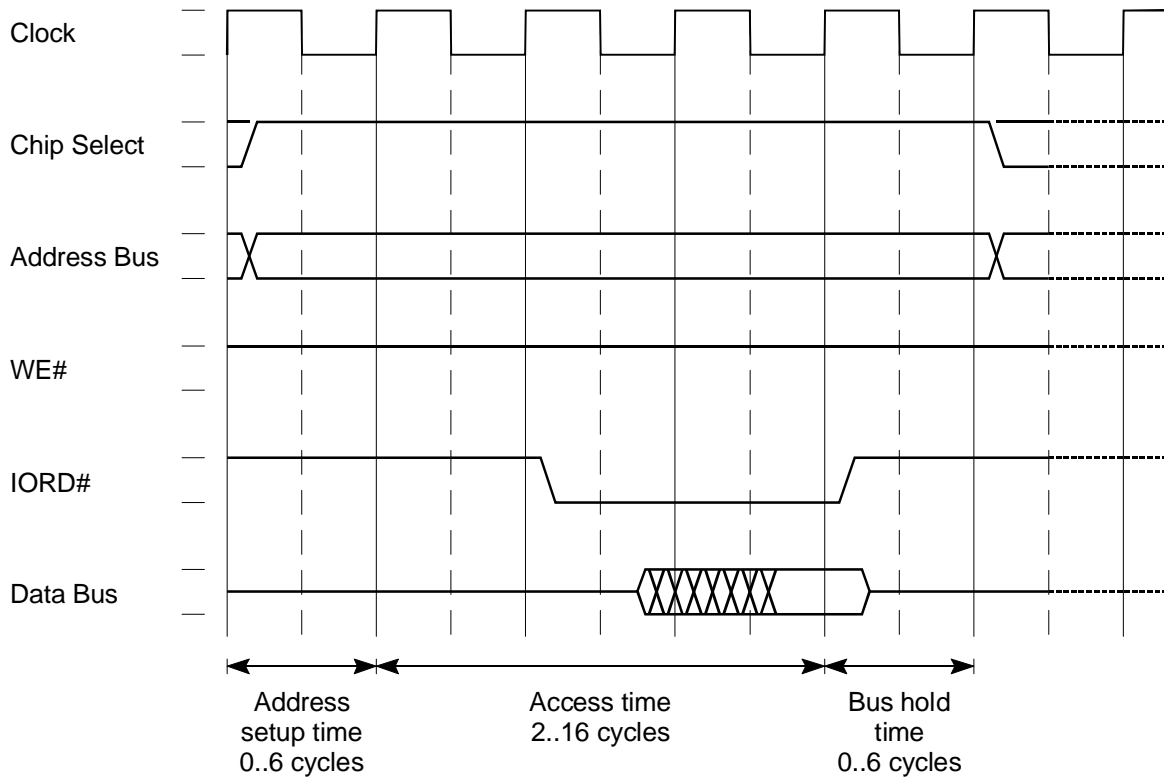
Figure 6.11: I/O Read Access

6.11.5. I/O Read Access with WAIT Pin

address setup time = 0 cycles, bus hold time = 0 cycles, INT3Polarity = Inverted
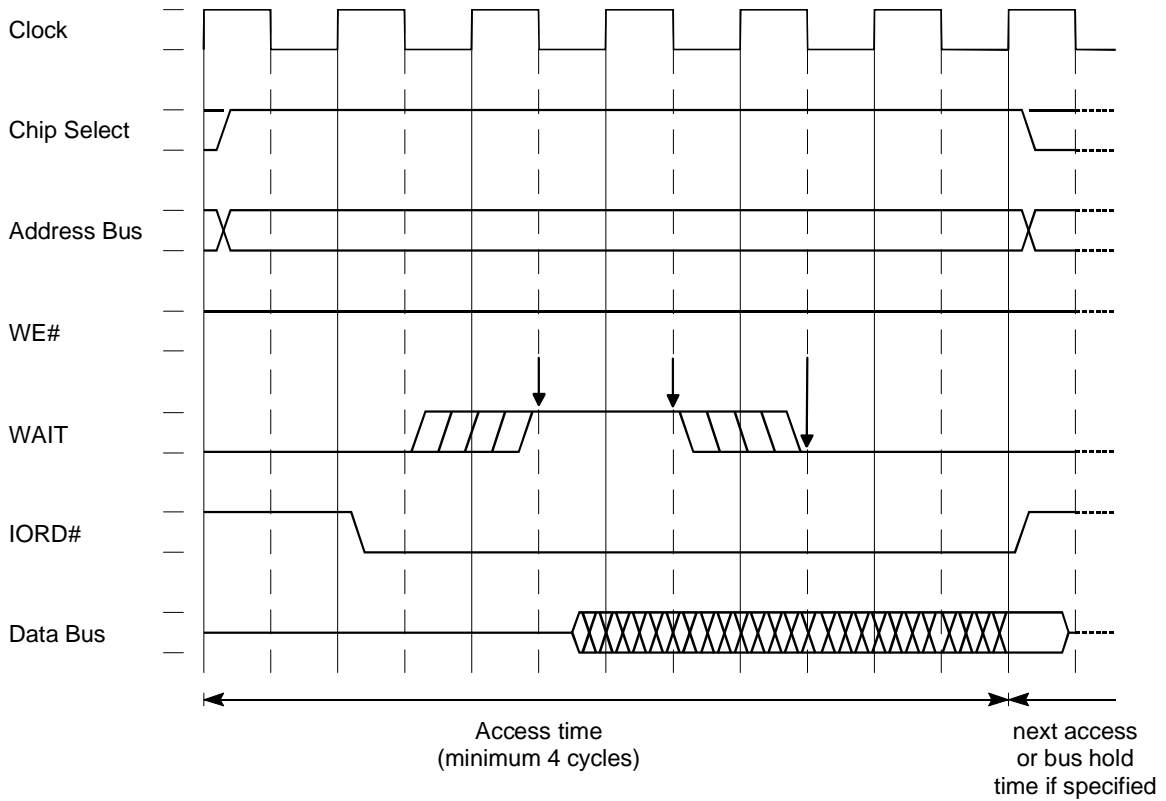
Figure 6.12: I/O Read Access with WAIT Pin

Note:

❏ Arrows on WAIT signal indicate the times where the signal is inspected.

❏ In this example
specified access time: 4 cycles
actual access time: $6 = 4$ cycles $+ 2$ additional cycles caused by WAIT pin

6.11.6. I/O Write Access
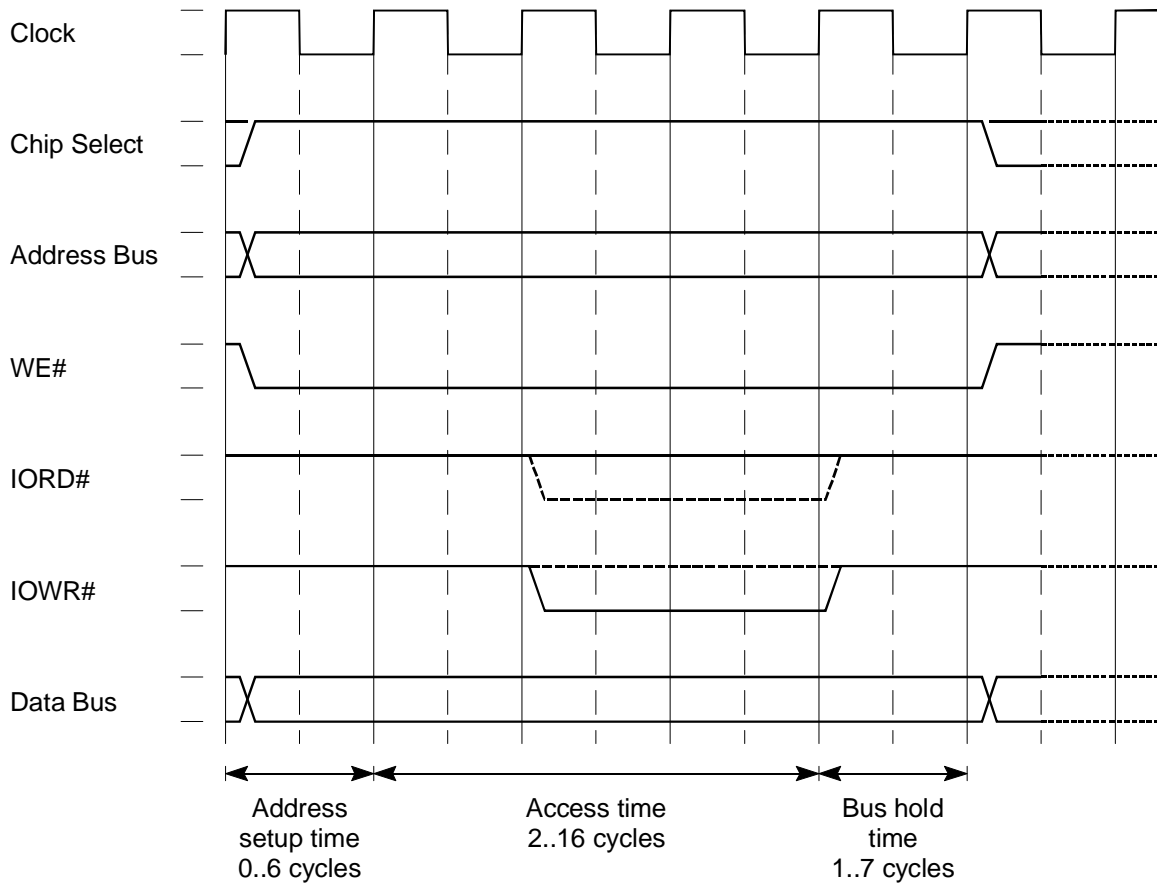
Figure 6.13: I/O Write Access

Note:

❒ If IORD# is used as I/O data strobe, IORD# instead of IOWR# is activated low.

6.11.7. DRAM

6.11.7.1. Fast Page Mode DRAM Access

Clock

Address Bus
high order bits — valid

Address Bus
low order bits — undefined | row address | col. addr. | col. addr.

RAS#

CAS0#..CAS3#

RAS precharge time	RAS to CAS delay time	CAS access	CAS access
1..6 cycles	1..4 cycles	time	time
		1..6 cycles	1..6 cycles

at read access

WE#

OE#

Data Bus
(read data)

at write access

WE#

OE#

Data Bus
(write data)
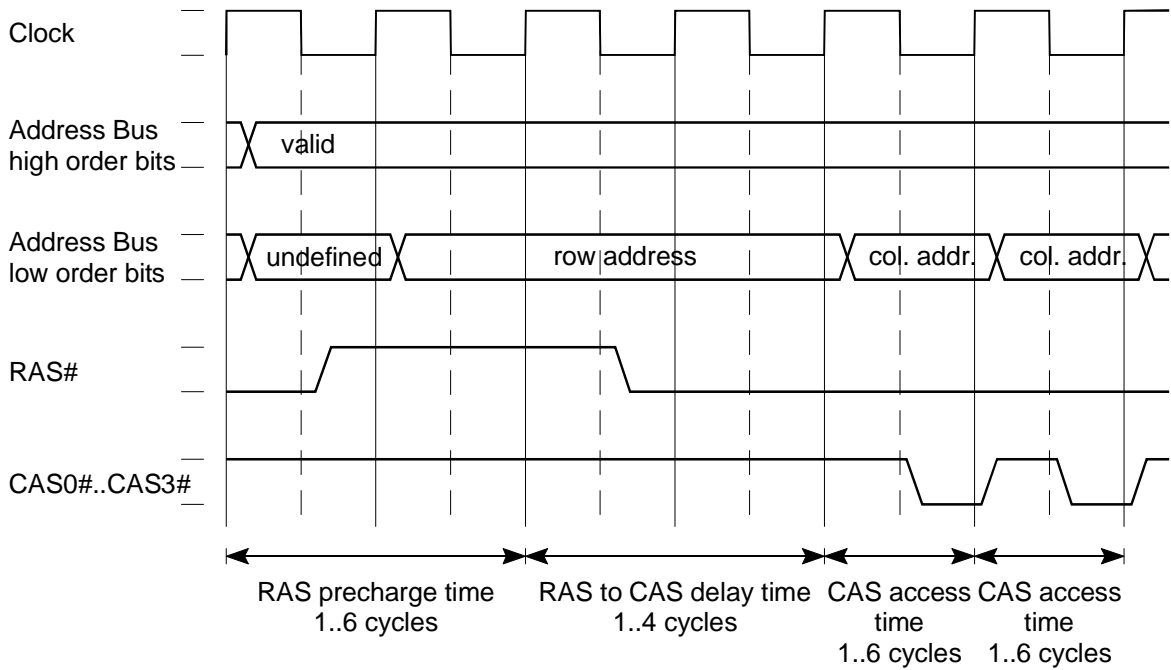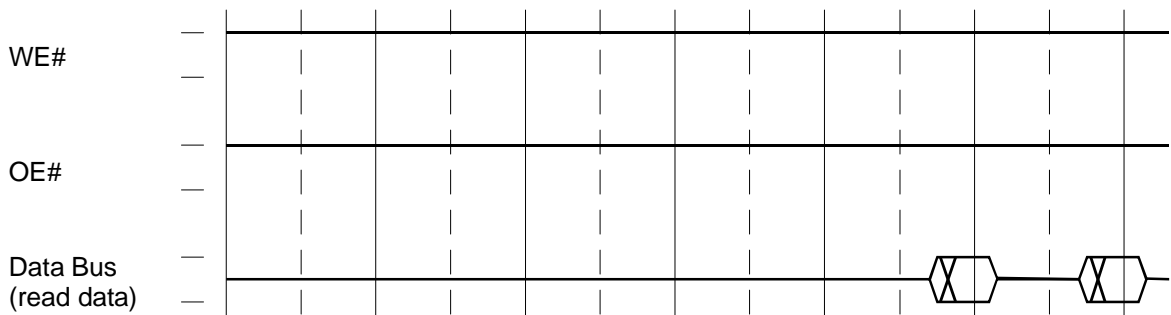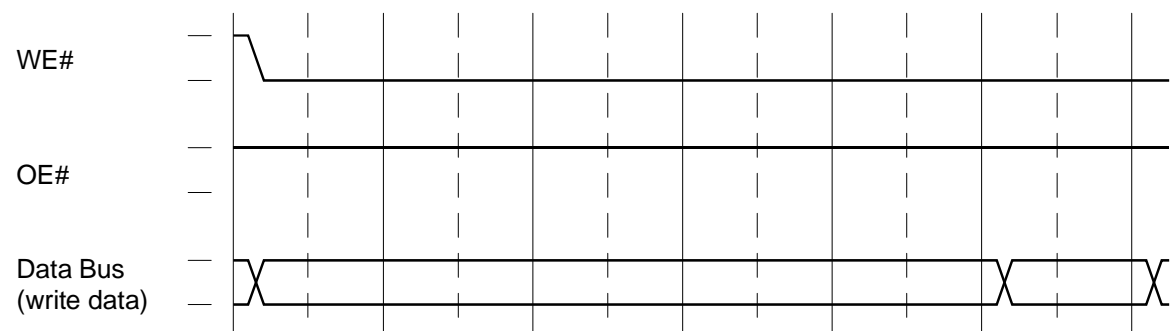
Figure 6.14: Fast Page Mode DRAM Access

6.11.7.2. EDO DRAM Single-Cycle Access

Clock

Address Bus
high order bits — valid

Address Bus
low order bits — undefined row address col. addr. col. addr.

RAS#

CAS0#..CAS3#

RAS precharge time
1..6 cycles RAS to CAS delay time
1..4 cycles CAS access
time
1..6 cycles CAS access
time
1..6 cycles

at read access

WE#

OE#

Data Bus
(read data)

at write access

WE#

OE#

Data Bus
(write data)
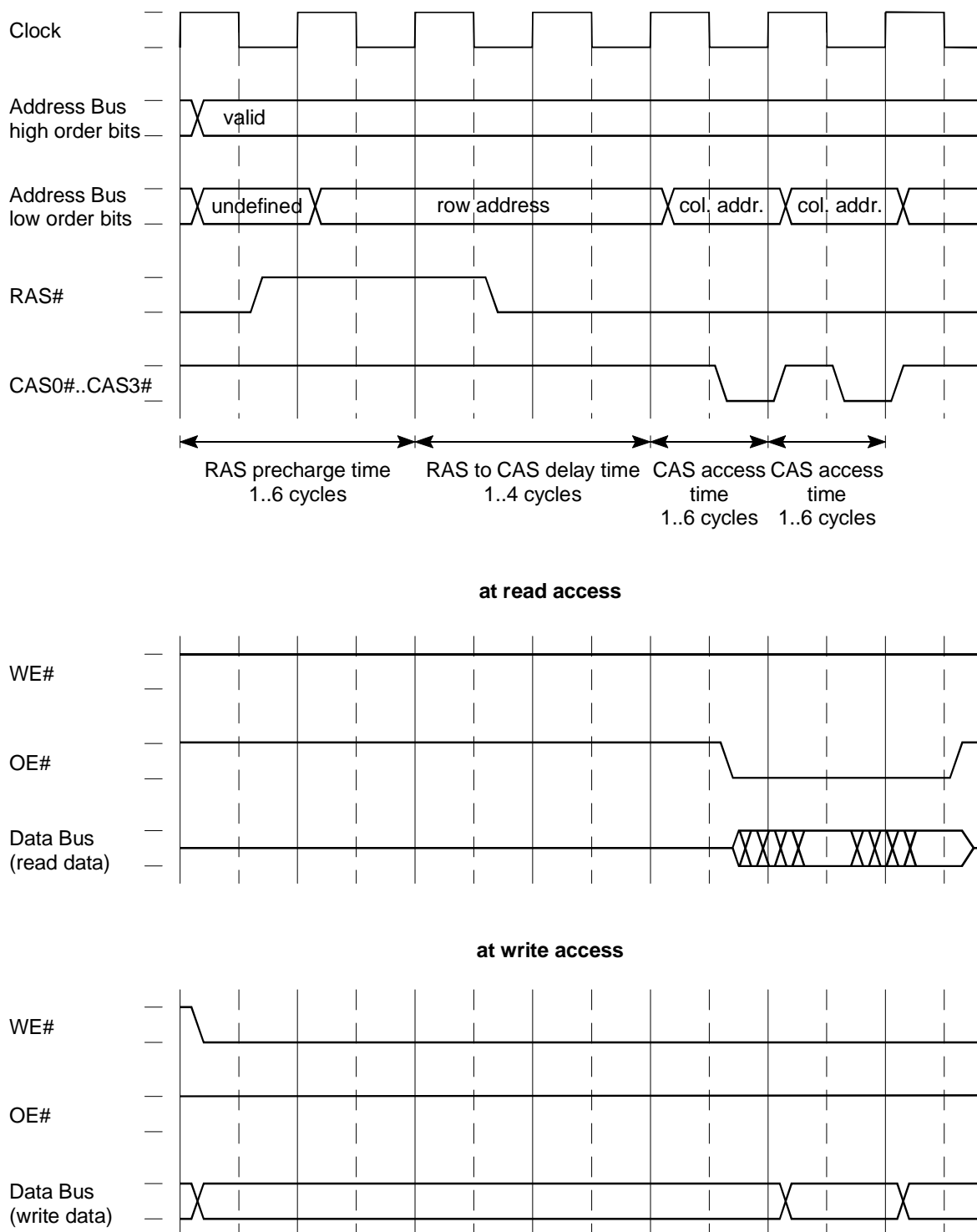
Figure 6.15: EDO DRAM Single-Cycle Access

6.11.7.3. EDO DRAM Multi-Cycle Access

Clock

Address Bus
high order bits — valid

Address Bus
low order bits — undefined | row addr. | column address | column address

RAS#

CAS0#..CAS3#

|← RAS precharge time 1..6 cycles →|← RAS to CAS delay time 1..4 cycles →|← CAS access time 1..6 cycles →|← CAS access time 1..6 cycles →|

at read access

WE#

OE#

Data Bus
(read data)
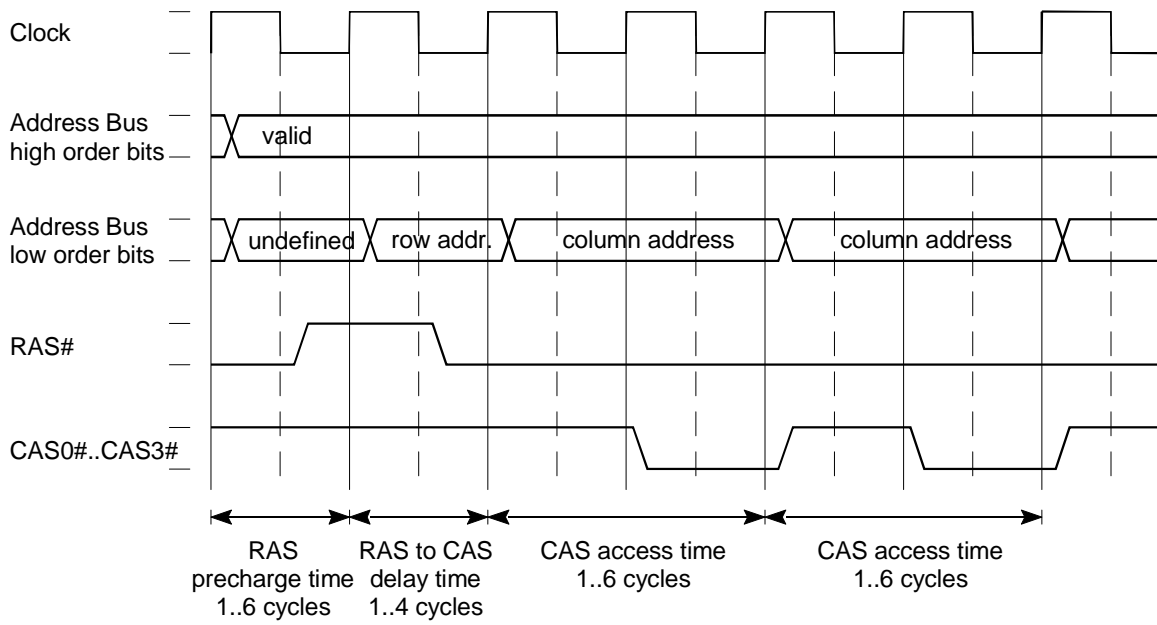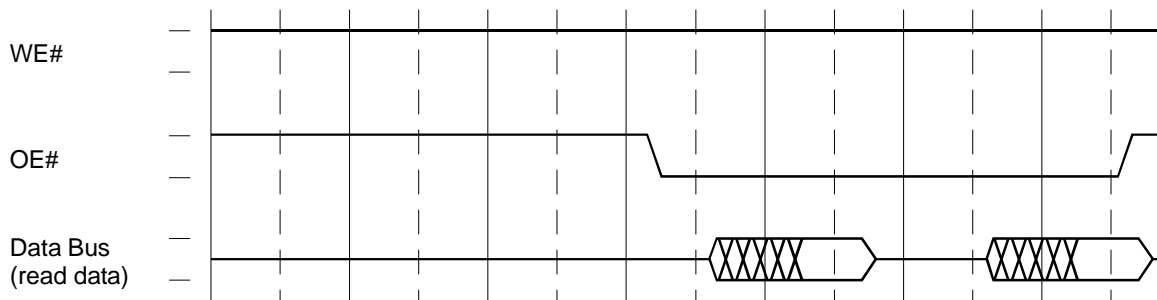
OE# is set after the first cycle of the CAS access time

at write access

WE#

OE#

Data Bus
(write data)
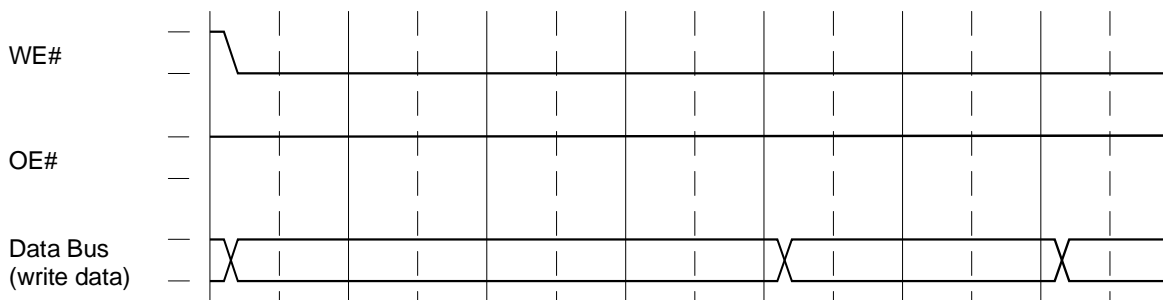
Figure 6.16: EDO DRAM Multi-Cycle Access

6.11.7.4. Fast Page Mode or EDO DRAM Refresh
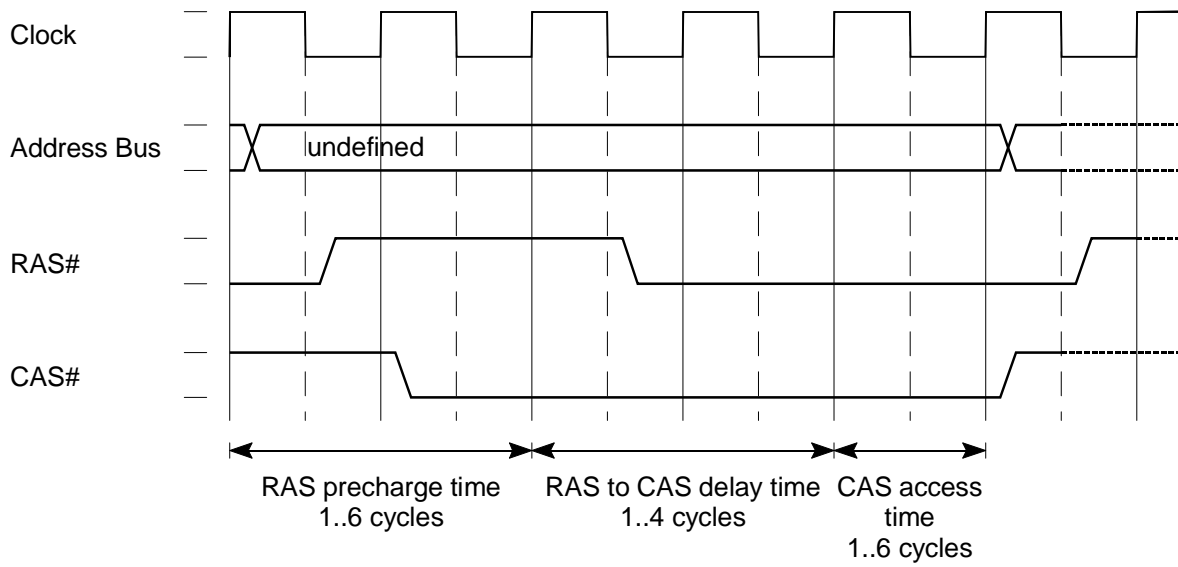
Figure 6.17: DRAM Refresh

Note:

❐ The type of refresh that is performed is CAS Before RAS.

6.11.7.5. SDRAM Access
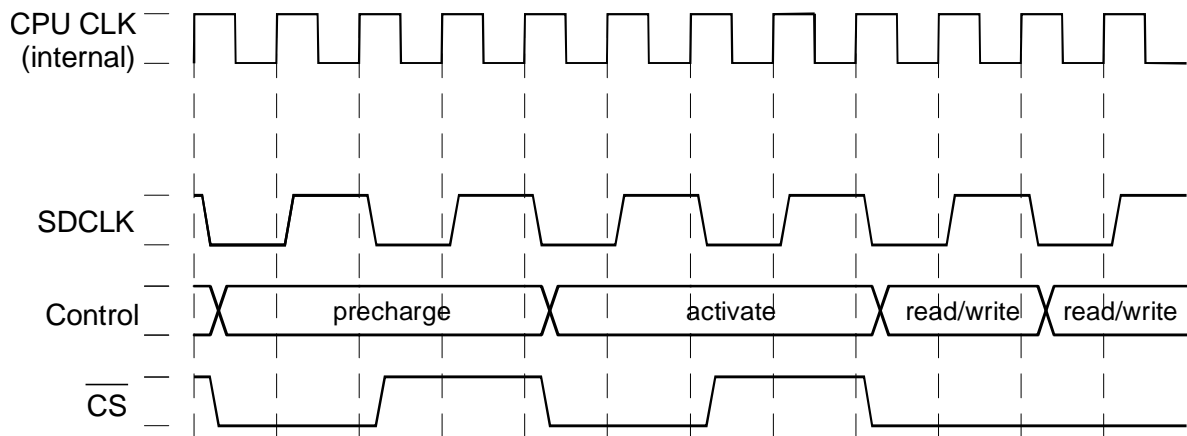
Figure 6.18: SDRAM Command Execution

Note:

❐ SDRAM executes precharge, activate, and then read/write commands

❐ In this example
BCR: RAS precharge 4 cycles, RAS-to-CAS delay 4 cycles, CAS access 2 cycles
SDCR: SDCLKSelect = 1

6.12. DC Characteristics

Absolute Maximum Ratings

Case temperature T_C under Bias: $0°C$ to $+85°C$
extended temperature range on request

Storage Temperature: $-65°C$ to $+150°C$

Voltage on any Pin with respect to ground: $-0.5V$ to $+3.8V$

D.C. Parameters

Supply Voltage Core: $2.5V \pm 5\%$

Supply Voltage I/O: $3.3V \pm 10\%$

Case Temperature T_{CASE}: $0°C$ to $+70°C$

Symbol	Parameter	Min	Max	Units	Notes
V_{IL}	Input LOW Voltage	-0.3	0.8	V	except CLKIN
V_{IH}	Input HIGH Voltage	2.0	3.6	V	except CLKIN
V_{OL}	Output LOW Voltage		0.45	V	at 4mA
V_{OH}	Output HIGH Voltage	2.4		V	at 1mA
I_{LI}	Input Leakage Current		±20	µA	
I_{LO}	Output Leakage Current		±20	µA	
C_{CLK}	Clock Capacitance		10	pF	
C_{ADR}	Output Capacitance A12..A0		15	pF	
$C_{I/O}$	Input/output Capacitance all other signals		10	pF	

Table 6.14: DC Characteristics

6.13. AC Characteristics

6.13.1. Processor Clock and CLKIN

The maximum internal processor clock frequency of the *hyperstone* E1-32XS and E1-16XS is 115 MHz.

The internal PLL of the *hyperstone* E1-32XS and E1-16XS multiplies the clock at the input pin CLKIN by ½, 1, 2, 4 or 8. Please be aware that the internal PLL can not operate with a crystal or a crystal oscillator of a frequency higher than 20 MHz.
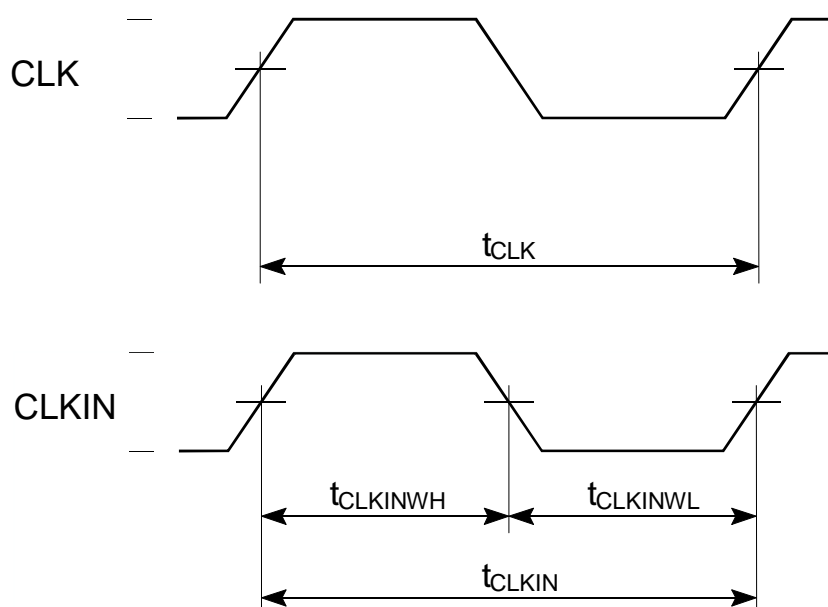
Figure 6.19: Internal Processor Clock CLK and CLKIN

Symbol	Description	Min Time (ns)	Max Time (ns)	Min Freq. (MHz)	Max Freq. (MHz)
t_{CLK}	CLK period	8.7	1000	1	115
t_{CLKIN}	CLKIN period	50	1000	1	25
$t_{CLKINWH}$	CLKIN high time	16	-		
$t_{CLKINWL}$	CLKIN low time	16	-		

Table 6.15: CLKIN Times

Note: CLKIN timing is referenced to 1.65V.

6.13.2. GRANT# response time

If a GRANT# low to high transition is detected while the processor is in power-down mode with SDRAM connected, the release of the processor bus may be delayed until the next SDRAM refresh cycle is scheduled (normally, every 16 µs). This only happens if the Mem0 memory type is SDRAM.

7. Mechanical Data

7.1. *hyperstone* E1-32XS, 144-Pin LQFP Package

7.1.1. Pin Configuration - View from Top Side

Figure 7.1: *hyperstone* E1-32XS, 144-Pin LQFP Package

7.1.2. Pin Cross Reference by Pin Name

Signal	Location	Signal	Location	Signal	Location	Signal	Location
A0	58	CS3#	140	DP3	80	IOWR#	141
A1	57	D0	88	GND	2	OE#	42
A2	56	D1	89	GND	11	RAS#	136
A3	55	D2	90	GND	23	RESET#	77
A4	22	D3	92	GND	33	RQST	66
A5	21	D4	93	GND	35	VCC	1
A6	20	D5	94	GND	38	VCC	19
A7	18	D6	100	GND	47	VCC	26
A8	17	D7	103	GND	59	VCC	36
A9	127	D8	104	GND	65	VCC	37
A10	126	D9	106	GND	71	VCC	43
A11	125	D10	111	GND	74	VCC	51
A12	124	D11	112	GND	83	VCC	72
A13	32	D12	113	GND	95	VCC	73
A14	28	D13	114	GND	105	VCC	75
A15	9	D14	116	GND	107	VCC	91
A16	8	D15	117	GND	110	VCC	98
A17	5	D16	52	GND	119	VCC	108
A18	4	D17	53	GND	131	VCC	109
A19	135	D18	54	GND	137	VCC	115
A20	133	D19	82	GND	143	VCC	123
A21	132	D20	84	GNDint	6	VCC	134
A22	16	D21	85	GNDint	14	VCC	144
A23	13	D22	96	GNDint	29	VCCint	7
A24	12	D23	97	GNDint	78	VCCint	15
A25	10	D24	99	GNDint	86	VCCint	30
ACT	31	D25	118	GNDint	101	VCCint	79
BOOTB	3	D26	120	GRANT#	76	VCCint	87
BOOTW	62	D27	121	INT1	70	VCCint	102
CAS0#	27	D28	122	INT2	69	WE#	34
CAS1#	46	D29	128	INT3/WAIT	68	WE0#/BE0#	24
CAS2#	45	D30	129	INT4	67	WE1#/BE1#	25
CAS3#	44	D31	130	IO1	64	WE2#/BE2#	40
CLKOUT	63	DP0	61	IO2	50	WE3#/BE3#	39
CS1#	138	DP1	60	IO3	142	XTAL1/CLKIN	48
CS2#	139	DP2	81	IORD#	41	XTAL2	49

7.1.3. Pin Cross Reference by Location

Location	Signal	Location	Signal	Location	Signal	Location	Signal
1	VCC	37	VCC	73	VCC	109	VCC
2	GND	38	GND	74	GND	110	GND
3	BOOTB	39	WE3#/BE3#	75	VCC	111	D10
4	A18	40	WE2#/BE2#	76	GRANT#	112	D11
5	A17	41	IORD#	77	RESET#	113	D12
6	GNDint	42	OE#	78	GNDint	114	D13
7	VCCint	43	VCC	79	VCCint	115	VCC
8	A16	44	CAS3#	80	DP3	116	D14
9	A15	45	CAS2#	81	DP2	117	D15
10	A25	46	CAS1#	82	D19	118	D25
11	GND	47	GND	83	GND	119	GND
12	A24	48	XTAL1/CLKIN	84	D20	120	D26
13	A23	49	XTAL2	85	D21	121	D27
14	GNDint	50	IO2	86	GNDint	122	D28
15	VCCint	51	VCC	87	VCCint	123	VCC
16	A22	52	D16	88	D0	124	A12
17	A8	53	D17	89	D1	125	A11
18	A7	54	D18	90	D2	126	A10
19	VCC	55	A3	91	VCC	127	A9
20	A6	56	A2	92	D3	128	D29
21	A5	57	A1	93	D4	129	D30
22	A4	58	A0	94	D5	130	D31
23	GND	59	GND	95	GND	131	GND
24	WE0#/BE0#	60	DP1	96	D22	132	A21
25	WE1#/BE1#	61	DP0	97	D23	133	A20
26	VCC	62	BOOTW	98	VCC	134	VCC
27	CAS0#	63	CLKOUT	99	D24	135	A19
28	A14	64	IO1	100	D6	136	RAS#
29	GNDint	65	GND	101	GNDint	137	GND
30	VCCint	66	RQST	102	VCCint	138	CS1#
31	ACT	67	INT4	103	D7	139	CS2#
32	A13	68	INT3/WAIT	104	D8	140	CS3#
33	GND	69	INT2	105	GND	141	IOWR#
34	WE#	70	INT1	106	D9	142	IO3
35	GND	71	GND	107	GND	143	GND
36	VCC	72	VCC	108	VCC	144	VCC

7.2. *hyperstone* E1-16XS, 100-Pin LQFP Package

7.2.1. Pin Configuration - View from Top Side

Top pins (left to right, 75–51): D9, GND, D8, D7, VCCint, GNDint, D6, GND, D5, D4, D3, VCC, D2, D1, D0, VCCint, GNDint, GND, DP0, DP1, VCCint, GNDint, RESET#, GRANT#, VCC

Left side (top to bottom):
D10 — 76
D11 — 77
D12 — 78
D13 — 79
VCC — 80
D14 — 81
D15 — 82
GND — 83
VCC — 84
A12 — 85
A11 — 86
A10 — 87
A9 — 88
GND — 89
A21 — 90
A20 — 91
VCC — 92
A19 — 93
RAS# — 94
GND — 95
CS1# — 96
CS2# — 97
CS3# — 98
IOWR# — 99
IO3 — 100

Center: *hyperstone* E1-16XS

Right side (top to bottom):
50 — INT1
49 — INT2
48 — INT3/WAIT
47 — INT4
46 — RQST
45 — GND
44 — IO1
43 — CLKOUT
42 — GND
41 — A0
40 — A1
39 — A2
38 — A3
37 — VCC
36 — IO2
35 — XTAL2
34 — XTAL1/CLKIN
33 — GND
32 — CAS0#
31 — CAS1#
30 — VCC
29 — OE#
28 — IORD#
27 — WE0#/BE0#
26 — WE1#/BE1#

Bottom pins (left to right, 1–25): BOOTB, A18, A17, GNDint, VCCint, A16, A15, GND, GNDint, VCCint, A8, A7, VCC, A6, A5, A4, GND, VCC, A14, GNDint, VCCint, ACT, A13, GND, WE#
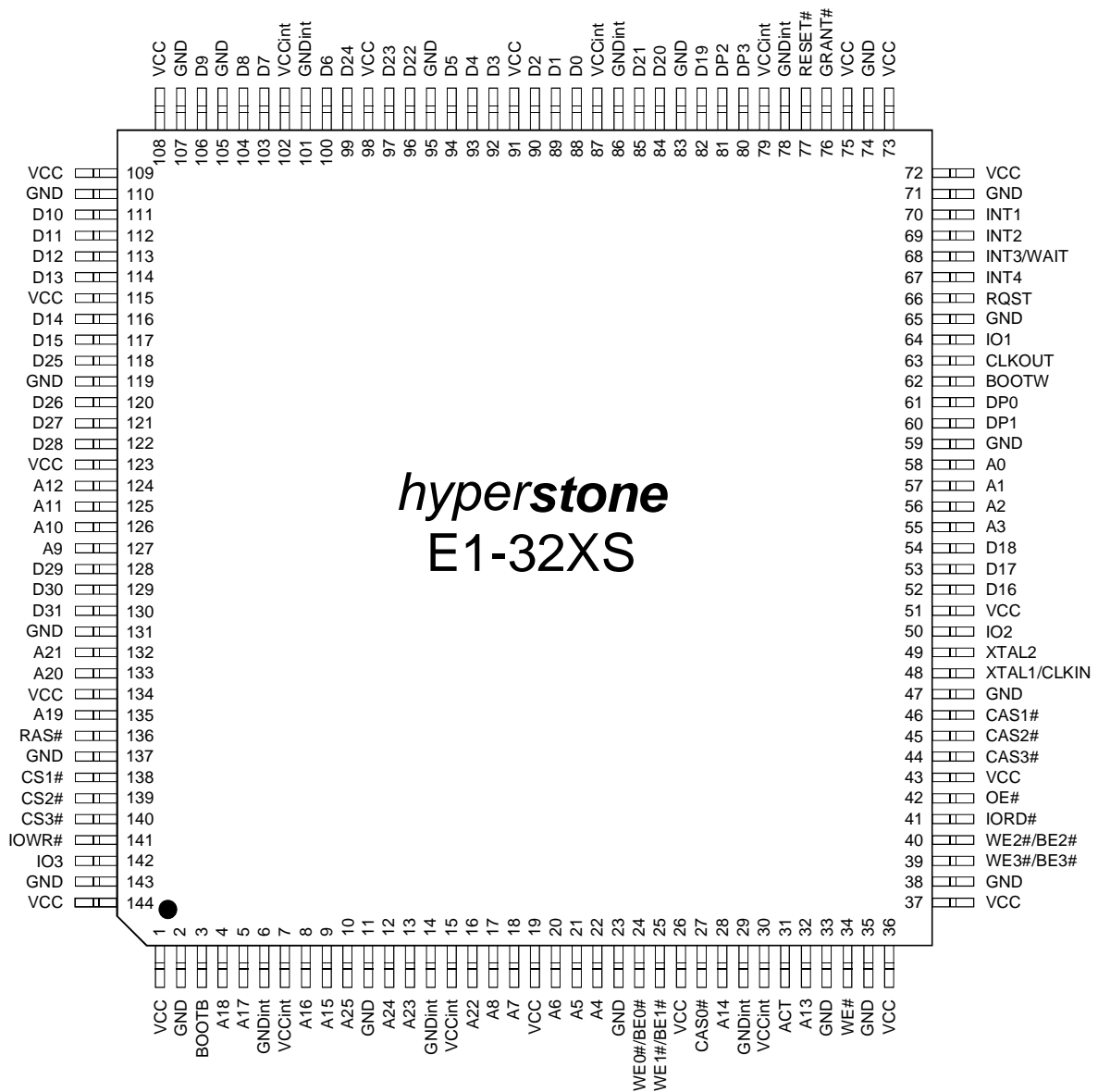
Figure 7.2: *hyperstone* E1-16XS, 100-Pin LQFP Package

7.2.2. Pin Cross Reference by Pin Name

Signal	Location	Signal	Location	Signal	Location	Signal	Location
A0	41	CAS1#	31	GND	24	IOWR#	99
A1	40	CLKOUT	43	GND	33	OE#	29
A2	39	CS1#	96	GND	42	RAS#	94
A3	38	CS2#	97	GND	45	RESET#	53
A4	16	CS3#	98	GND	58	RQST	46
A5	15	D0	61	GND	68	VCC	13
A6	14	D1	62	GND	74	VCC	18
A7	12	D2	63	GND	83	VCC	30
A8	11	D3	65	GND	89	VCC	37
A9	88	D4	66	GND	95	VCC	51
A10	87	D5	67	GNDint	4	VCC	64
A11	86	D6	69	GNDint	9	VCC	80
A12	85	D7	72	GNDint	20	VCC	84
A13	23	D8	73	GNDint	54	VCC	92
A14	19	D9	75	GNDint	59	VCCint	5
A15	7	D10	76	GNDint	70	VCCint	10
A16	6	D11	77	GRANT#	52	VCCint	21
A17	3	D12	78	INT1	50	VCCint	55
A18	2	D13	79	INT2	49	VCCint	60
A19	93	D14	81	INT3/WAIT	48	VCCint	71
A20	91	D15	82	INT4	47	WE#	25
A21	90	DP0	57	IO1	44	WE0#/BE0#	27
ACT	22	DP1	56	IO2	36	WE1#/BE1#	26
BOOTB	1	GND	8	IO3	100	XTAL1/CLKIN	34
CAS0#	32	GND	17	IORD#	28	XTAL2	35

7.2.3. Pin Cross Reference by Location

Signal	Location	Signal	Location	Signal	Location	Signal	Location
1	BOOTB	26	WE1#/BE1#	51	VCC	76	D10
2	A18	27	WE0#/BE0#	52	GRANT#	77	D11
3	A17	28	IORD#	53	RESET#	78	D12
4	GNDint	29	OE#	54	GNDint	79	D13
5	VCCint	30	VCC	55	VCCint	80	VCC
6	A16	31	CAS1#	56	DP1	81	D14
7	A15	32	CAS0#	57	DP0	82	D15
8	GND	33	GND	58	GND	83	GND
9	GNDint	34	XTAL1/CLKIN	59	GNDint	84	VCC
10	VCCint	35	XTAL2	60	VCCint	85	A12
11	A8	36	IO2	61	D0	86	A11
12	A7	37	VCC	62	D1	87	A10
13	VCC	38	A3	63	D2	88	A9
14	A6	39	A2	64	VCC	89	GND
15	A5	40	A1	65	D3	90	A21
16	A4	41	A0	66	D4	91	A20
17	GND	42	GND	67	D5	92	VCC
18	VCC	43	CLKOUT	68	GND	93	A19
19	A14	44	IO1	69	D6	94	RAS#
20	GNDint	45	GND	70	GNDint	95	GND
21	VCCint	46	RQST	71	VCCint	96	CS1#
22	ACT	47	INT4	72	D7	97	CS2#
23	A13	48	INT3/WAIT	73	D8	98	CS3#
24	GND	49	INT2	74	GND	99	IOWR#
25	WE#	50	INT1	75	D9	100	IO3

7.3. *hyperstone* E1-16XSB, 100-Pin TFBGA Package

7.3.1. Pin Configuration – View from Top Side

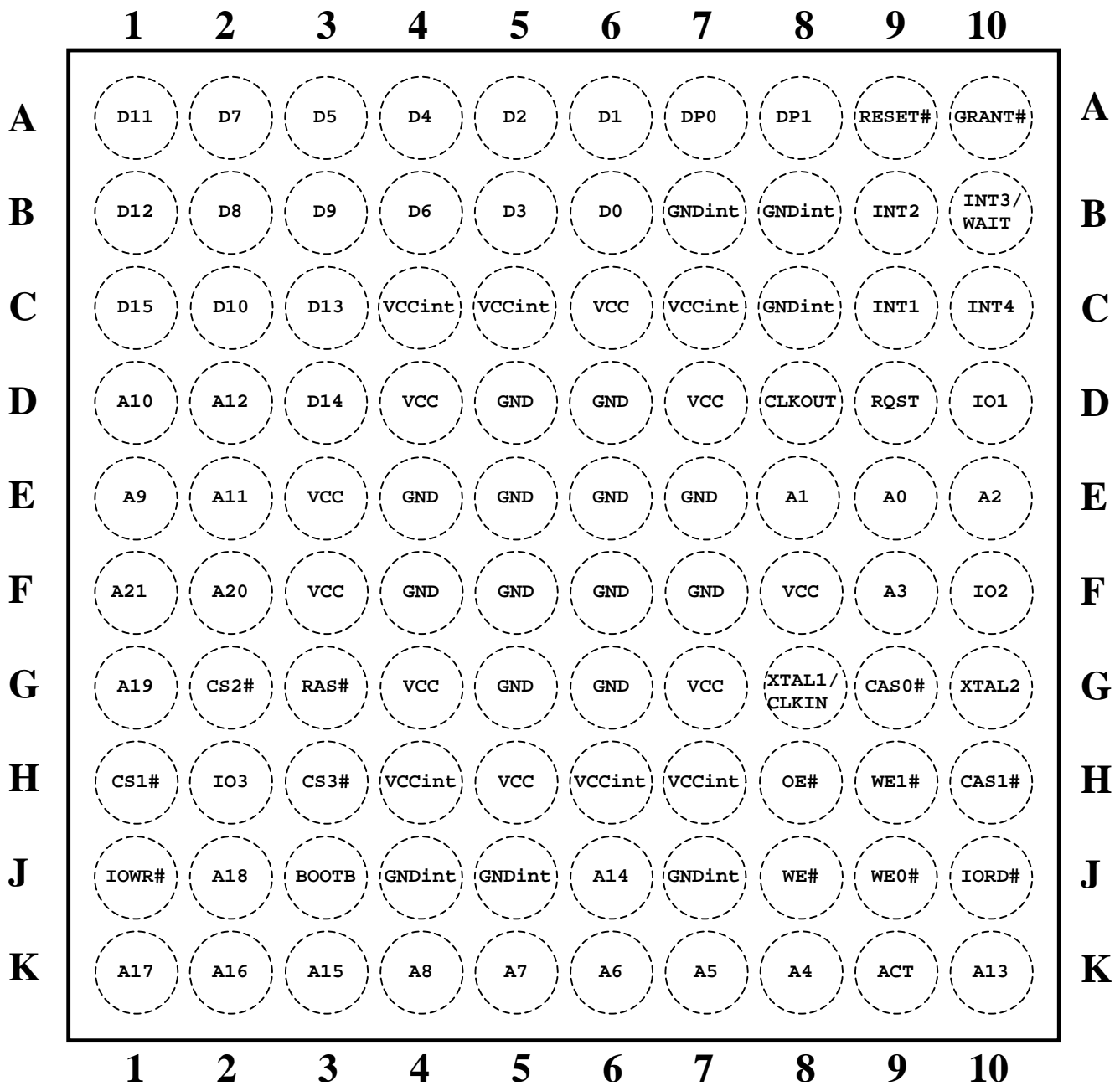|	1	2	3	4	5	6	7	8	9	10
A	D11	D7	D5	D4	D2	D1	DP0	DP1	RESET#	GRANT#
B	D12	D8	D9	D6	D3	D0	GNDint	GNDint	INT2	INT3/WAIT
C	D15	D10	D13	VCCint	VCCint	VCC	VCCint	GNDint	INT1	INT4
D	A10	A12	D14	VCC	GND	GND	VCC	CLKOUT	RQST	IO1
E	A9	A11	VCC	GND	GND	GND	GND	A1	A0	A2
F	A21	A20	VCC	GND	GND	GND	GND	VCC	A3	IO2
G	A19	CS2#	RAS#	VCC	GND	GND	VCC	XTAL1/CLKIN	CAS0#	XTAL2
H	CS1#	IO3	CS3#	VCCint	VCC	VCCint	VCCint	OE#	WE1#	CAS1#
J	IOWR#	A18	BOOTB	GNDint	GNDint	A14	GNDint	WE#	WE0#	IORD#
K	A17	A16	A15	A8	A7	A6	A5	A4	ACT	A13

Figure 7.3: *hyperstone* E1-16XSB, 100-Pin TFBGA Package

7.3.2. Pin Cross Reference by Pin Name

Signal	Location	Signal	Location	Signal	Location	Signal	Location
A0	E9	CAS1#	H10	GND	E4	IOWR#	J1
A1	E8	CLKOUT	D8	GND	E5	OE#	H8
A2	E10	CS1#	H1	GND	E6	RAS#	G3
A3	F9	CS2#	G2	GND	E7	RESET#	A9
A4	K8	CS3#	H3	GND	F4	RQST	D9
A5	K7	D0	B6	GND	F5	VCC	C6
A6	K6	D1	A6	GND	F6	VCC	D4
A7	K5	D2	A5	GND	F7	VCC	D7
A8	K4	D3	B5	GND	G5	VCC	E3
A9	E1	D4	A4	GND	G6	VCC	F3
A10	D1	D5	A3	GNDint	B7	VCC	F8
A11	E2	D6	B4	GNDint	B8	VCC	G4
A12	D2	D7	A2	GNDint	C8	VCC	G7
A13	K10	D8	B2	GNDint	J4	VCC	H5
A14	J6	D9	B3	GNDint	J5	VCCint	C4
A15	K3	D10	C2	GNDint	J7	VCCint	C5
A16	K2	D11	A1	GRANT#	A10	VCCint	C7
A17	K1	D12	B1	INT1	C9	VCCint	H4
A18	J2	D13	C3	INT2	B9	VCCint	H6
A19	G1	D14	D3	INT3/WAIT	B10	VCCint	H7
A20	F2	D15	C1	INT4	C10	WE#	J8
A21	F1	DP0	A7	IO1	D10	WE0#	J9
ACT	K9	DP1	A8	IO2	F10	WE1#	H9
BOOTB	J3	GND	D5	IO3	H2	XTAL1/CLKIN	G8
CAS0#	G9	GND	D6	IORD#	J10	XTAL2	G10

7.3.3. Pin Cross Rreference by Location

Location	Signal	Location	Signal	Location	Signal	Location	Signal
A1	D11	C6	VCC	F1	A21	H6	VCCint
A2	D7	C7	VCCint	F2	A20	H7	VCCint
A3	D5	C8	GNDint	F3	VCC	H8	OE#
A4	D4	C9	INT1	F4	GND	H9	WE1#
A5	D2	C10	INT4	F5	GND	H10	CAS1#
A6	D1	D1	A10	F6	GND	J1	IOWR#
A7	DP0	D2	A12	F7	GND	J2	A18
A8	DP1	D3	D14	F8	VCC	J3	BOOTB
A9	RESET#	D4	VCC	F9	A3	J4	GNDint
A10	GRANT#	D5	GND	F10	IO2	J5	GNDint
B1	D12	D6	GND	G1	A19	J6	A14
B2	D8	D7	VCC	G2	CS2#	J7	GNDint
B3	D9	D8	CLKOUT	G3	RAS#	J8	WE#
B4	D6	D9	RQST	G4	VCC	J9	WE0#
B5	D3	D10	IO1	G5	GND	J10	IORD#
B6	D0	E1	A9	G6	GND	K1	A17
B7	GNDint	E2	A11	G7	VCC	K2	A16
B8	GNDint	E3	VCC	G8	XTAL1/CLKIN	K3	A15
B9	INT2	E4	GND	G9	CAS0#	K4	A8
B10	INT3/WAIT	E5	GND	G10	XTAL2	K5	A7
C1	D15	E6	GND	H1	CS1#	K6	A6
C2	D10	E7	GND	H2	IO3	K7	A5
C3	D13	E8	A1	H3	CS3#	K8	A4
C4	VCCint	E9	A0	H4	VCCint	K9	ACT
C5	VCCint	E10	A2	H5	VCC	K10	A13

7.4. Package Dimensions

7.4.1. Package Dimensions LQFP
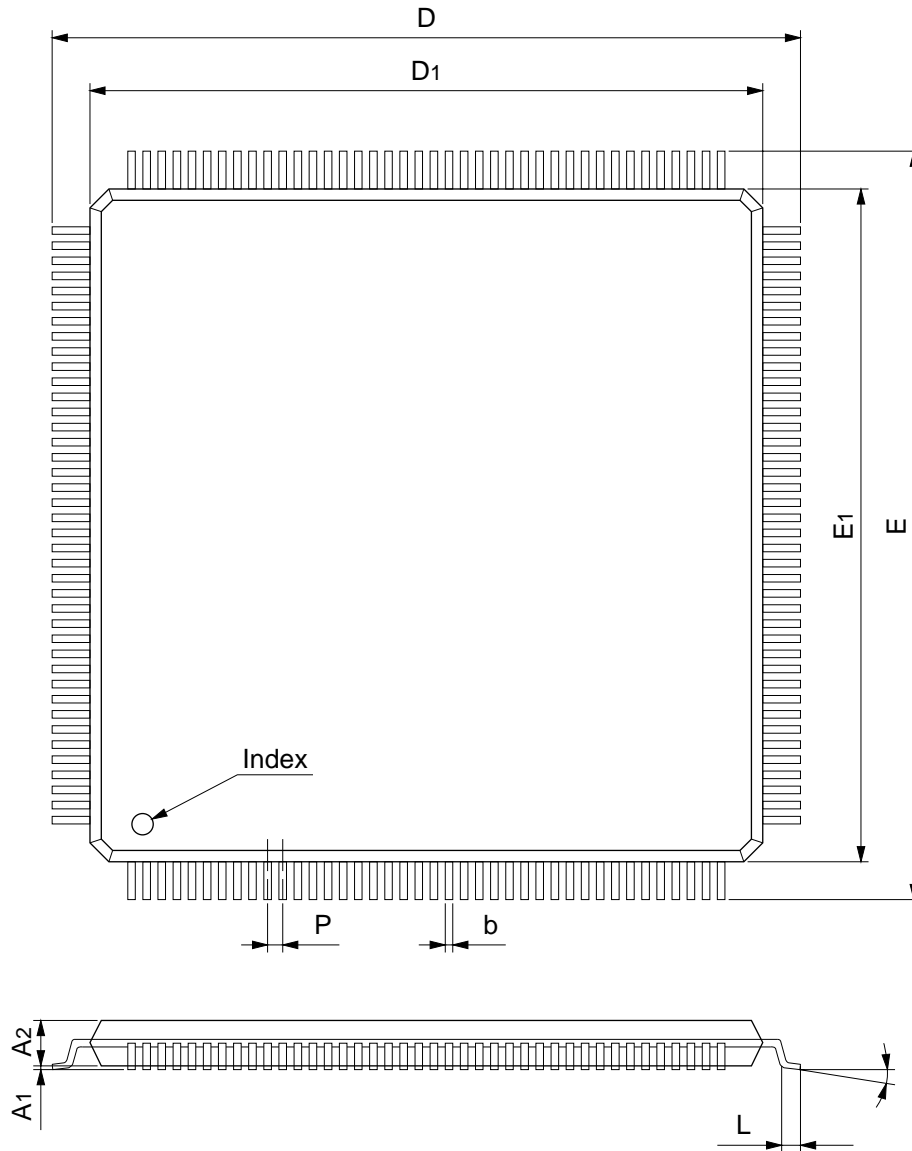
Figure 7.4: *hyperstone* E1-32XS, E1-16XS LQFP Package Outline

Symbol	Term	Definition
A1	Standoff height	Height from ground plane to bottom edge of package
A2	Package height	Height of package itself
E, D	Overall length & width	Length and width including leads
D1, E1	Package length & width	Length and width of package
L	Length of flat lead section	Length of flat lead section
P	Lead pitch	Lead pitch
B	Lead width	Width of a lead
θ	Lead angle	Angle of lead versus seating plane

7.4.1. Package Dimensions LQFP (continued)

hyperstone E1-32XS, 144-Pin LQFP Package

Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max
A1	0.05	0.10	0.15	(0.002)	(0.004)	(0.006)
A2	1.35	1.40	1.45	(0.053)	(0.055)	(0.057)
E, D	21.80	22.00	22.20	(0.858)	(0.866)	(0.874)
E1, D1	19.90	20.00	20.10	(0.783)	(0.787)	(0.791)
L	0.45	0.60	0.75	(0.018)	(0.024)	(0.030)
P		0.50			(0.0197)	
b	0.17	0.22	0.27	(0.007)	(0.009)	(0.011)
θ	0°		7°	(0°)		(7°)

hyperstone E1-16XS, 100-Pin LQFP Package

Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max
A1	0.05	0.10	0.15	(0.002)	(0.004)	(0.006)
A2	1.35	1.40	1.45	(0.053)	(0.055)	(0.057)
E, D	15.80	16.00	16.20	(0.622)	(0.630)	(0.638)
E1, D1	13.90	14.00	14.10	(0.547)	(0.551)	(0.555)
L	0.45	0.60	0.75	(0.018)	(0.024)	(0.030)
P		0.50			(0.0197)	
b	0.17	0.22	0.27	(0.007)	(0.009)	(0.011)
θ	0°		7°	(0°)		(7°)

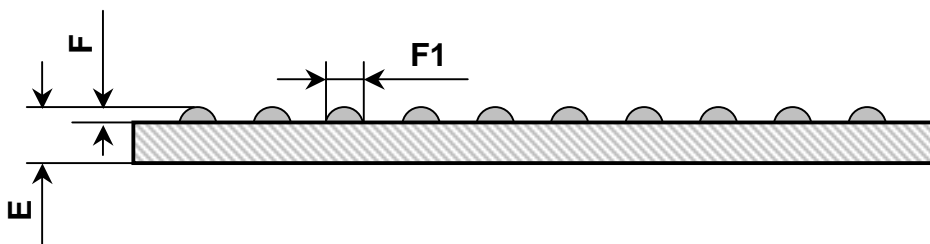## 7.4.2. Package Dimensions TFBGA

bottom view:
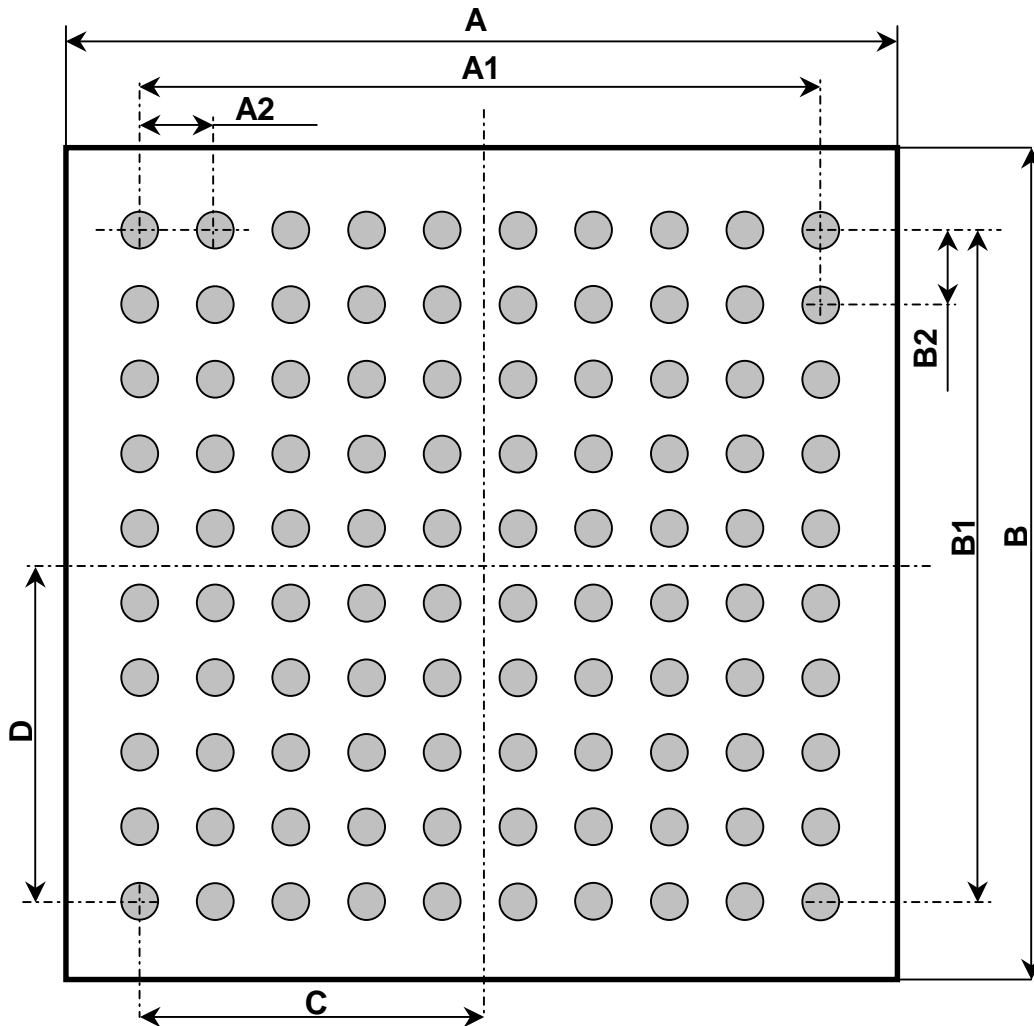
side view:

Figure 7.5: *hyperstone* E1-16XSB TFBGA Package Outline

7.4.2. Package Dimensions TFBGA (continued)

hyperstone E1-16XSB, 100-Pin TFBGA Package

Symbol	Dimensions in mm			Dimensions in Inch		
	MIN	NOM	MAX	MIN	NOM	MAX
A	8.90	9.00	9.10	0.350	0.354	0.358
A1	---	7.20	---	---	0.283	---
A2	---	0.80	---	---	0.031	---
B	8.90	9.00	9.10	0.350	0.354	0.358
B1	---	7.20	---	---	0.283	---
B2	---	0.80	---	---	0.031	---
C	---	3.60	---	---	0.142	---
D	---	3.60	---	---	0.142	---
E	---	---	1.40	---	---	0.055
F	0.25	0.30	0.35	0.010	0.012	0.014
F1	0.35	0.40	0.45	0.014	0.016	0.018

8. Specification Changes

Compared to the specifications in this manual, the currently available E1-32XS and E1-16XS chips have three limitations. This includes, but is not limited to the lot numbers

K60062.1

K60172.1.*

The specification differences are listed in the following sections.

8.1. Clock Speed

The maximum clock speed is 110 MHz, the maximum XTAL1 input frequency is 20 MHz.

8.2. SDRAM Clock Mode

The delayed SDRAM clock mode is not available, the non-delayed SDRAM clock mode must be used.

8.3. GRANT# Response Time

If a GRANT# low to high transition is detected while the processor is in power-down mode, the release of the processor bus may be delayed until the next SDRAM refresh cycle is scheduled (normally, every 16 µs). This only happens if the Mem0 memory type is SDRAM.